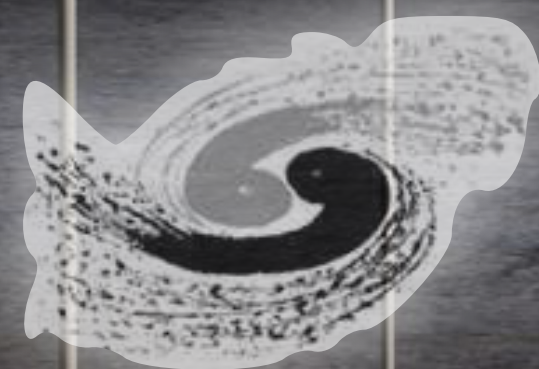


# CEPC Detector R&D, Collaboration and Future

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*Institute of High Energy Physics  
Chinese Academy of Sciences*

International Advisory Committee Meeting  
October 31, 2022



# CEPC action plan since CDR

Public release: **November 2018**

IHEP-CEPC-DR-2018-01

IHEP-AC-2018-01

**CEPC**

*Conceptual Design Report*

Volume I - Accelerator

arXiv: [1809.00285](https://arxiv.org/abs/1809.00285)

The CEPC Study Group  
August 2018

IHEP-CEPC-DR-2018-02

IHEP-EP-2018-01

IHEP-TH-2018-01

**CEPC**

*Conceptual Design Report*

Volume II - Physics & Detector

arXiv: [1811.10545](https://arxiv.org/abs/1811.10545)

The CEPC Study Group  
October 2018

Since 2019

Cement project with  
R&D towards:

Detector technologies  
development and  
establishment of seeds for  
**International Collaborations**

Identify challenges and  
devise solutions



# CEPC TDR Parameters (upgrade version)

## Main Parameters: High luminosity

	<b>Higgs</b>	<b>W</b>	<b>Z</b>	<b>ttbar</b>
Number of IPs	2			
Circumference [km]	100.0			
<b>SR power per beam [MW]</b>	<b>50</b>			
<b>Energy [GeV]</b>	<b>120</b>	<b>80</b>	<b>45.5</b>	<b>180</b>
Bunch number	415	2161	19918	59
Emittance ( $\epsilon_x/\epsilon_y$ ) [nm/pm]	0.64/1.3	0.87/1.7	0.27/1.4	1.4/4.7
Beam size at IP ( $\sigma_x/\sigma_y$ ) [ $\mu\text{m}/\text{nm}$ ]	15/36	13/42	6/35	39/113
Bunch length (SR/total) [mm]	2.3/3.9	2.5/4.9	2.5/8.7	2.2/2.9
Beam-beam parameters ( $\xi_x/\xi_y$ )	0.015/0.11	0.012/0.113	0.004/0.127	0.071/0.1
RF frequency [MHz]	650			
<b>Luminosity per IP [<math>10^{34}/\text{cm}^2/\text{s}</math>]</b>	<b>8.3</b>	<b>27</b>	<b>192</b>	<b>0.83</b>

**Increase relative to CDR:      x 2.8      x 2.7      x 6**



# CEPC Physics Program

CEPC Operation mode		ZH	Z	W+W-	ttbar
		~ 240	~ 91.2	~ 160	~ 360
Run time [years]		7	2	1	-
CDR (30MW)	$L / IP [\times 10^{34} \text{ cm}^{-2}\text{s}^{-1}]$	3	32	10	-
	[ab <sup>-1</sup> , 2 IPs]	5.6	16	2.6	-
	Event yields [2 IPs]	$1 \times 10^6$	$7 \times 10^{11}$	$2 \times 10^7$	-
Run time [years]		10	2	1	5
Latest (50MW)	$L / IP [\times 10^{34} \text{ cm}^{-2}\text{s}^{-1}]$	8.3	192	27	0.83
	[ab <sup>-1</sup> , 2 IPs]	20	96	7	1
	Event yields [2 IPs]	$4 \times 10^6$	$4 \times 10^{12}$	$5 \times 10^7$	$5 \times 10^5$

Large physics samples:  $\sim 10^6$  Higgs,  $\sim 10^{12}$  Z,  $\sim 10^8$  W bosons,  $\sim 10^6$  top quarks

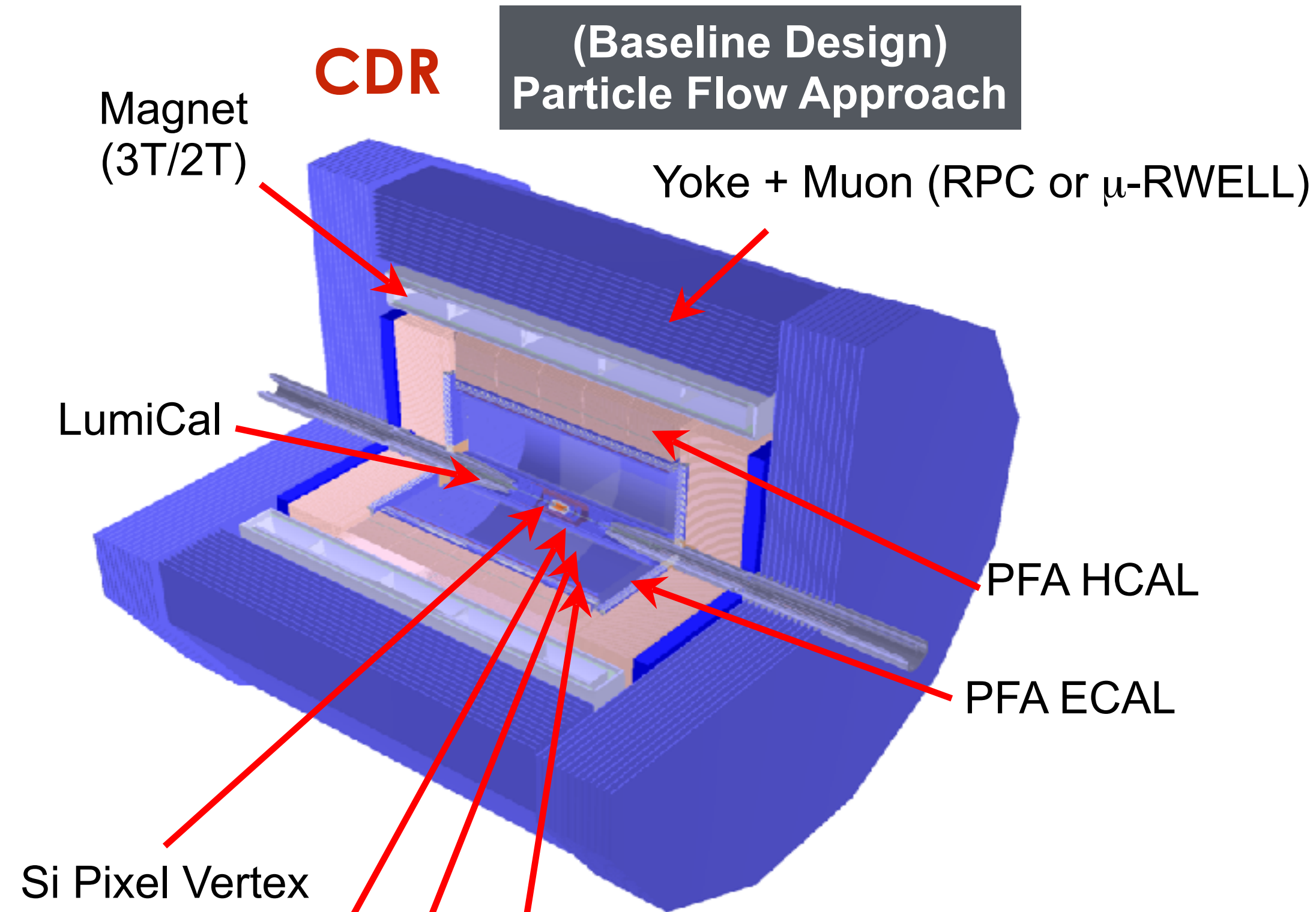
Physics potential similar to FCC-ee, ILC, CLIC



# Detector R&D progress



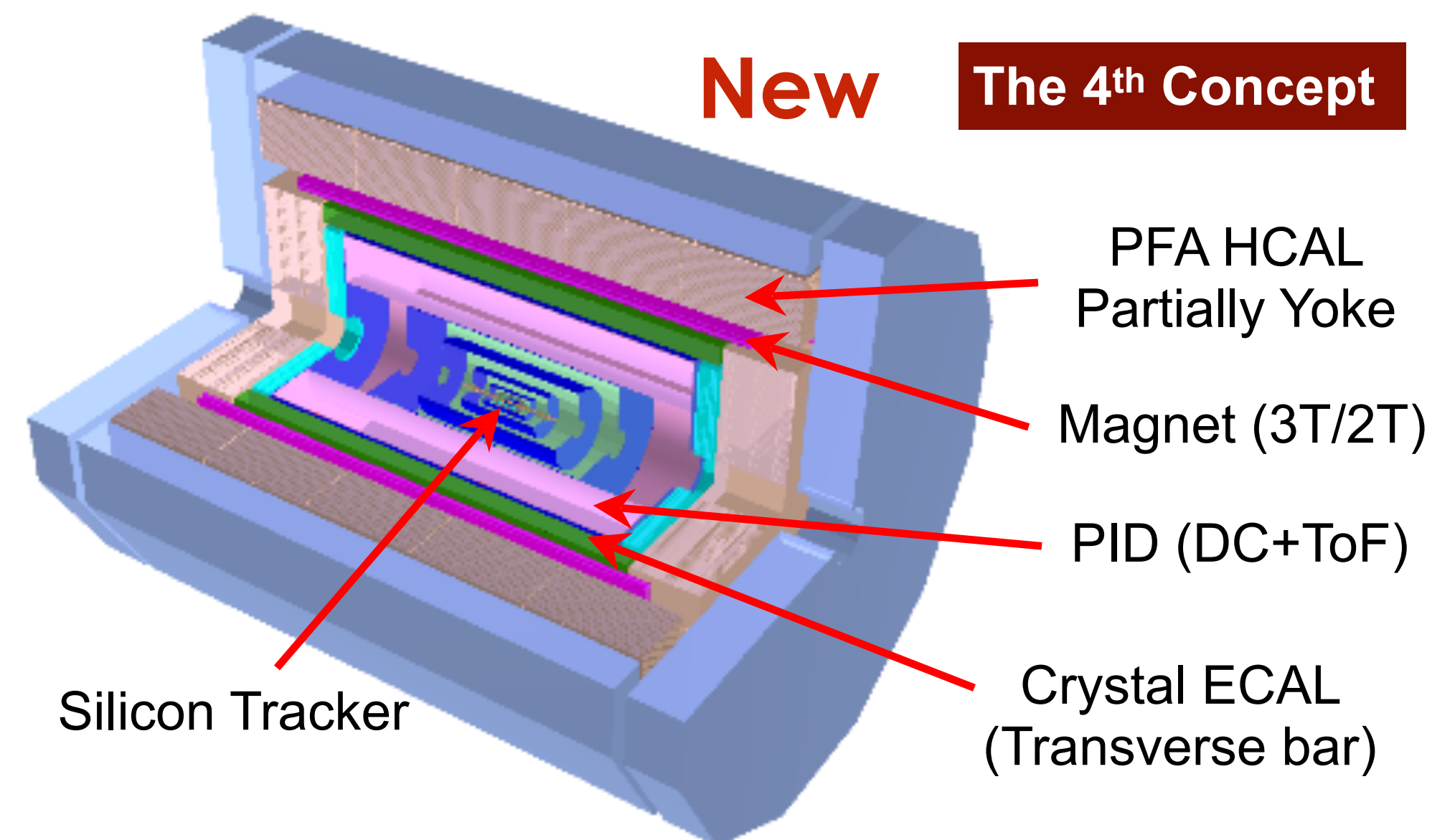
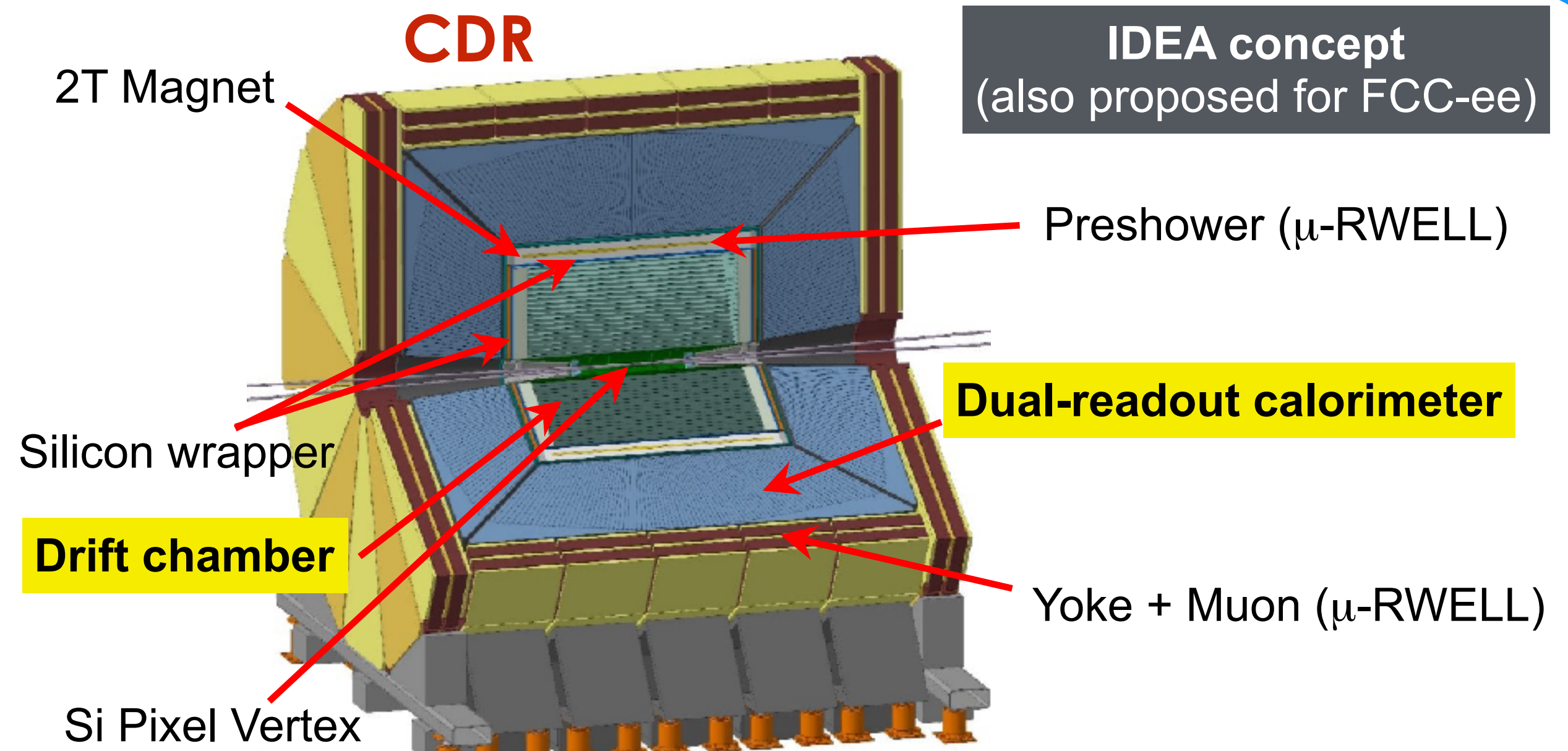
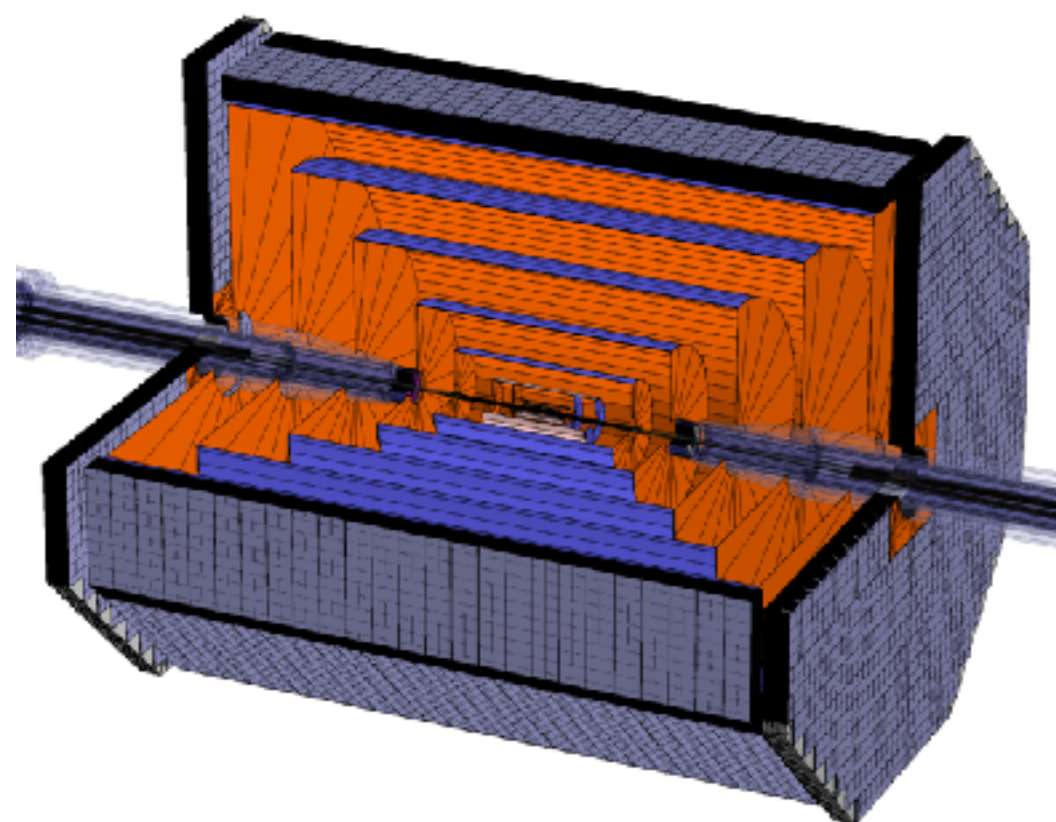
# CEPC Detector Concept Designs



SIT TPC SET  
FTD ETD

**FST concept**  
(Full Silicon Tracker)

**CDR**





# The 4<sup>th</sup> Conceptual Detector Design

Scint Glass  
PFA HCAL

**Advantage:** Cost efficient, high density  
**Challenges:** Light yield, transparency,  
massive production.

Solenoid Magnet (3T / 2T )  
Between HCAL & ECAL

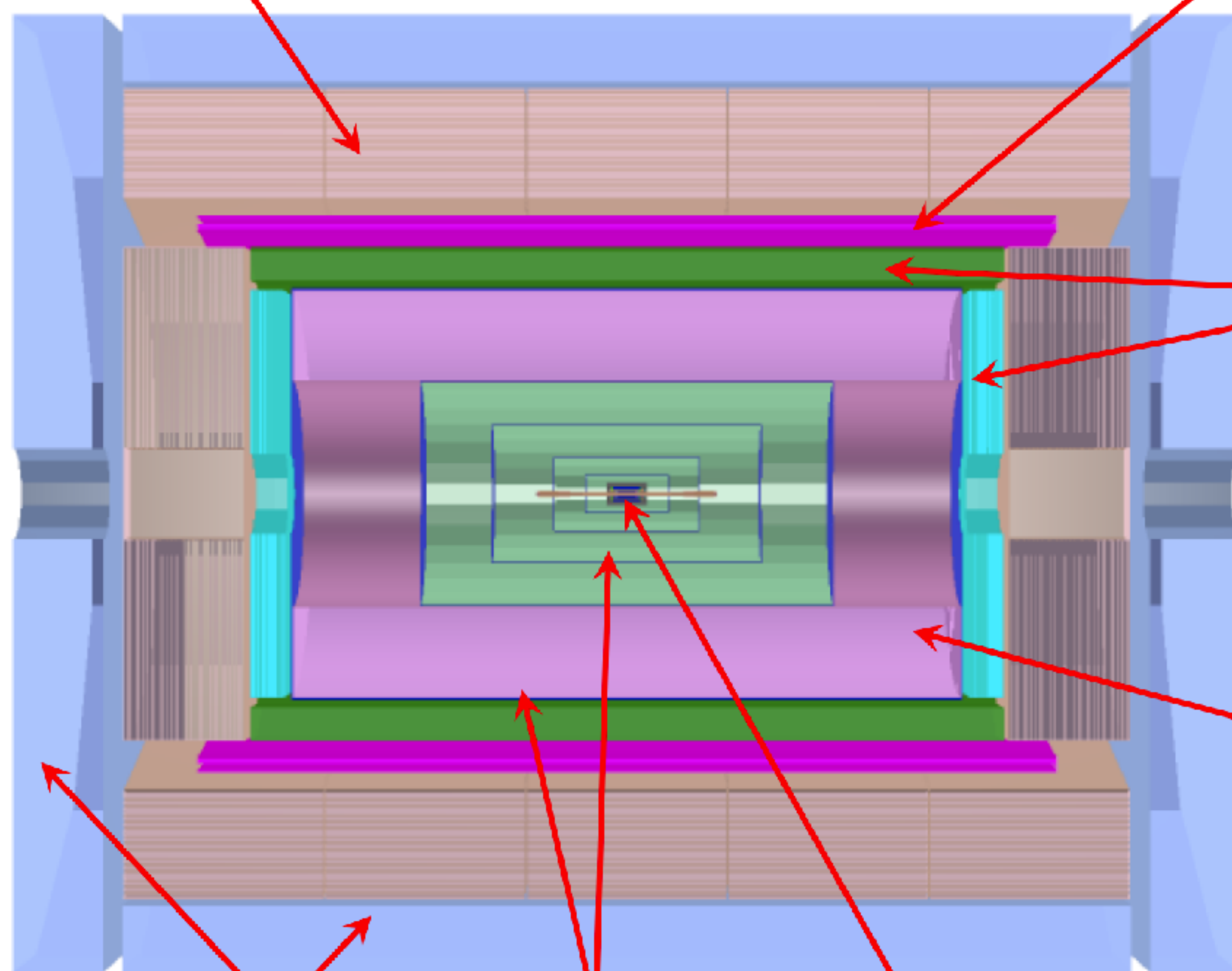
**Advantage:** the HCAL absorbers act as part  
of the magnet return yoke.  
**Challenges:** thin enough not to affect the jet  
resolution (e.g. BMR); stability.

Crystal ECAL

**Advantage:** better  $\pi^0/\gamma$  reconstruction.  
**Challenges:** minimum number of readout  
channels; compatible with PFA calorimeter;  
maintain good jet resolution.

A Drift chamber  
that is optimized for PID

**Advantage:** Work at high luminosity Z runs  
**Challenges:** sufficient PID power; thin  
enough not to affect the moment resolution.



Muon+Yoke

Si Tracker  
w/TOF outer layer

Si Vertex



# Detector R&D Breakdown

**Total of 103 sub-tasks identified**

## 1. Vertex

- 1.1. Pixel Vertex Prototype
- 1.2. ARCADIA/LFoundry CMOS

## 2. Tracker

- 2.1. TPC
- 2.2. Silicon Tracker
- 2.3. Drift Chamber

## 3. Calorimeter

- 3.1. ECAL Calorimeter
  - 3.1.1. Crystal Calorimeter
  - 3.1.2. Scintillator-Tungsten
- 3.2. HCAL PFA Calorimeter
  - 3.2.1. DHCAL
  - 3.2.2. Sci AHCAL
- 3.3. DR Calorimeter

## 4. Muon Detectors

- 4.1. Muon Scintillator Detector
- 4.2. Muon and pre-shower MuRWell Detectors

## 5. Solenoid

- 5.1. LTS Solenoid
- 5.2. HTS Solenoid

## 6. MDI

- 6.1. LumiCal Prototype
- 6.2. Mechanics

## 7. TDAQ

## 8. Software and Computing

Det	Technology	Det	Technology
Pixel Vertex	JadePix	Calorimeter	Crystal ECAL
	TaichuPix		Si+W ECAL
	Arcadia		Scint+W ECAL
	CPV(SOI)		Scint AHCAL
	Stiching		ScintGlass AHCAL
Tracker & PID	TPC		RPC SDHCAL
	CEPCPix	MPGD SDHCAL	
	Drift chamber	DR Calorimeter	
	PID DC	Muon	Scintillation Bar
	LGAD		RPC
	Silicon Strip		$\mu$ -Rwell
Lumi		Lumi	SiTrk+Crystal ECAL
			SiTrk+SiW ECAL



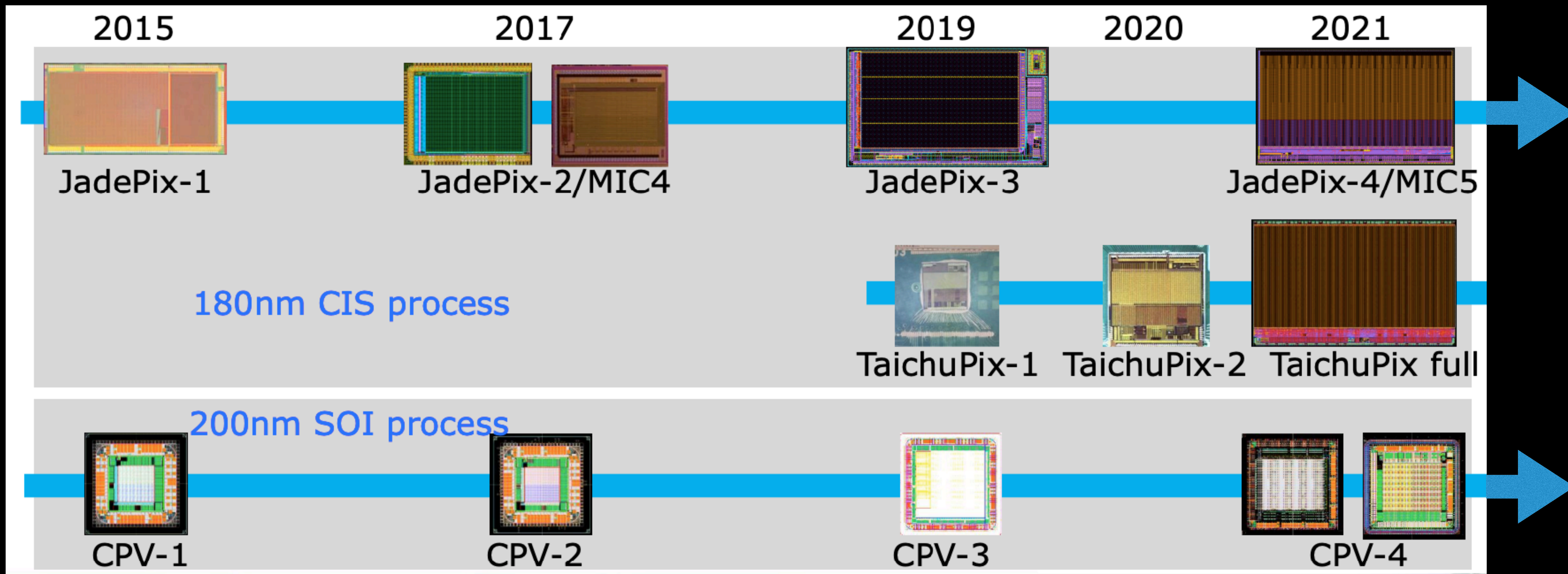
# Prototypes under evaluation

Sub-detector	Specification	Requirement	CEPC prototype	
Pixel detector	Spatial resolution	$\sim 3 \mu\text{m}$	$3 - 5 \mu\text{m}$ [14–16]	
TPC/drift chamber	dE/dx (dN/dx) resolution	$\sim 2\%$	$\sim 4\%$ [19–21]	
PFA calorimeter	Scintillator-W ECal	Energy resolution Granularity	$< 15\% / \sqrt{E(\text{GeV})}$ $\sim 2 \times 2 \text{ cm}^2$	Prototype built to be measured $0.5 \times 0.5 \text{ cm}^2$
	4D crystal ECal	EM energy resolution 3D Granularity	$\sim 3\% / \sqrt{E(\text{GeV})}$ $\sim 2 \times 2 \times 2 \text{ cm}^3$	Prototyping [25] $\sim 3\% / \sqrt{E(\text{GeV})}$ $\sim 2 \times 2 \times 2 \text{ cm}^3$
	Scintillator-Steel HCal	Support PFA, Single hadron $\sigma_E^{had}$	$< 60\% / \sqrt{E(\text{GeV})}$	Prototyping
	Scintillating glass HCal	Support PFA Single hadron $\sigma_E^{had}$	$\sim 40\% / \sqrt{E(\text{GeV})}$	Prototyping $\sim 40\% / \sqrt{E(\text{GeV})}$
	Low-mass Solenoid magnet	Magnet field strength Thickness	$2 \text{ T} - 3 \text{ T}$ $< 150 \text{ mm}$	Prototyping



# CEPC Vertex detector R&D

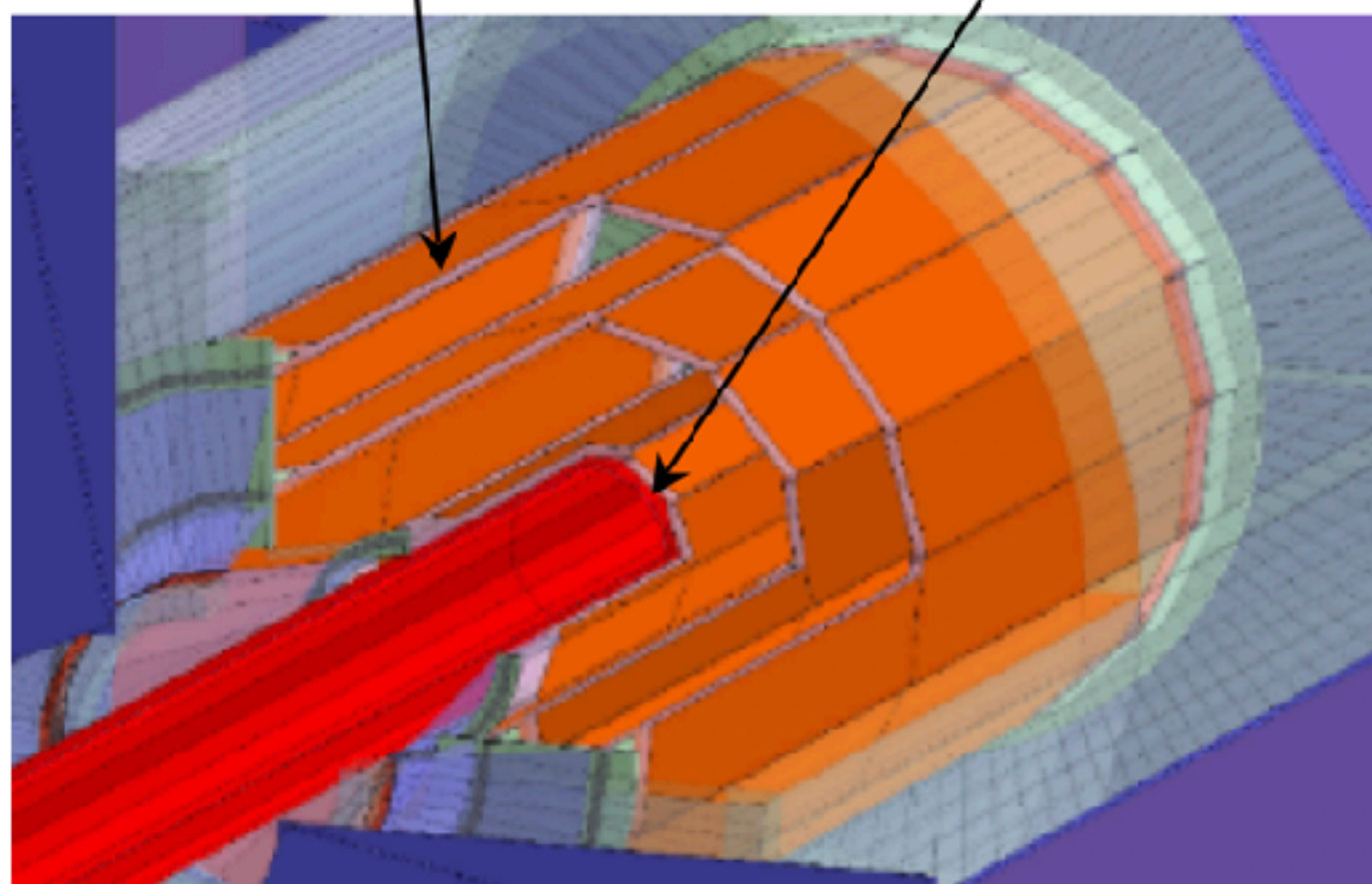
- CEPC Vertex detector sensor R&D timeline
  - Based on Tower Jazz CIS 180nm process (Jadepix , TaichuPix)
  - Based SOI 200nm process (CPV chip)





# CEPC R&D: Silicon Pixel Sensors

2 layers / ladder  $R_{in} \sim 16$  mm



**JadePix-3** Pixel size  $\sim 16 \times 23 \mu\text{m}^2$



**Tower-Jazz 180nm CiS process**  
Resolution 5 microns,  $53\text{mW}/\text{cm}^2$

**MOST 1**

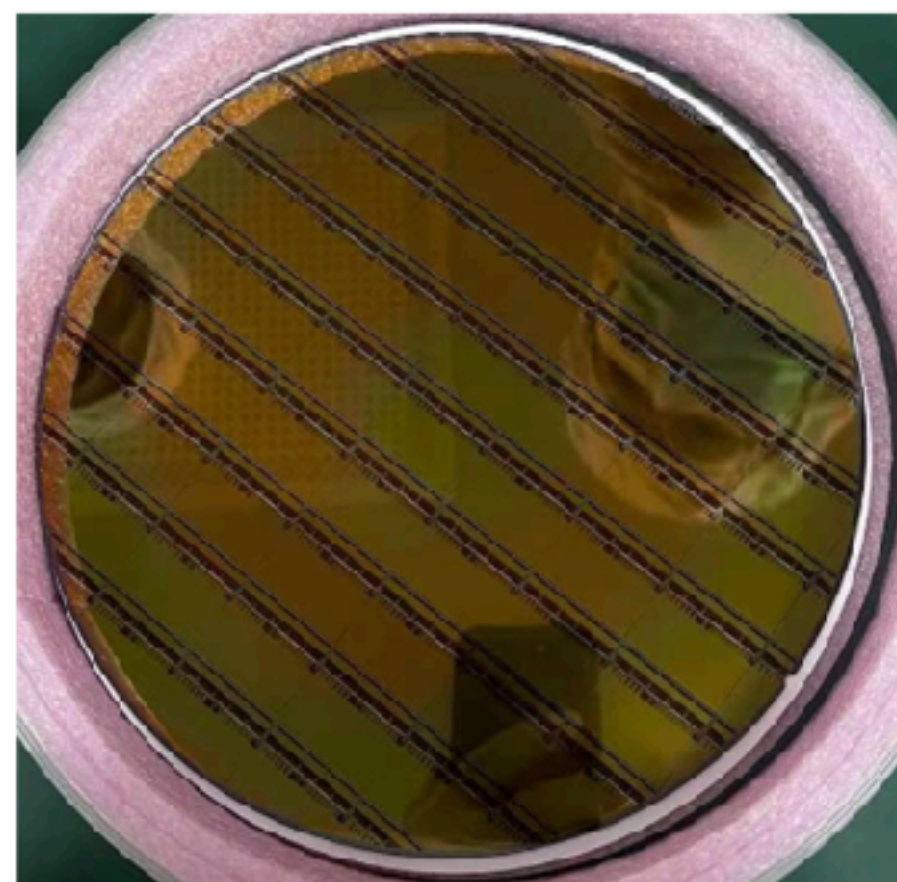
**Goal:  $\sigma(\text{IP}) \sim 5 \mu\text{m}$  for high P track**

CDR design specifications

- Single point resolution  $\sim 3\mu\text{m}$
- Low material ( $0.15\% X_0$  / layer)
- Low power ( $< 50\text{mW}/\text{cm}^2$ )
- Radiation hard ( $1\text{ Mrad}/\text{year}$ )

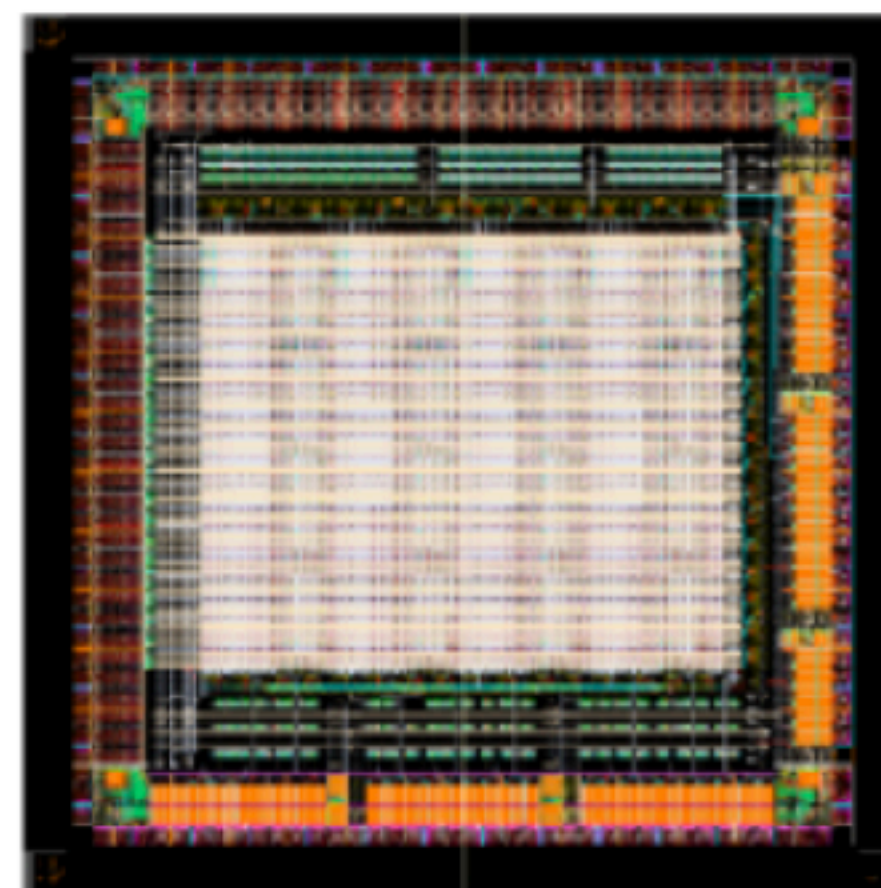
Silicon pixel sensor develops in 5 series:  
JadePix, TaichuPix, CPV, Arcadia, CEPCPix

**TaichuPix-3**, FS  $2.5 \times 1.5 \text{ cm}^2$   
 $25 \times 25 \mu\text{m}^2$  pixel size

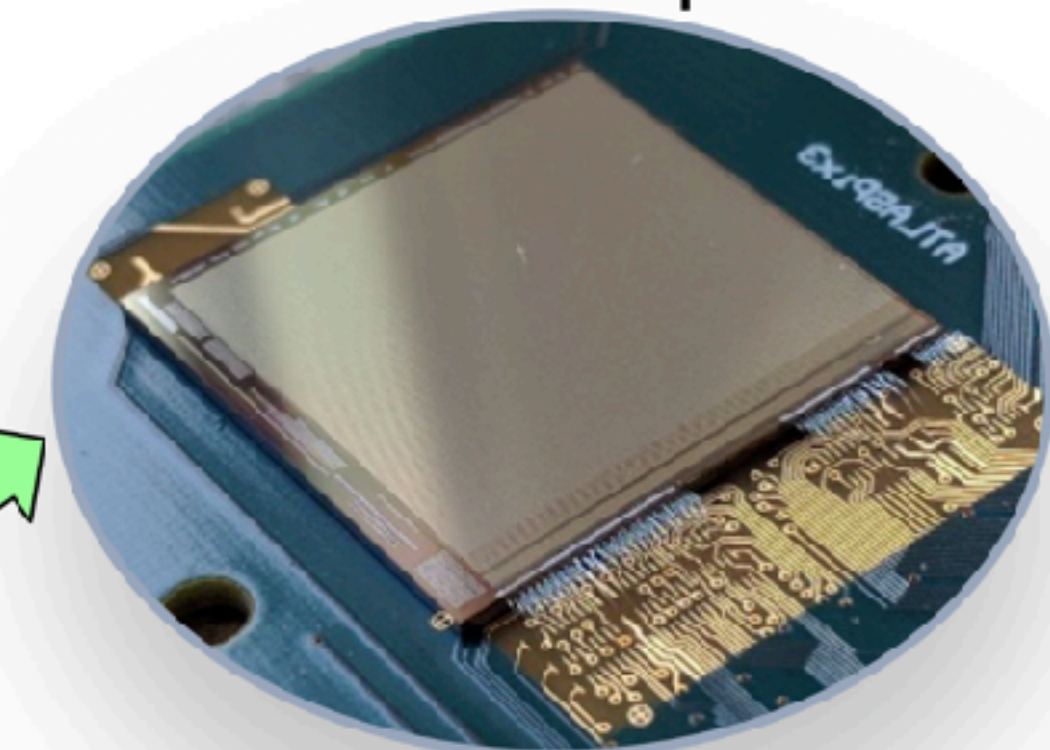


**MOST 2**

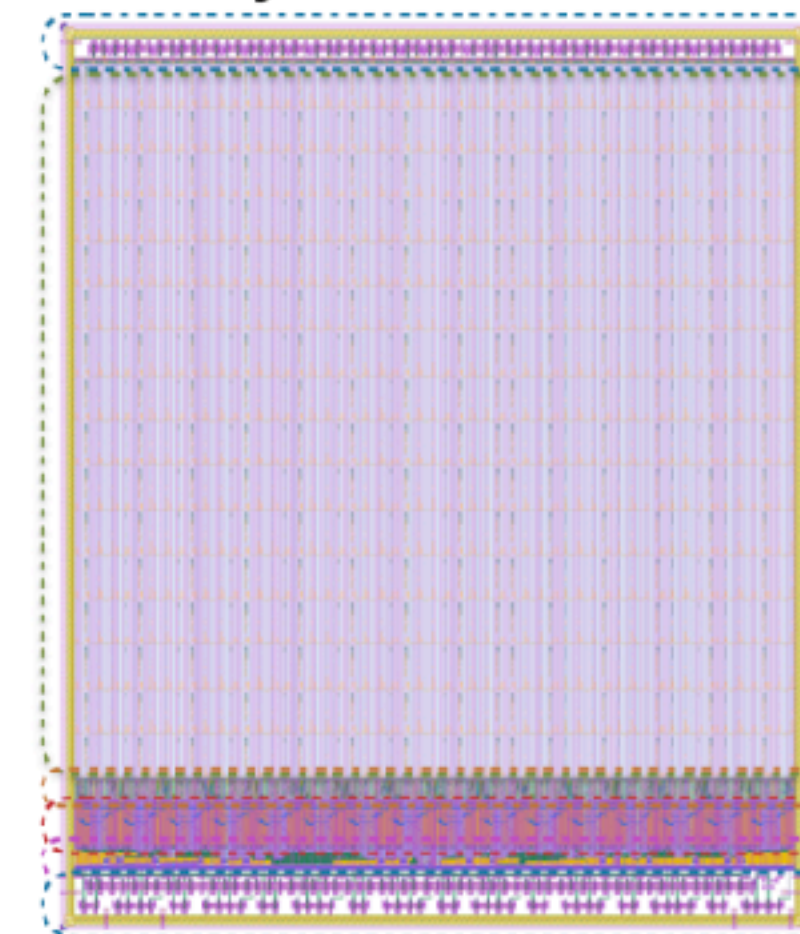
**CPV4 (SOI-3D)**,  $64 \times 64$  array  
 $\sim 21 \times 17 \mu\text{m}^2$  pixel size



Develop **CEPCPix** for a CEPC tracker based on **ATLASPix3 CN/IT/UK/DE**  
TSI 180 nm HV-CMOS process



**Arcadia** by Italian groups for IDEA vertex detector  
LFoundry 110 nm CMOS





# CEPC R&D: Vertex Detector Prototype

Low-mass vertex detectors require sensors with:

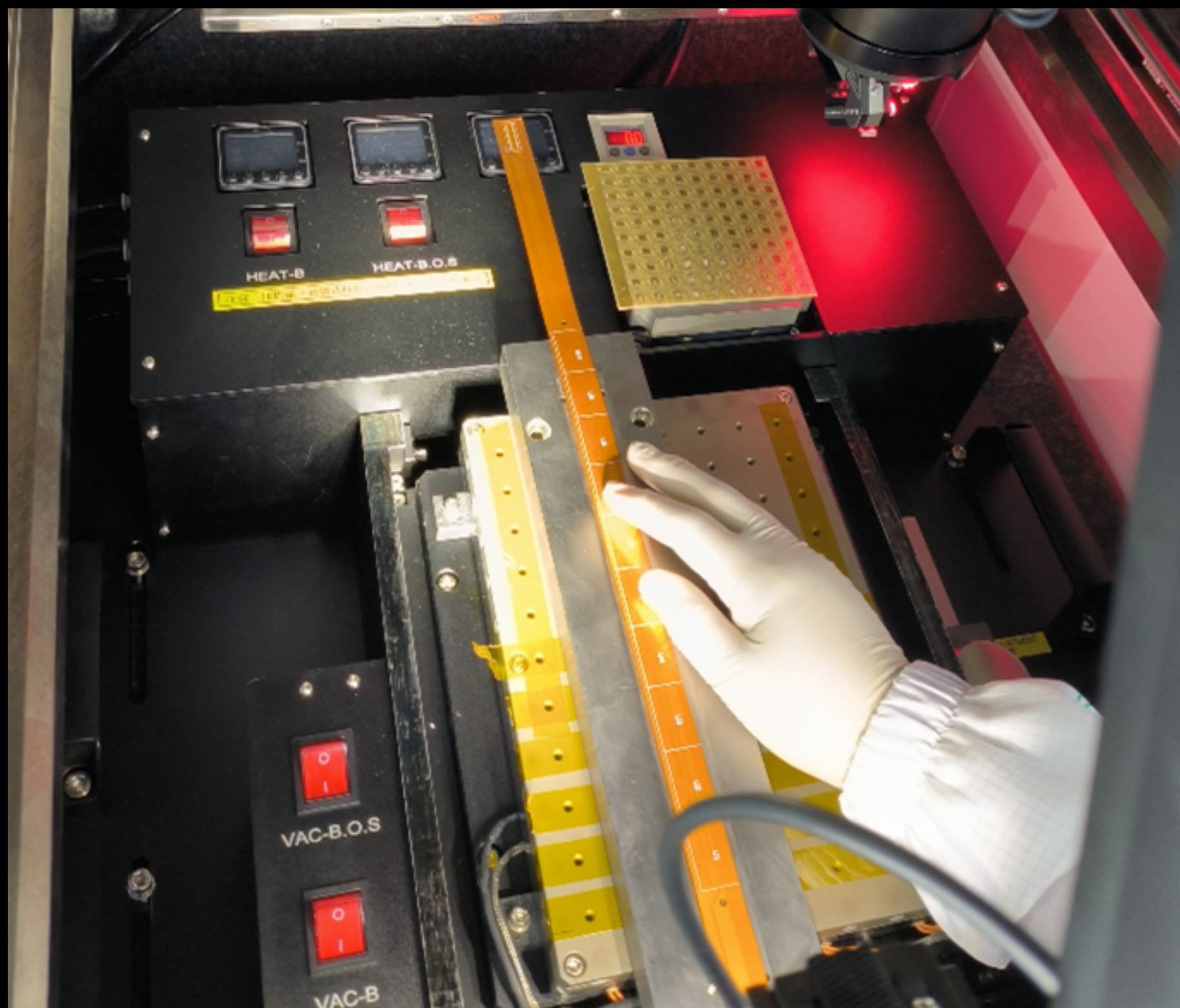
integrated readout electronics  
low power consumption

TaichuPix3 chips at IHEP

Ladder wire bonding preparations

Assembly tooling designed

Produced by TowerJazz,  
in collaboration with  
IFAE, Spain



CEPC

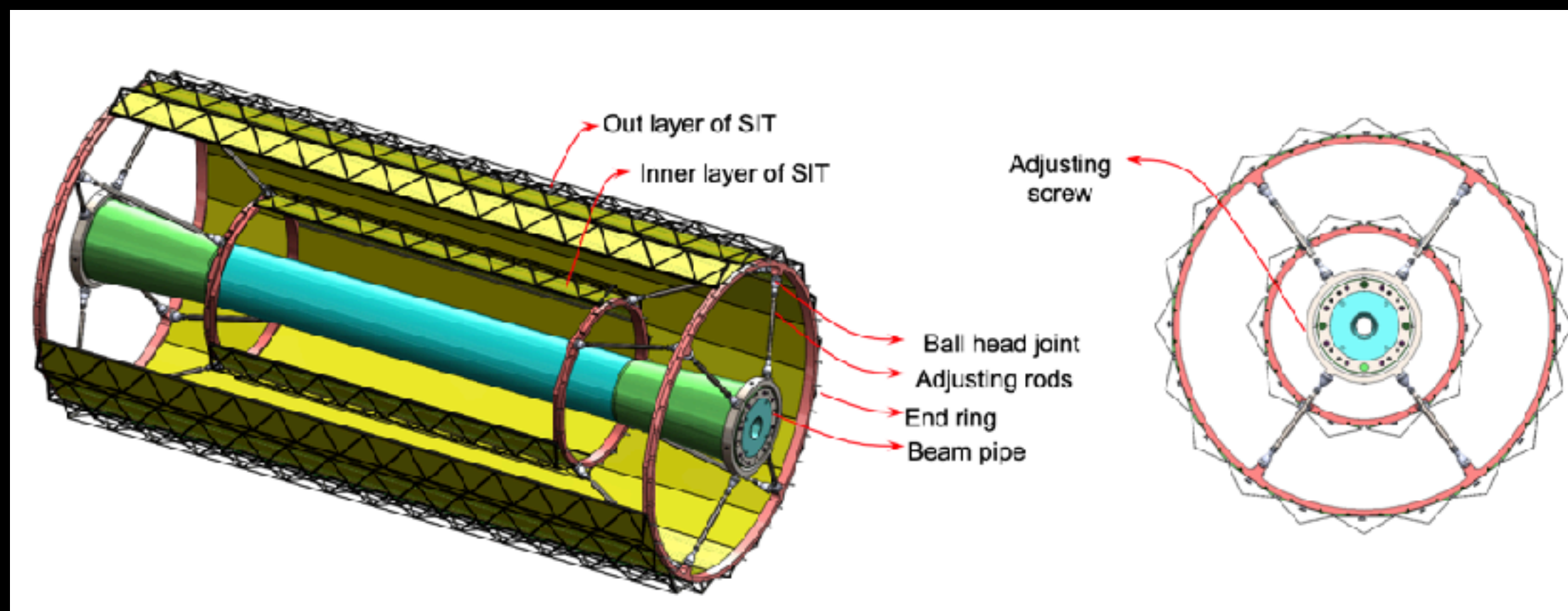
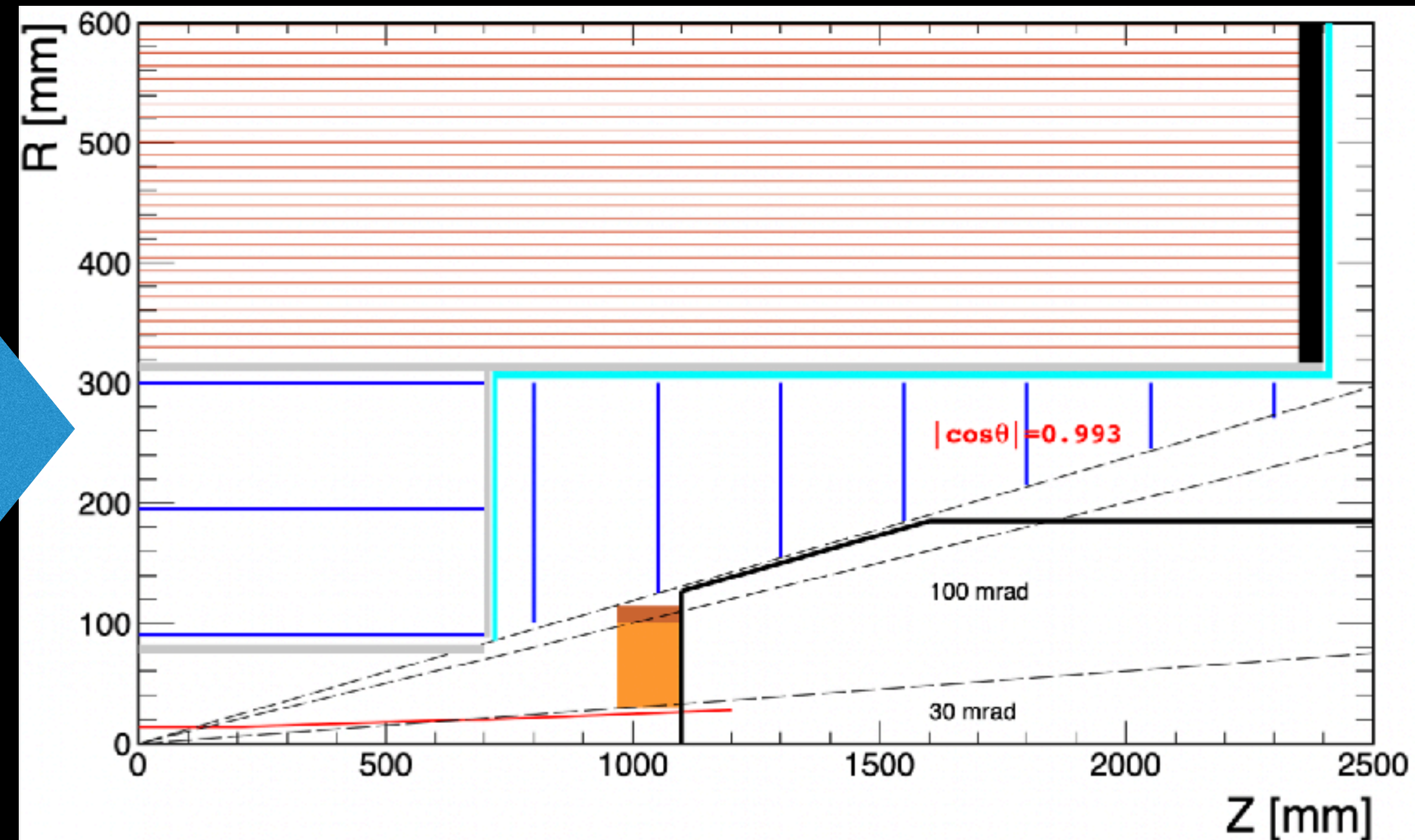
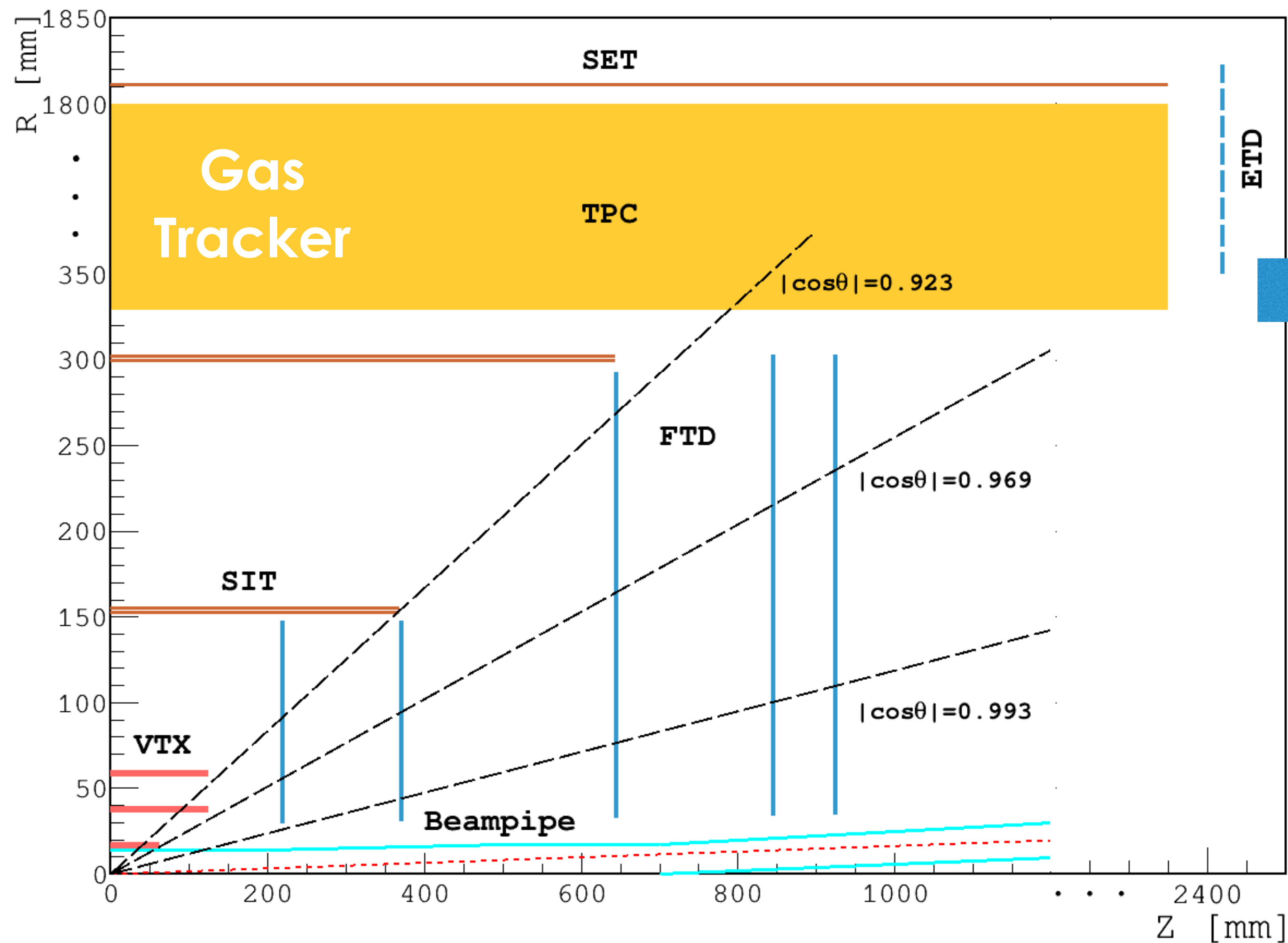
Chip working well

Full vertex detector prototype test beam planned for DESY December 2022



# CEPC R&D: Silicon Tracker design

## Optimization: tracker layout taskforce





# Silicon tracker demonstrator with international partners

## HV-CMOS Tracker Demonstrator

### International collaboration

- **China**

- Institute of High Energy Physics, CAS
- Shangdong University
- Tsinghua University
- University of Science and Technology of China
- Northwestern Polytechnical University
- T.D. Lee Institute – Shanghai Jiao Tong University
- Harbin Institute of Technology
- University of South China

- **Italy**

- INFN Sezione di Milano, Università di Milano e Università dell'Insubria
- INFN Sezione di Pisa e Università di Pisa
- INFN Sezione di Torino e Università di Torino

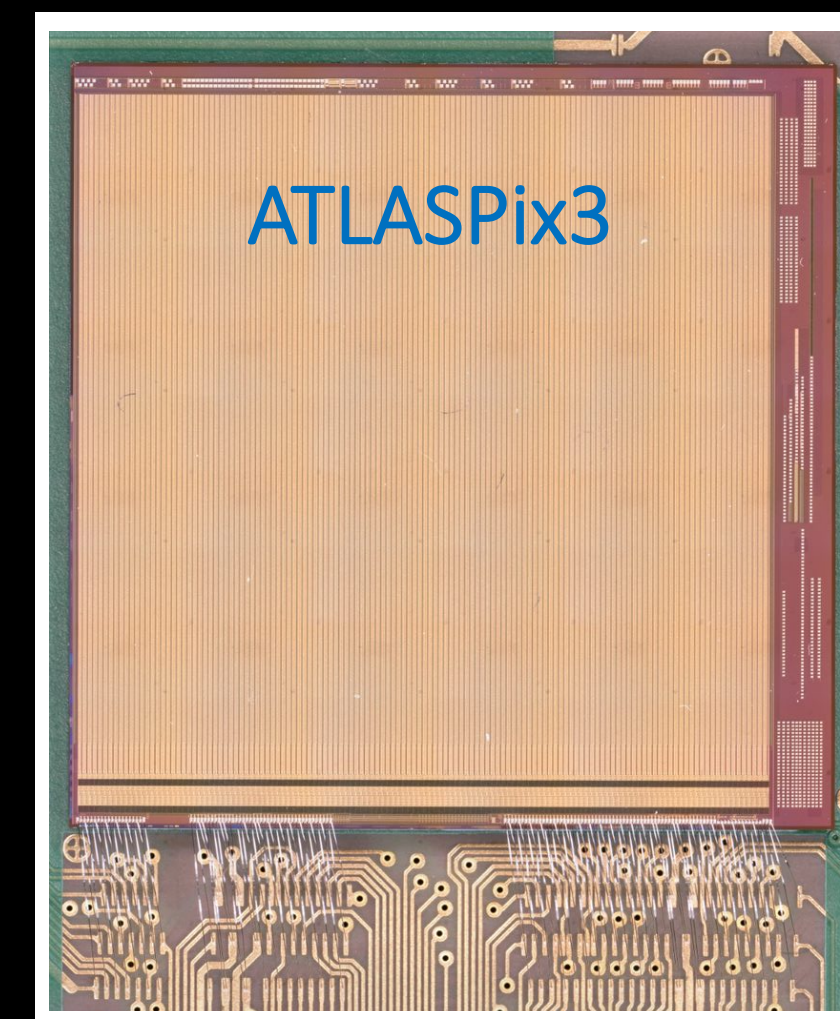
- **Germany**

- Karlsruhe Institute of Technology

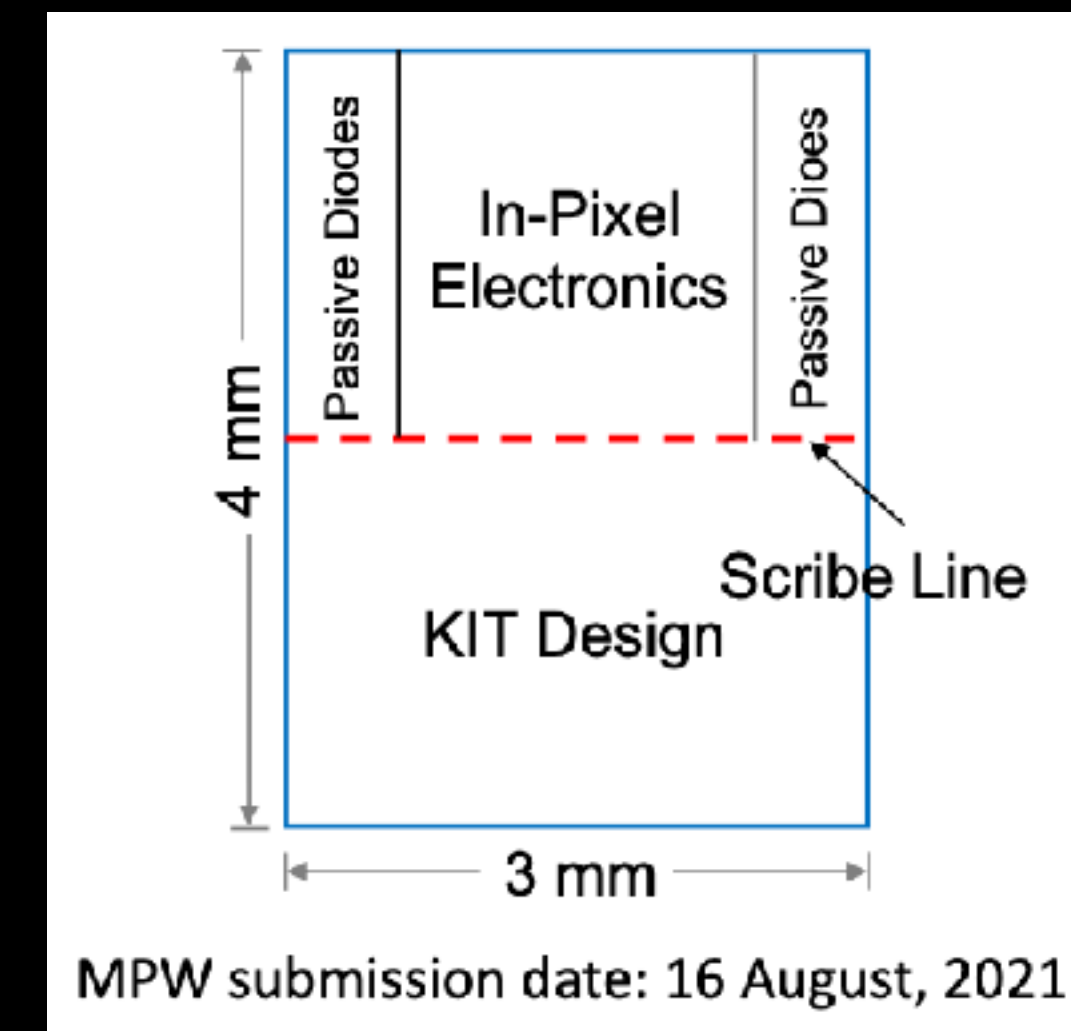
- **UK**

- University of Bristol
- STFC – Daresbury Laboratory
- University of Edinburgh
- Lancaster University
- University of Liverpool
- Queen Mary University of London
- University of Oxford
- University of Sheffield
- University of Warwick

Start by using components developed for other projects



smaller pixel size  
( $25 \times 150 \mu\text{m}^2$ )



Test beam at DESY in April 2022

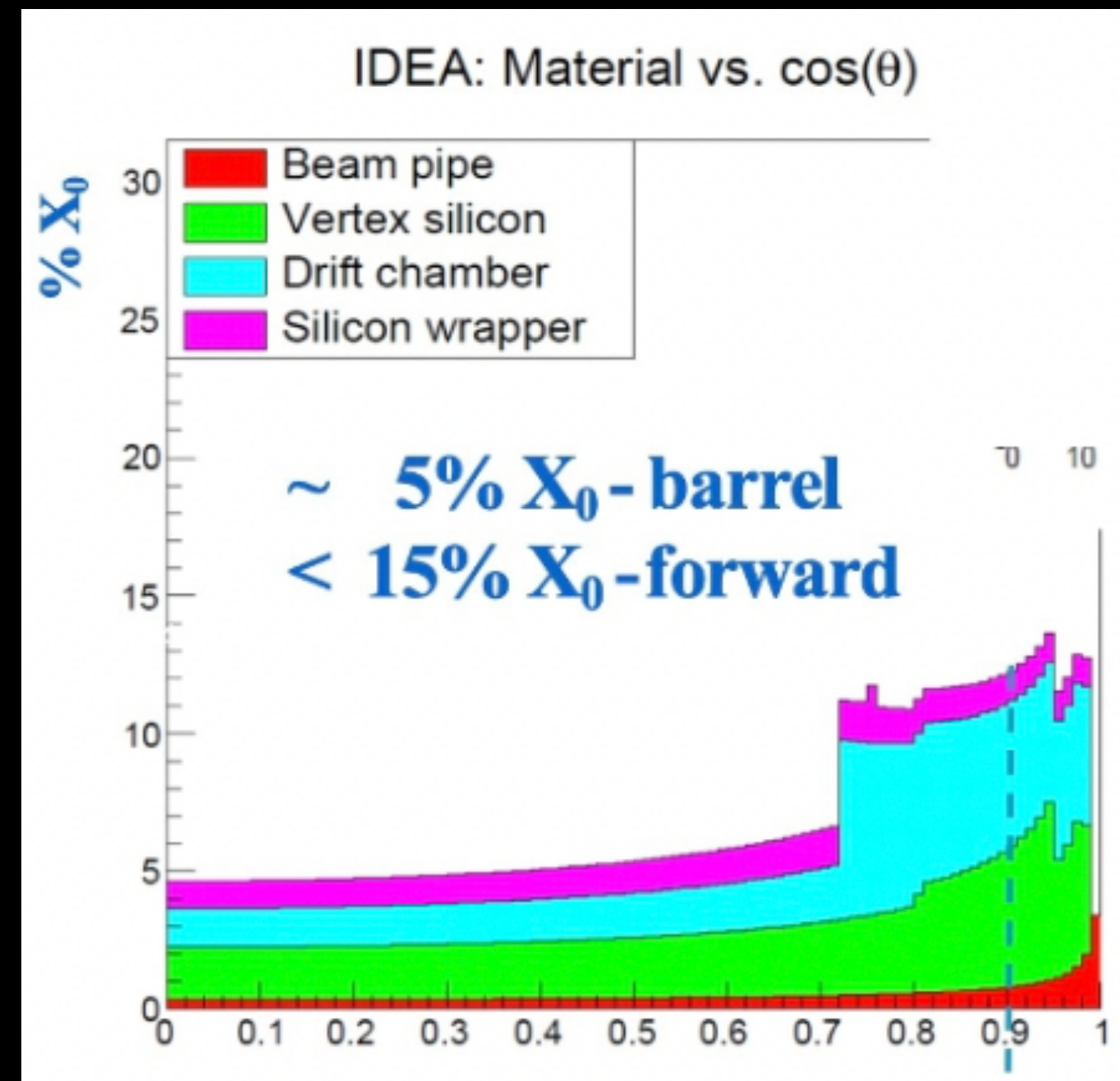
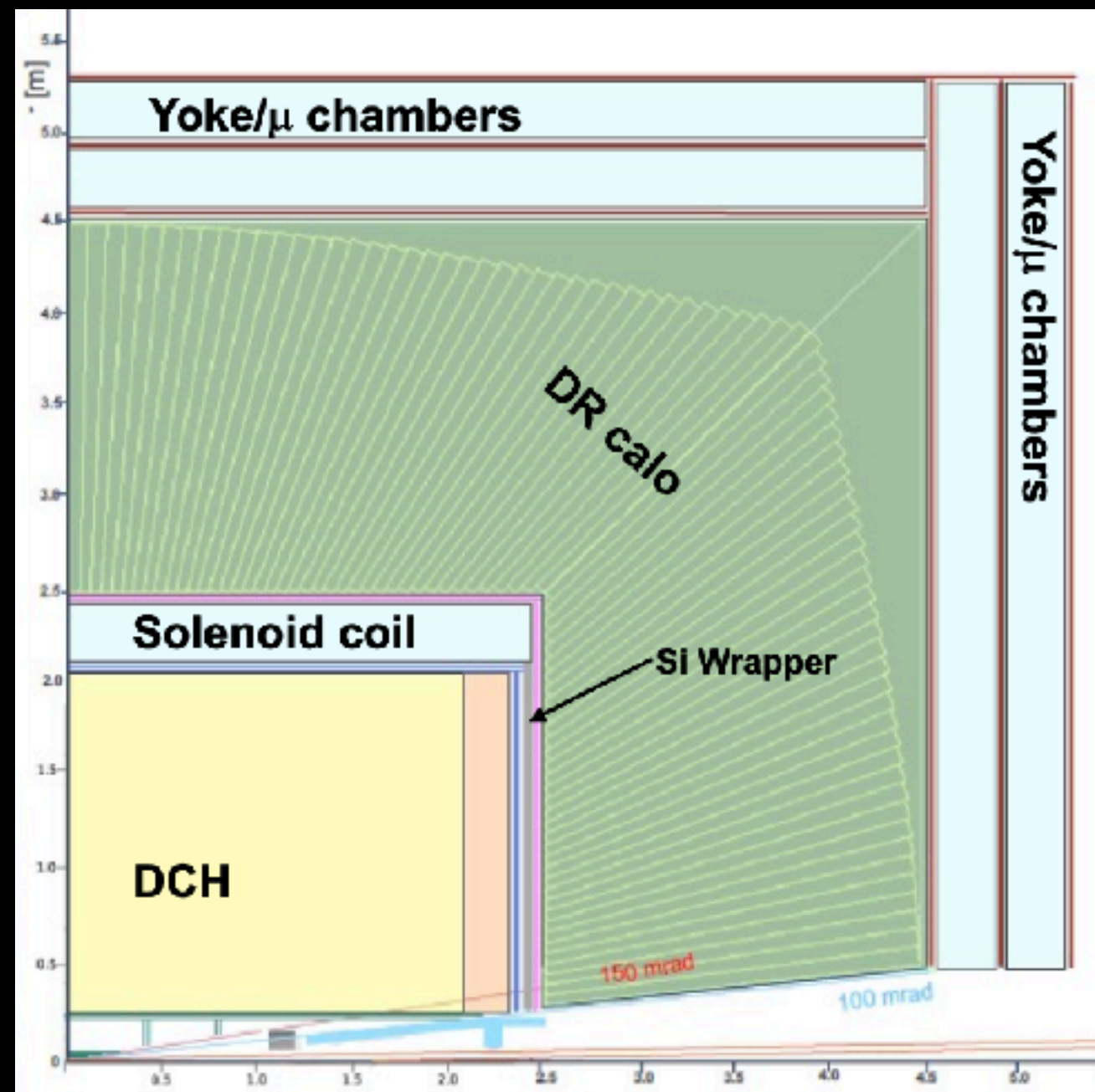
Migrate to a new process: HLMC 55 nm HV-CMOS

Possibility of producing in chinese foundry

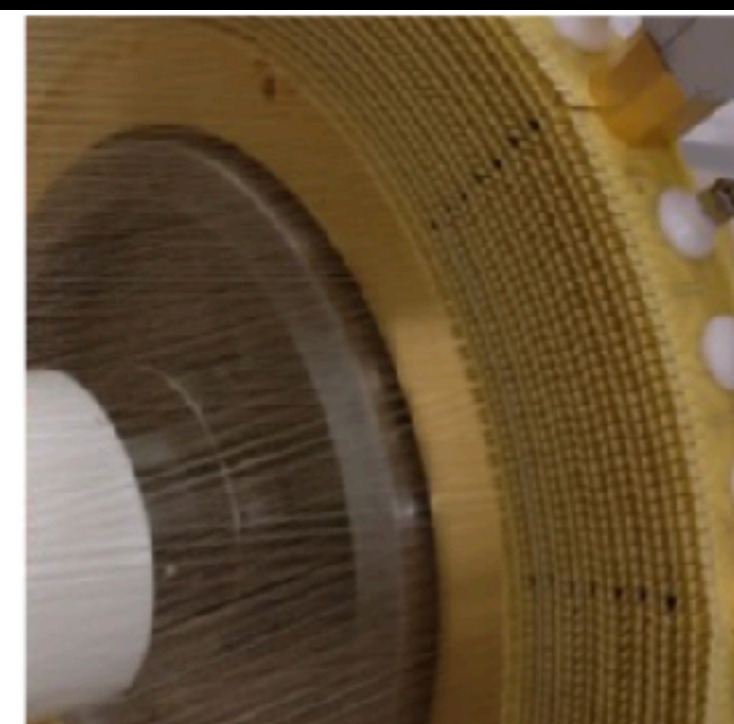
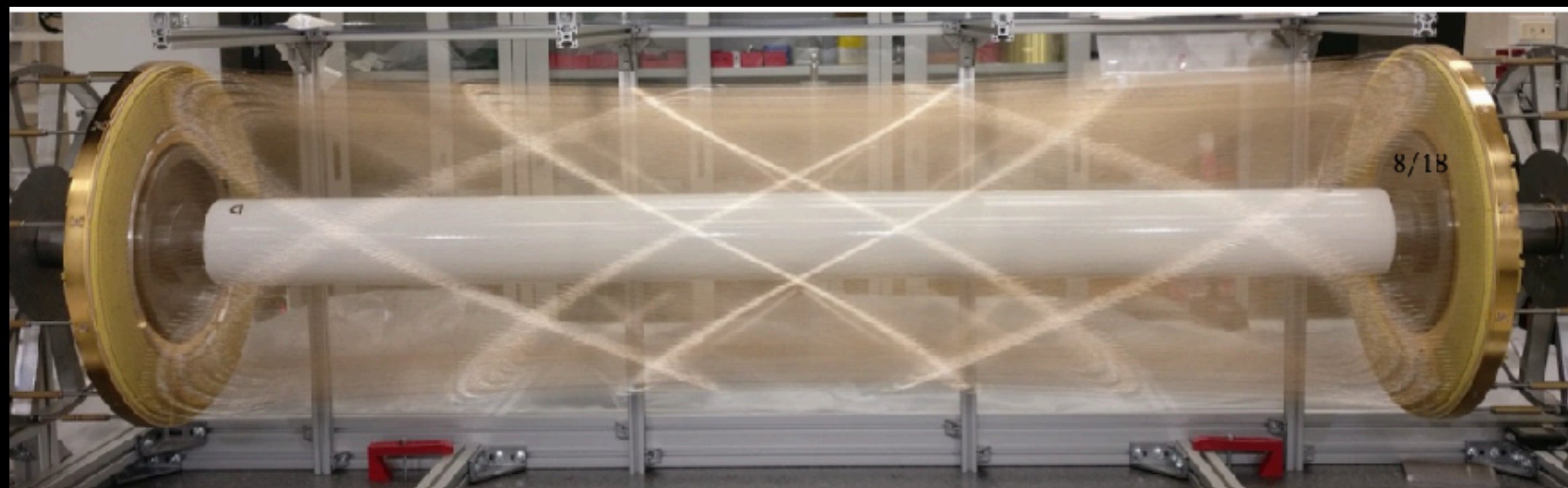


# Drift Chamber

## IDEA Drift Chamber

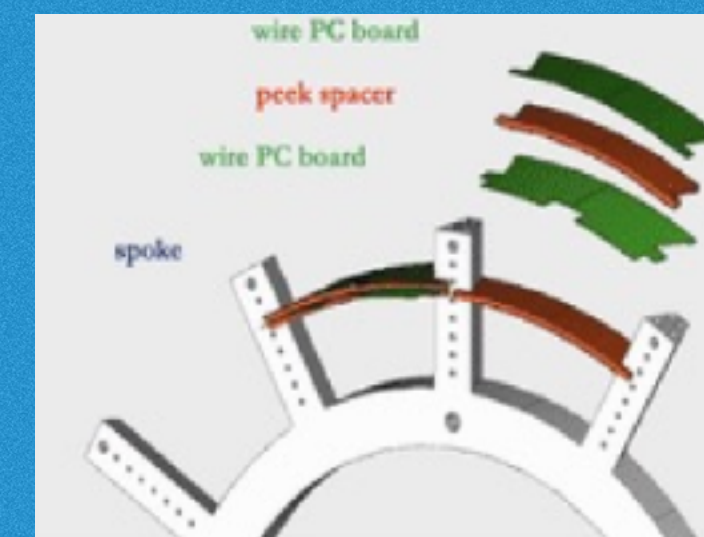


Design based on MEG-II drift chamber

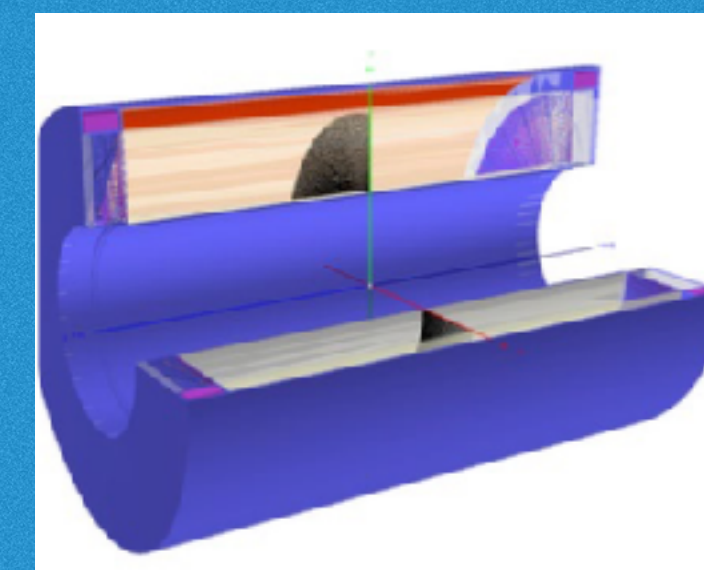


On-going work

Mechanical design



Geant4 simulation

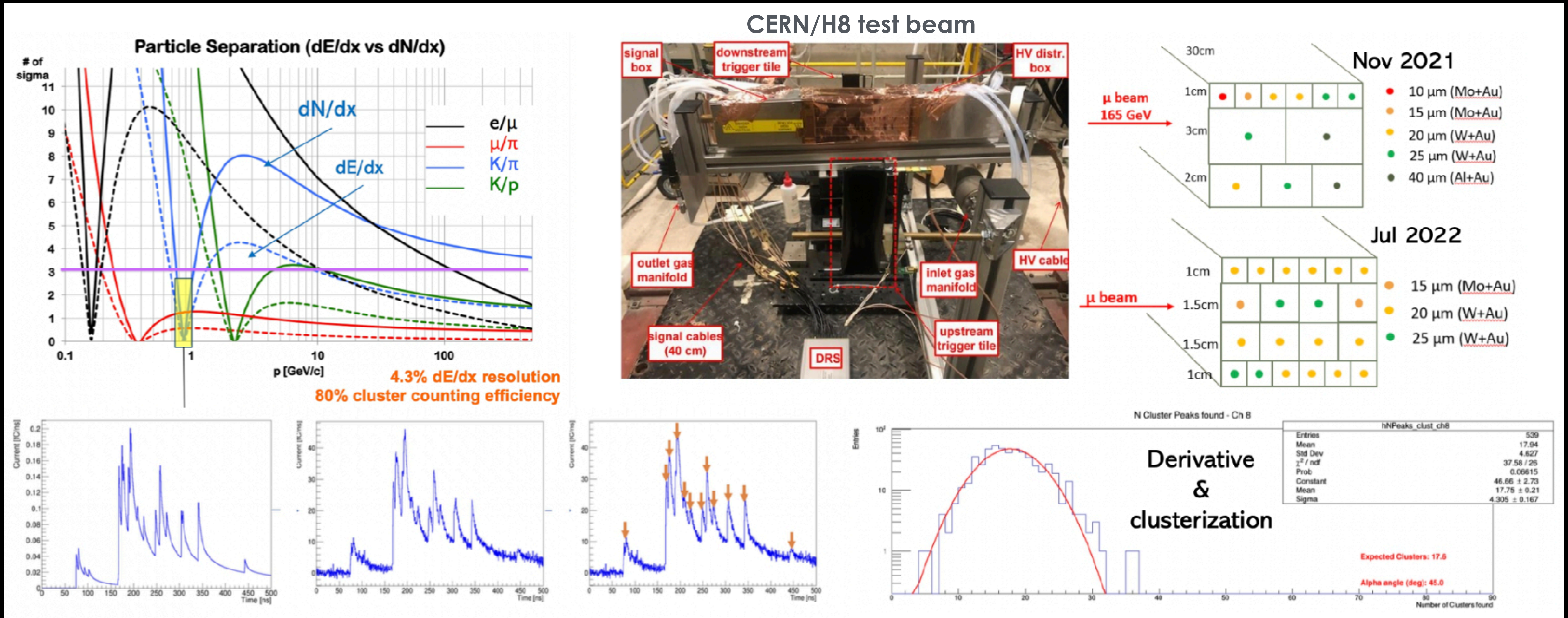


Particle identification studies



# CEPC R&D: Particle Identification—Drift Chamber ( $dN_{cl}/dx$ )

Cluster counting potentially a factor  $\sim 2$  better than  $dE/dx$ , but requires **fast electronics** and good **counting algorithms**



- Essential to have a high efficiency and accurate counting of clusters
- Multiple peak finding algorithm are developed & tested
- Test beam result seems matched the expectation



# Collaboration on Drift Chamber and Tracking - Regular meetings

## Cluster counting regular meeting

September 2022
📅 Sep 15 <a href="#">Meeting on cluster counting in drift chambers</a>
July 2022
📅 Jul 28 <a href="#">Meeting on cluster counting in drift chambers</a>
May 2022
📅 May 05 <a href="#">Meeting on cluster counting in drift chambers</a>
April 2022
📅 Apr 07 <a href="#">Meeting on cluster counting in drift chambers</a>
March 2022
📅 Mar 17 <a href="#">Meeting on cluster counting in drift chambers</a>
February 2022
📅 Feb 18 <a href="#">Meeting on cluster counting in drift chambers</a>

- **Called by:**
  - Franco and Linghui
- **Participants from:**
  - IHEP
  - INFN
  - Shandong University
  - Jilin University
  - BINP

## Tracker layout optimization discussion

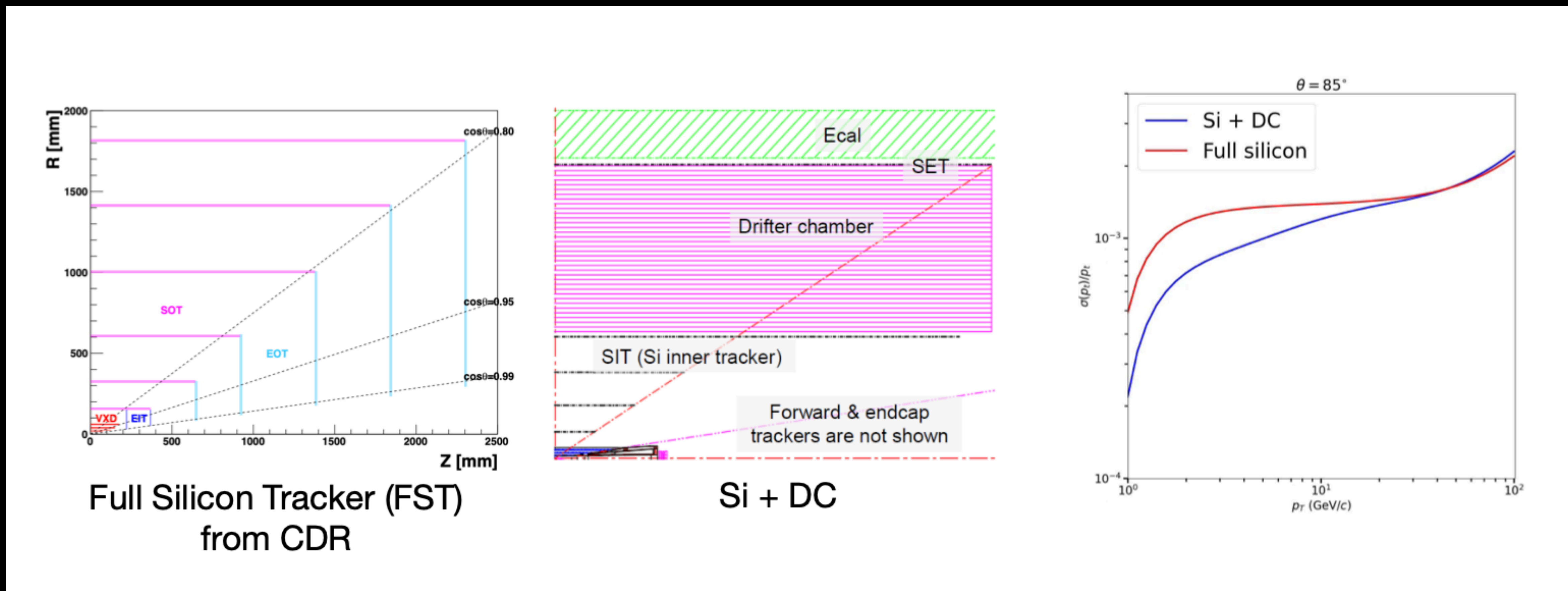
October 2022
📅 Oct 21 <a href="#">CEPC Drift Chamber Meeting</a>
September 2022
📅 Sep 23 <a href="#">CEPC Drift Chamber Meeting</a>
📅 Sep 16 <a href="#">CEPC Drift Chamber Meeting</a>
📅 Sep 02 <a href="#">CEPC Drift Chamber Meeting</a>
August 2022
📅 Aug 26 <a href="#">CEPC Drift Chamber Meeting</a>
📅 Aug 19 <a href="#">CEPC Drift Chamber Meeting</a>
📅 Aug 12 <a href="#">CEPC Drift Chamber Meeting</a>
July 2022
📅 Jul 22 <a href="#">CEPC Drift Chamber Meeting</a>
📅 Jul 15 <a href="#">CEPC Drift Chamber Meeting</a>
📅 Jul 08 <a href="#">CEPC Drift Chamber Meeting</a>
June 2022
📅 Jun 24 <a href="#">Tracker Discussion</a>
📅 Jun 10 <a href="#">Tracker Discussion</a>
May 2022
📅 May 27 <a href="#">Tracker Discussion</a>
📅 May 20 <a href="#">Tracker Discussion</a>
📅 May 13 <a href="#">Tracker Discussion</a>
📅 May 07 <a href="#">Tracker Discussion</a>

- **Called by:**
  - Gang and Linghui
- **Participants from:**
  - IHEP
  - Lancaster University
  - Jilin University
  - Shandong University
  - Nanjing University



# CEPC tracking with drift chamber: 4th detector

Silicon inner tracker, silicon external tracker for precise measurement provide high resolution and still low Si-system budget



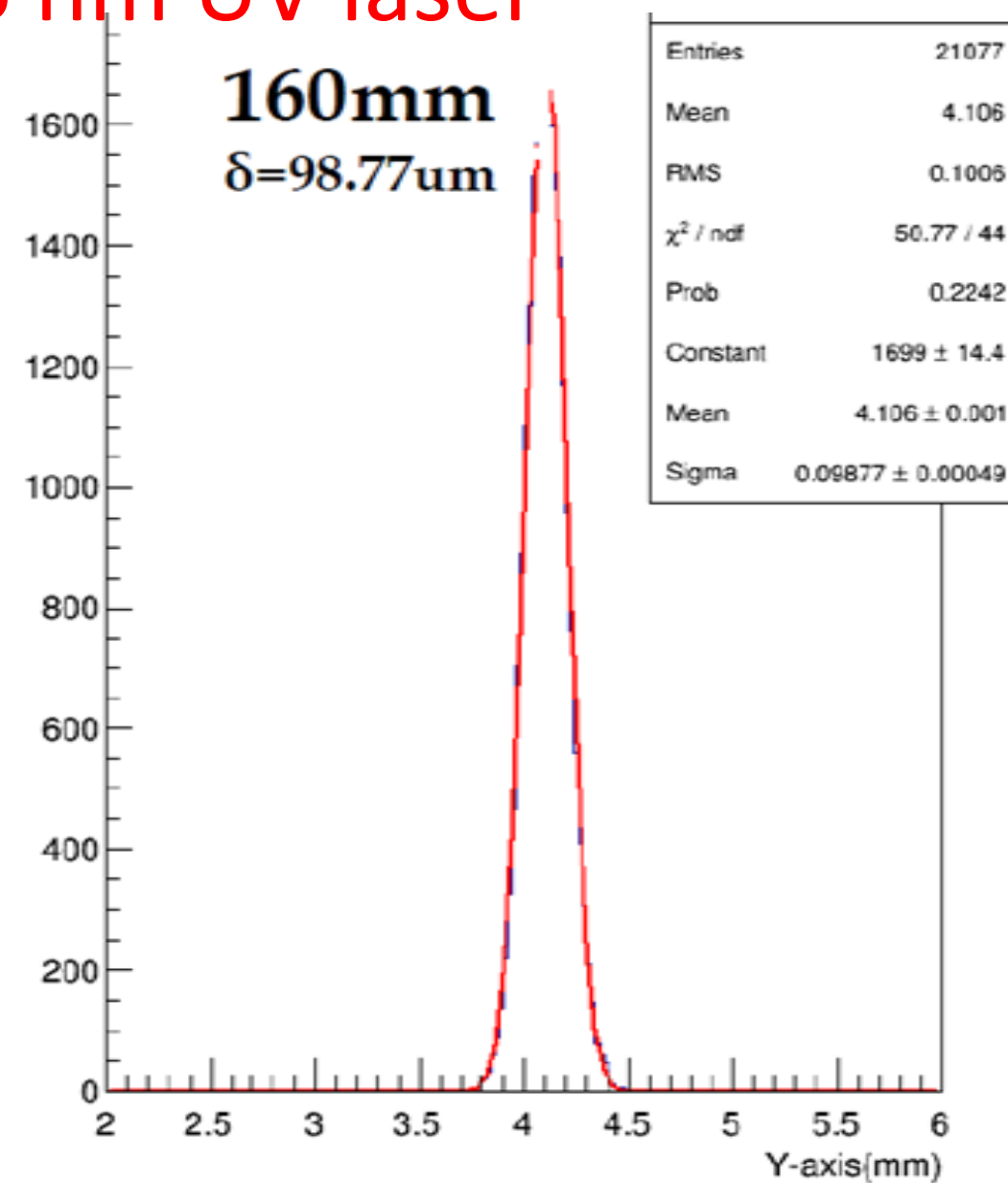
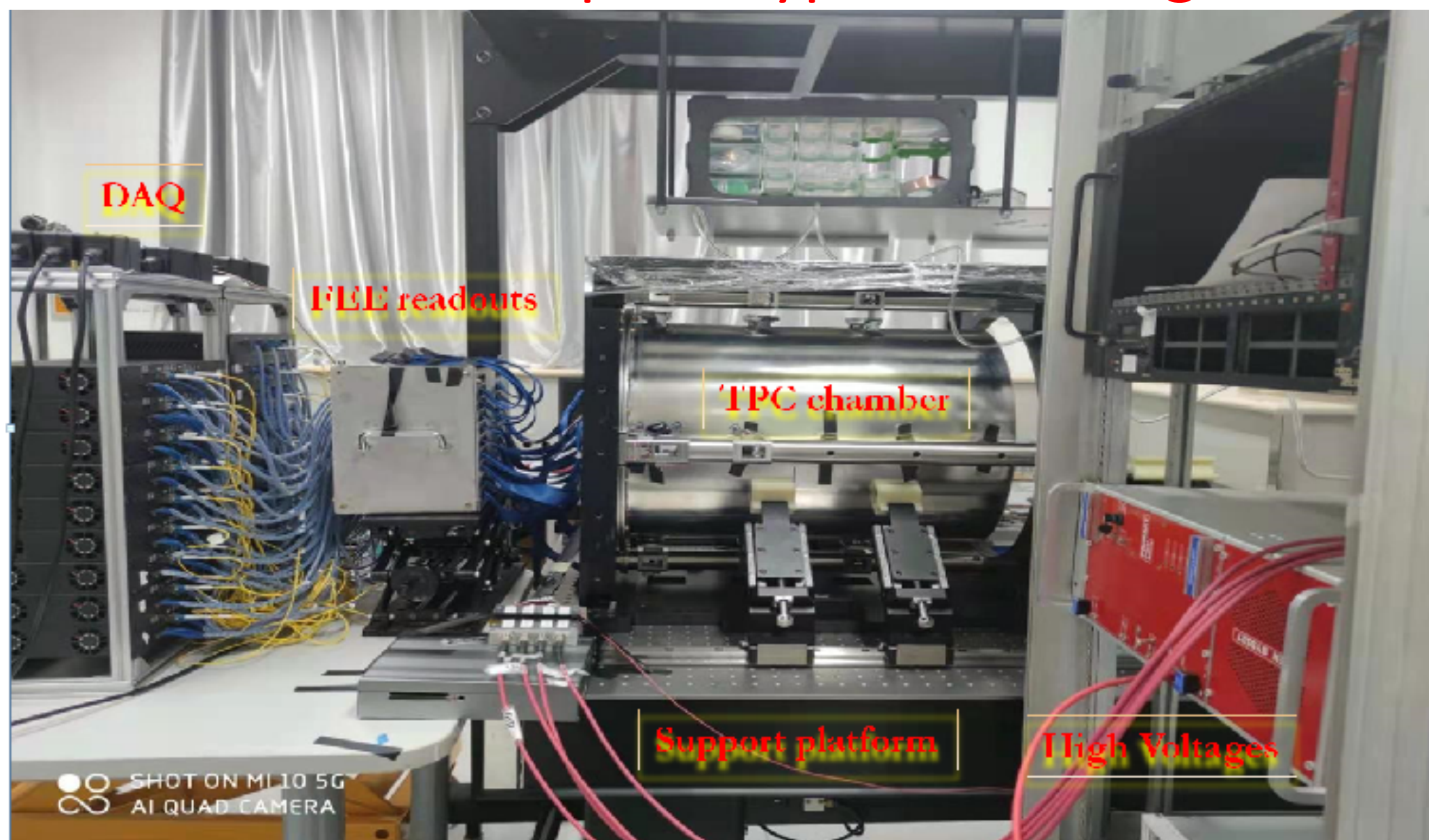
Si + DC design gives better momentum resolution than full Silicon design  $\sim p_T < 50$  GeV/c



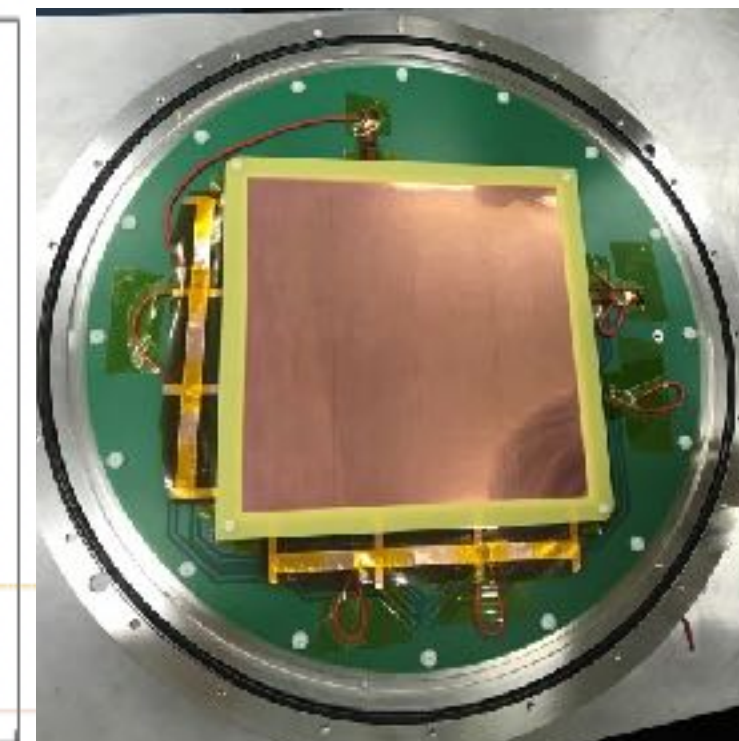
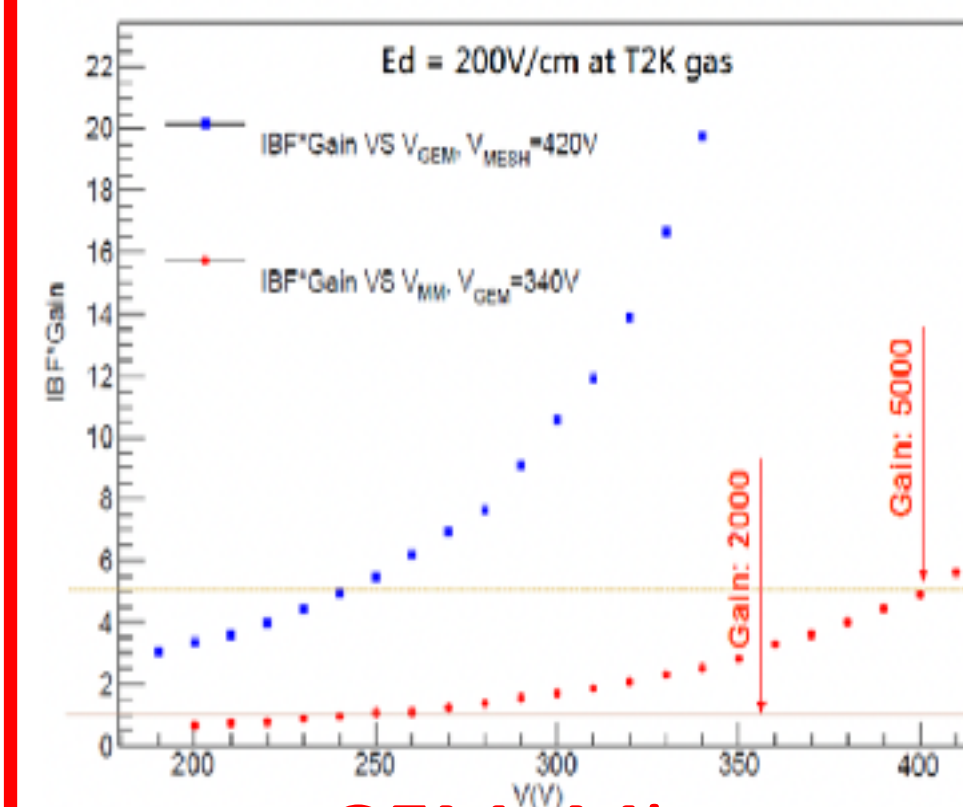
# CEPC TPC detector R&D

- CEPC TPC detector prototyping roadmap:
  - From TPC module to TPC prototype R&D for beam test
  - Low power consumption FEE ASIC R&D (reach **<5mW/ch** including ADC)
- Achievement by far:
  - Suppression ions hybrid GEM+Micromegas module
    - IBFxGain **~1 at Gain=2000** validation with GEM/MM readout
  - Spatial resolution of  **$\sigma_{r\phi} \leq 100 \mu\text{m}$**  by TPC prototype
  - dE/dx for PID: **<4%** (as expected for CEPC baseline detector concept)

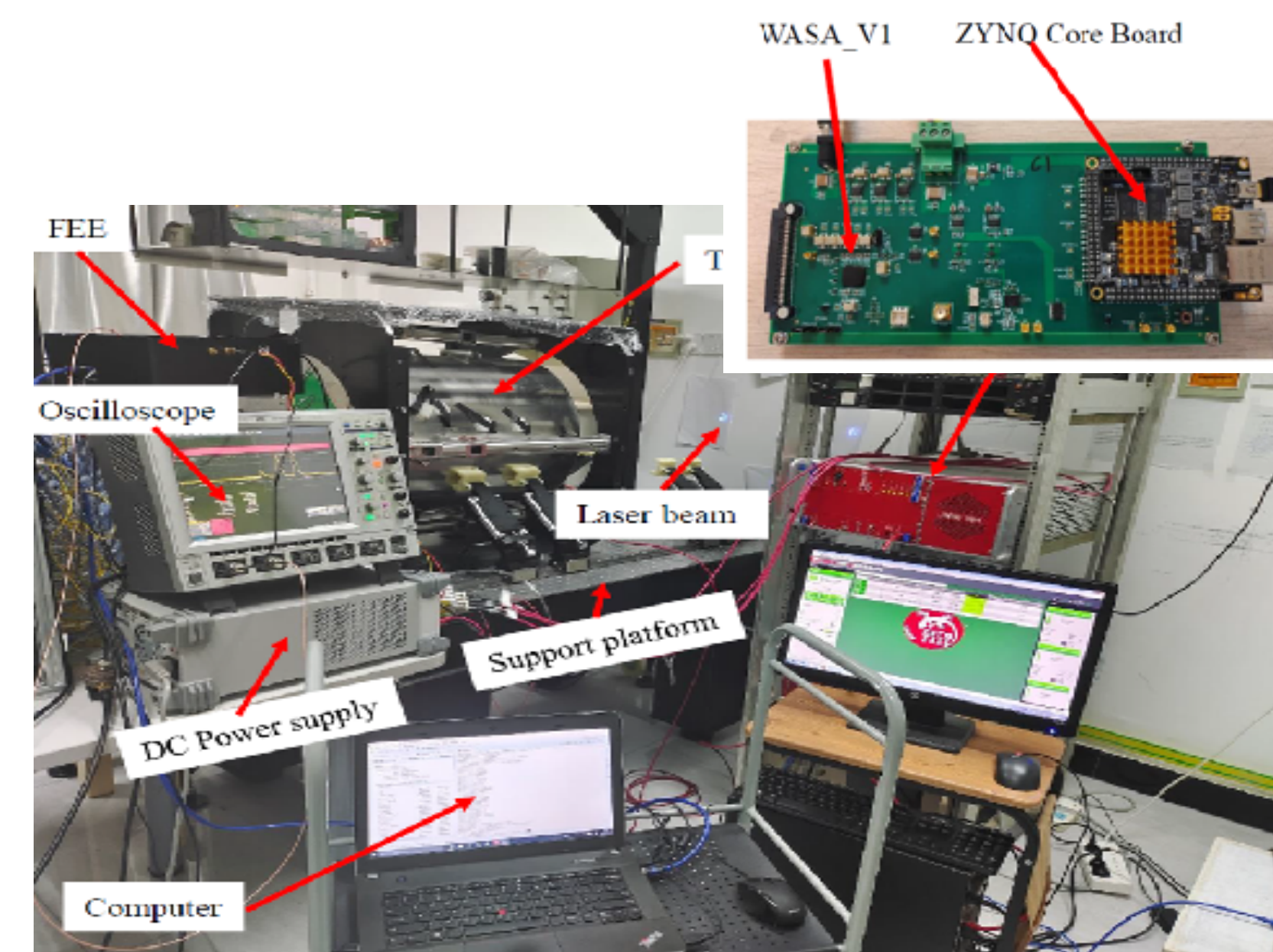
## TPC prototype with integrated 266 nm UV laser



## Achievement



GEM+Micromegas module R&D



Low power consumption readout



# CEPC TPC detector R&D

- Highlights of CEPC TPC detection technology R&D
  - Pad readout towards pixelated readout TPC to increased PID to 2-3%
  - Massive production and assemble MPGD lab has been setup at IHEP
  - Very activate international collaboration with LCTPC and RD51

Publications by TPC group:

<https://doi.org/10.1016/j.nima.2022.167241>

<https://doi.org/10.1109/NSS/MIC44867.2021.9875566>

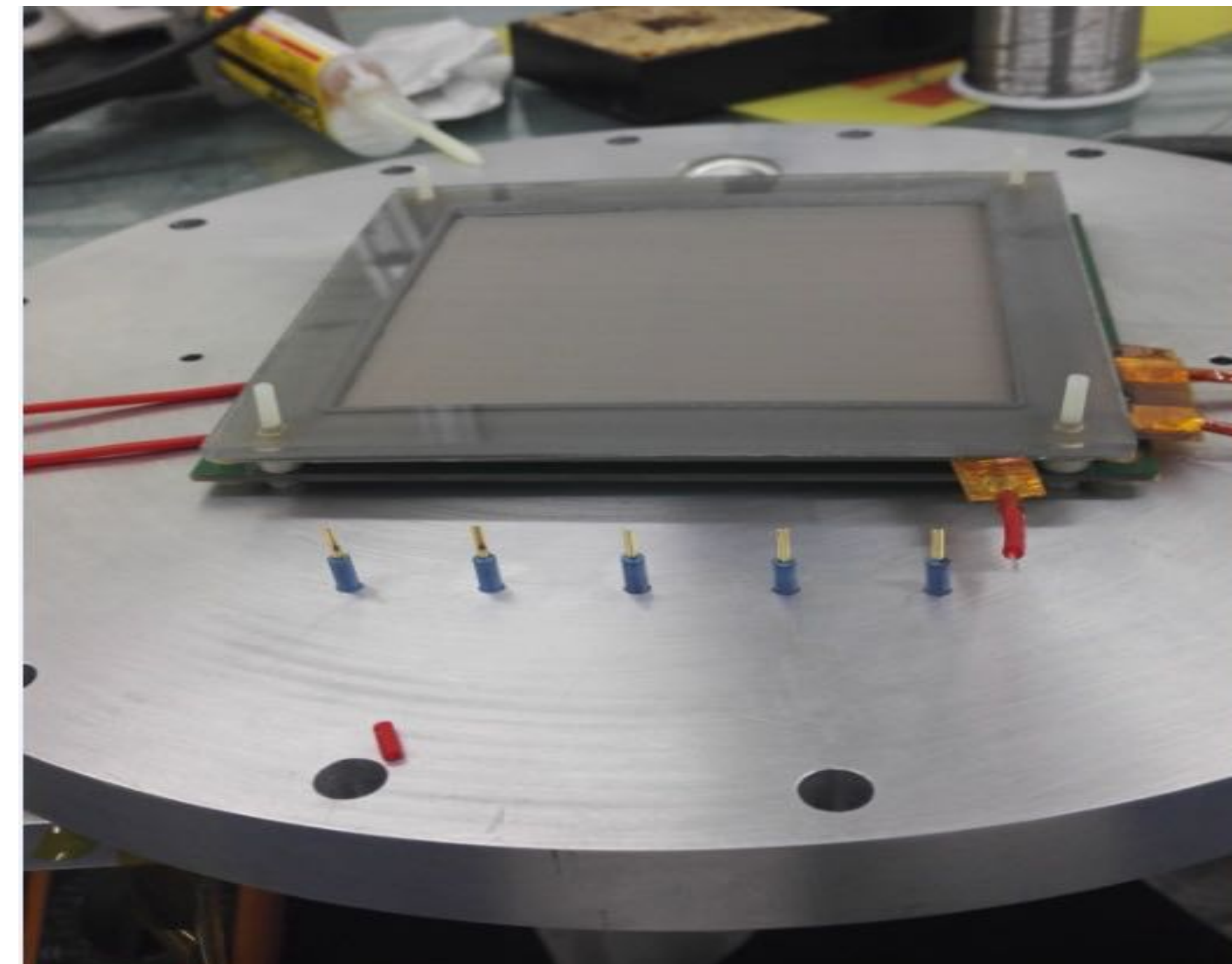
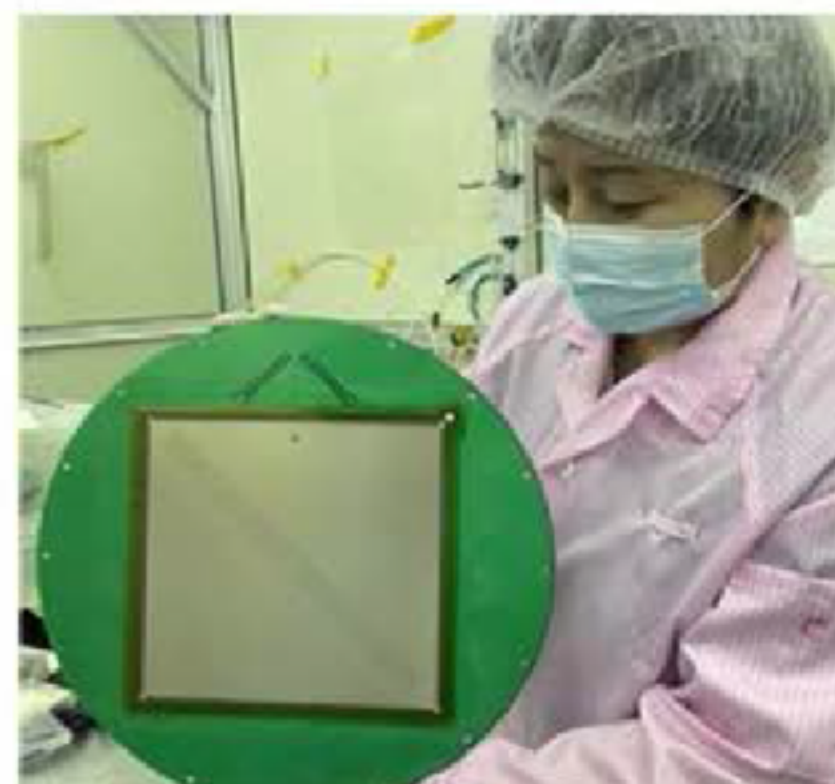
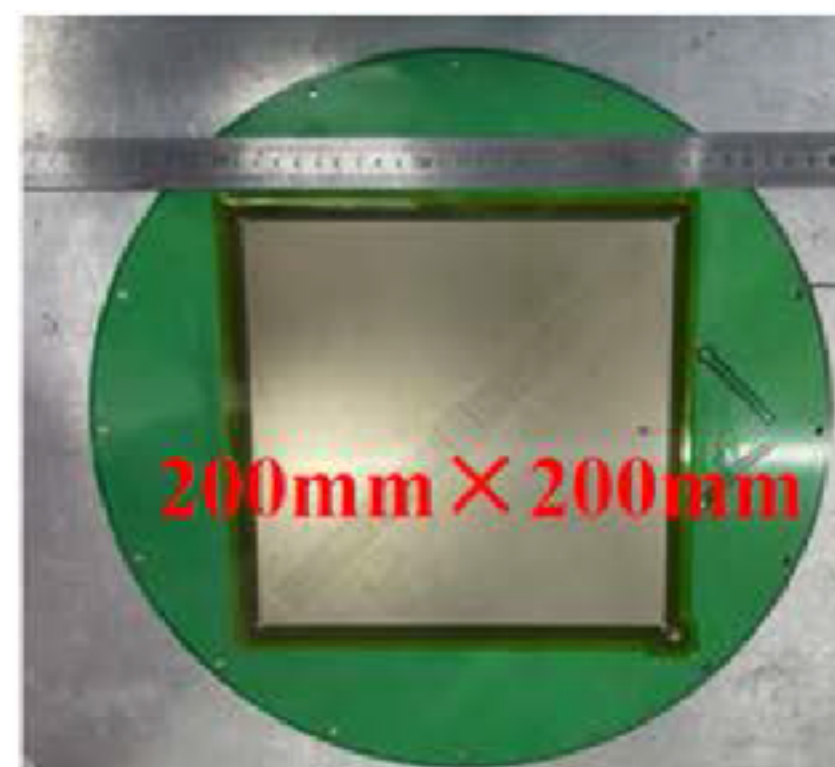
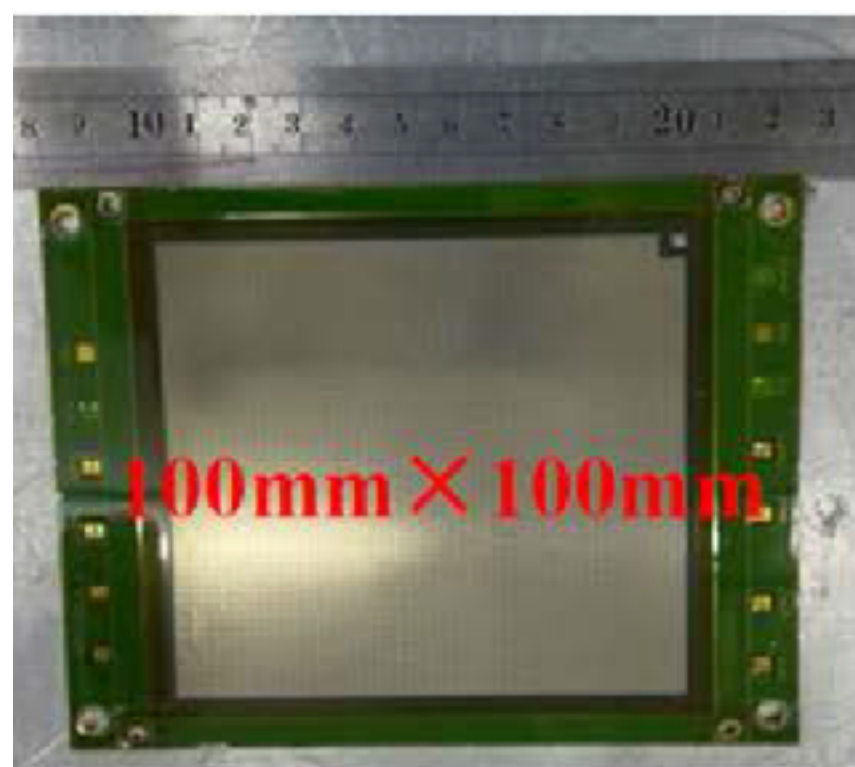
<https://doi.org/10.1088/1748-0221/15/09/C09065>

<https://doi.org/10.1088/1748-0221/15/05/P05005>

<https://dx.doi.org/10.1142/S0217751X20410146>

<https://doi.org/10.1088/1674-1137/41/5/056003>

<https://doi.org/10.1088/1748-0221/15/02/T02001>





# Pixelated readout TPC for dN/dx

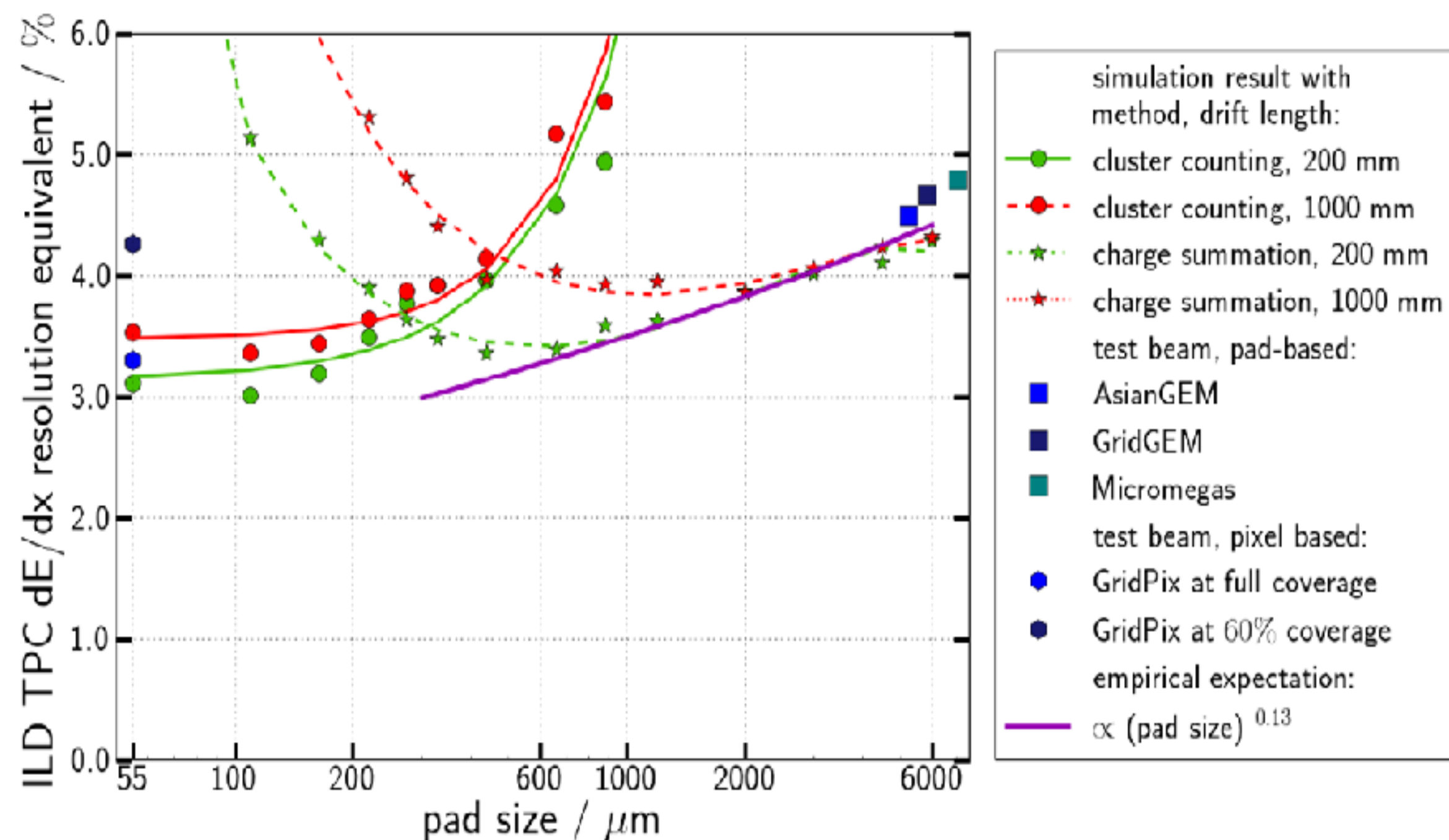
Current full CEPC TPC reconstruction: 6 mm pads  $\rightarrow$   $\sim 4.8\%$  dE/dx resolution

6mm  $\rightarrow$  1mm: 15% improved resolution via the charge summation (dE/dx)

6mm  $\rightarrow$  0.1mm: 30% improved resolution via the cluster counting (dN/dx)

## High readout granularity VS the primary cluster size optimization ongoing at IHEP

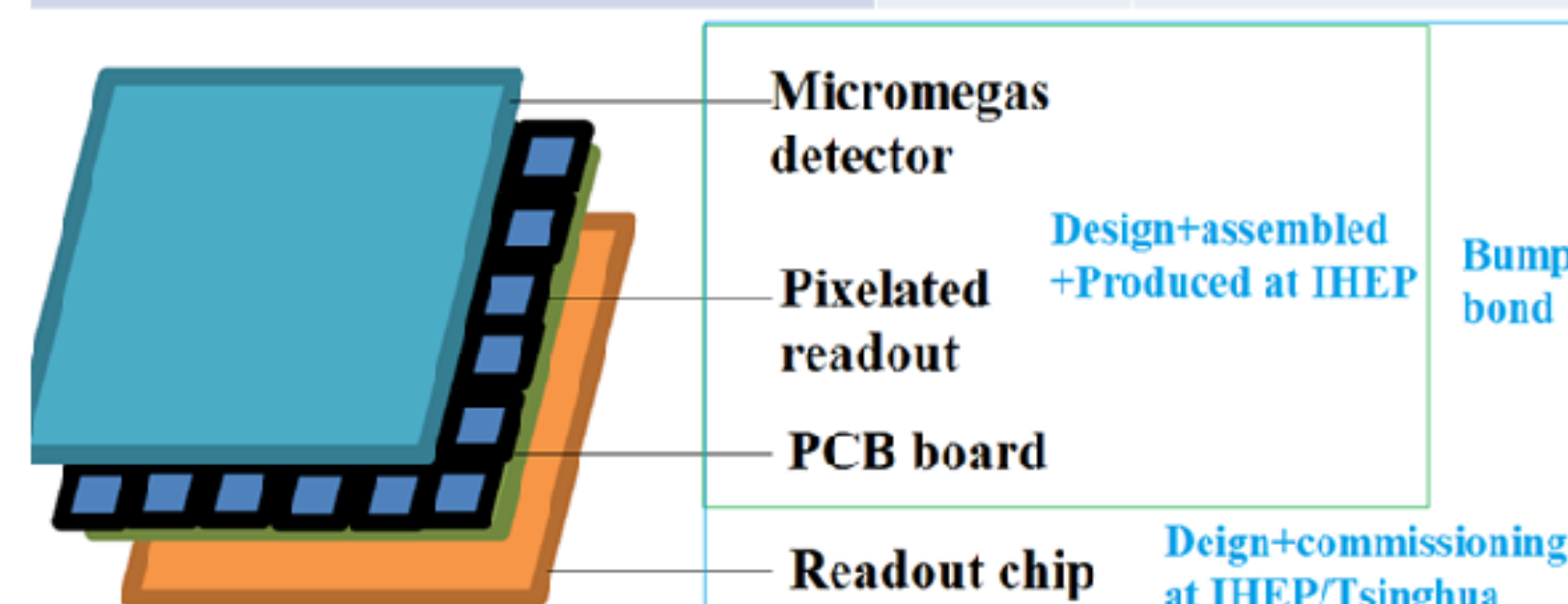
current resolution in the full CEPC TPC reconstruction with 6mm pads



Pad size of about  $300\mu\text{m}$  can record  $\sim 1$  primary cluster along track length with T2K gas

### Realization of pixelated technology collaborated with Tsinghua

Bump bond pixelated readout with Micromegas detector	Module size	To be addressed by R&D
<ul style="list-style-type: none"> <li><math>\geq 300\mu\text{m} \times 300\mu\text{m}</math></li> <li>Developed the readout chip by Tsinghua University</li> <li>Developed the Micromegas detector sensor at IHEP</li> <li>Development of the new module and prototype in the end of 2022</li> </ul>	1-2 cm <sup>2</sup>	<ul style="list-style-type: none"> <li>Research on pixelated readout technology realization</li> <li>Optimization of cluster profile and pad size</li> <li>Study of the 'dN<sub>cl</sub>+dx'</li> </ul>
	100 cm <sup>2</sup>	<ul style="list-style-type: none"> <li>Study the distortion using UV laser tracks and UV lamp to create ions disk</li> <li>In-situ calibration with UV Laser system</li> <li>Study of the 'dE/dx+dN<sub>cl</sub>/dx'</li> </ul>

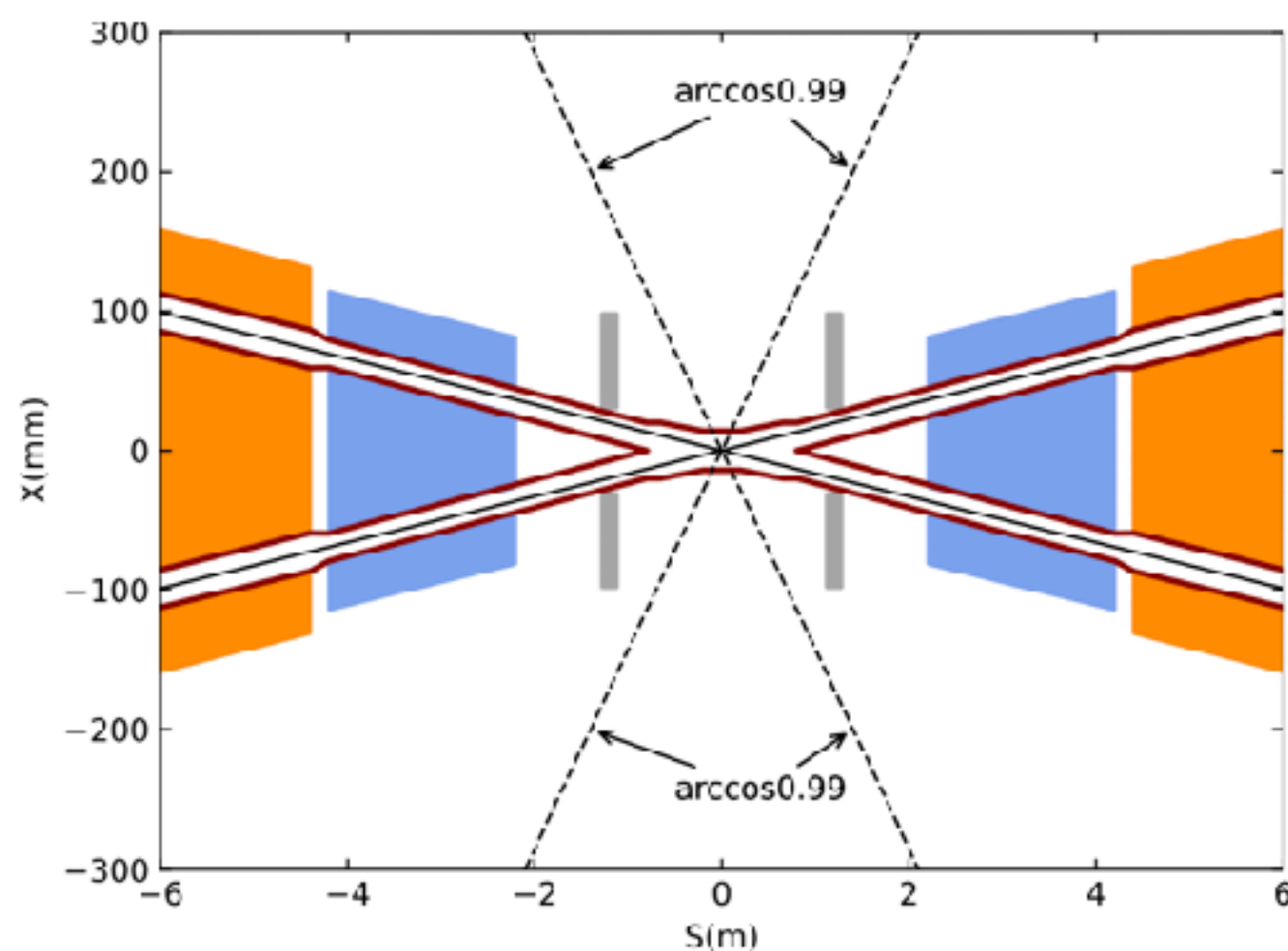


Tsinghua University  
University

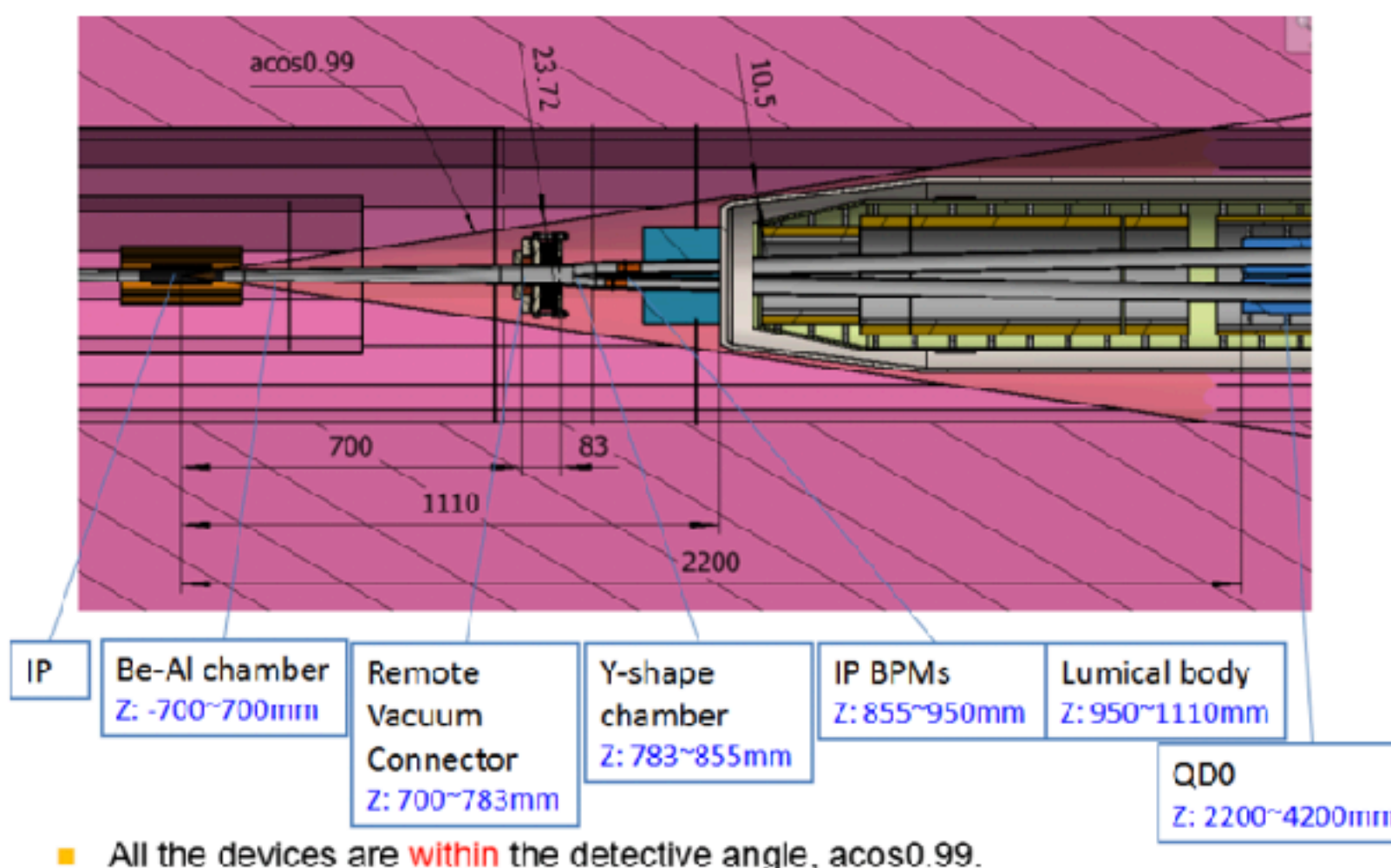


# CEPC R&D: Machine Detector Interface (MDI)

Crossing angle: 33 mrad  
Focal length: 2.2 m



Final focusing magnets (QD0, QF1) with Segmented Anti-Solenoidal Magnets



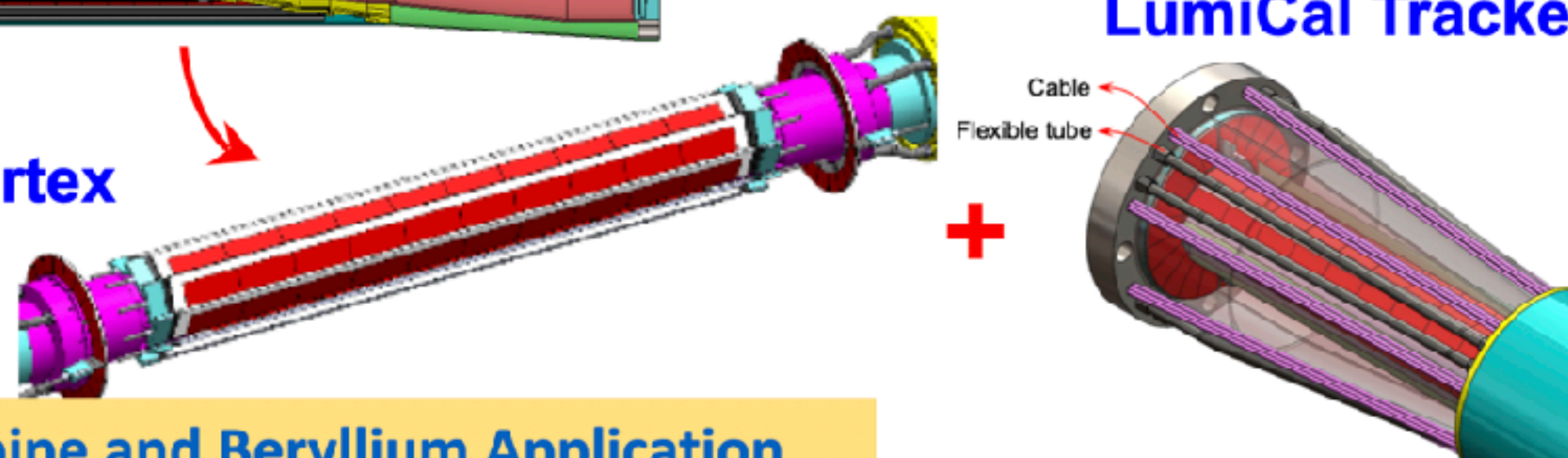
2021 Workshop on CEPC Detector & MDI Mechanical Design, Oct.22-23  
<https://indico.ihep.ac.cn/event/14392/>

Beam Pipe

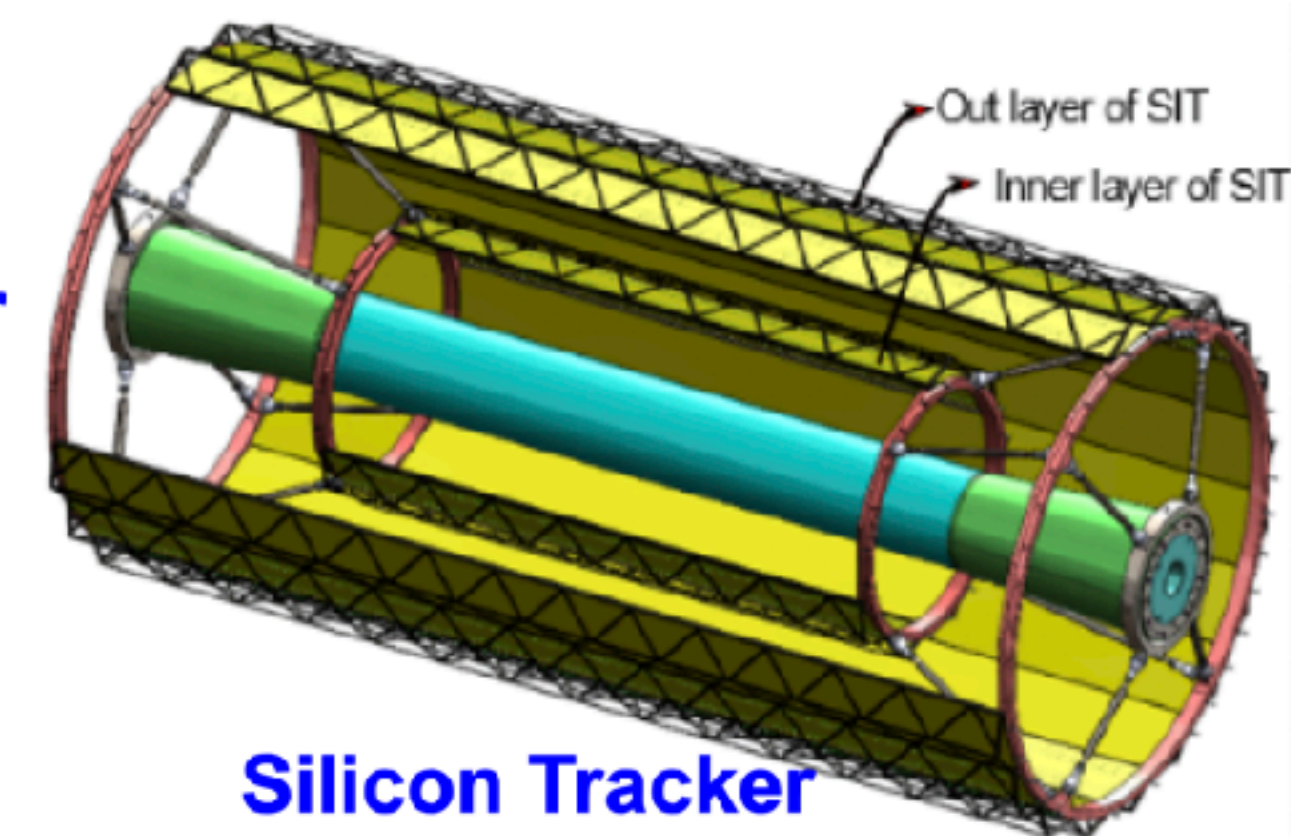
$\phi$  28 → 20 mm, Be thickness: 0.85 → 0.35 mm



Vertex



LumiCal Tracker



Silicon Tracker

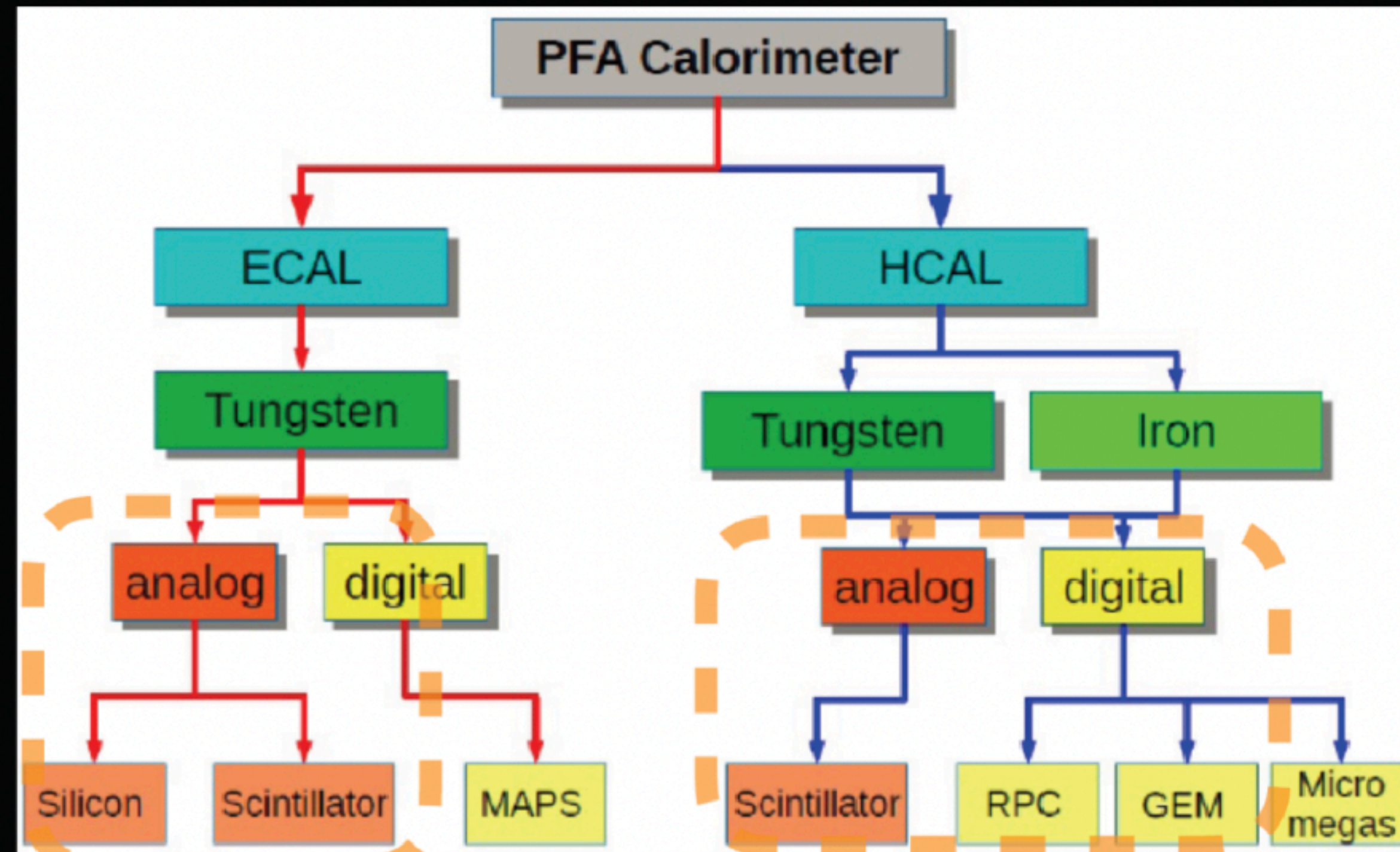
Workshop on CEPC Central Beampipe and Beryllium Application  
May 6, 2022, <https://indico.ihep.ac.cn/event/16173/>



# Calorimeter options

Chinese institutions have been focusing on Particle Flow calorimeters

R&D supported by **MOST**, **NSFC** and **IHEP** seed funding



High Granularity

Newer Options

**Electromagnetic** ECAL with **Silicon** and Tungsten (LLR, France)  
 ECAL with **Scintillator+SiPM** and Tungsten (IHEP + USTC)

**Hadronic** SDHCAL with **RPC** and Stainless Steel (SJTU + IPNL, France)  
 SDHCAL with **ThGEM/GEM** and Stainless Steel (IHEP + UCAS + USTC)  
 HCAL with **Scintillator+SiPM** and Stainless Steel (IHEP + USTC + SJTU)

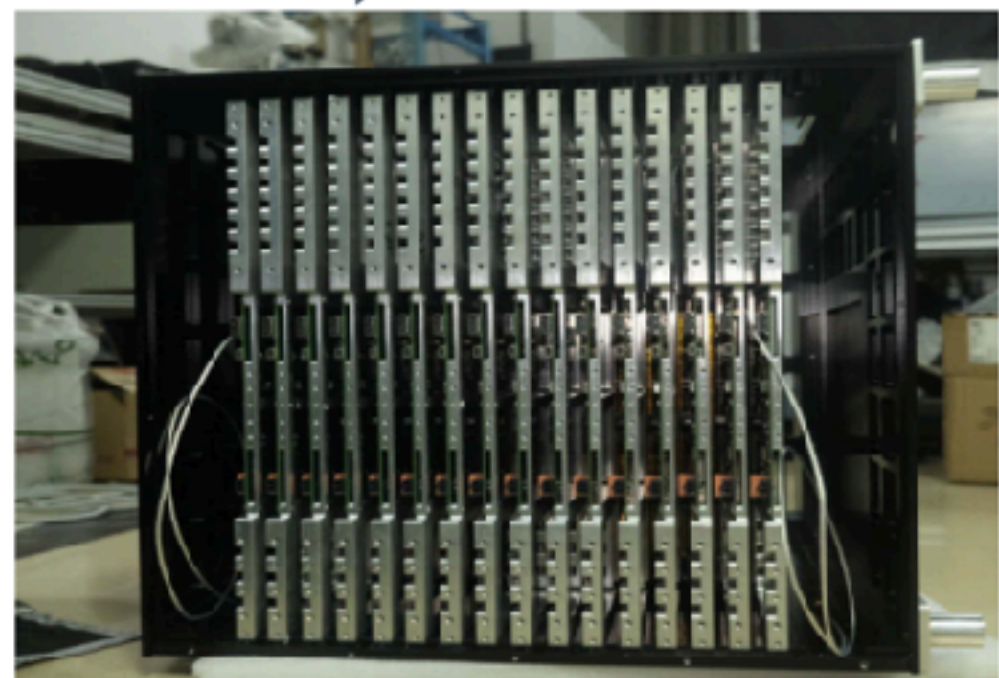
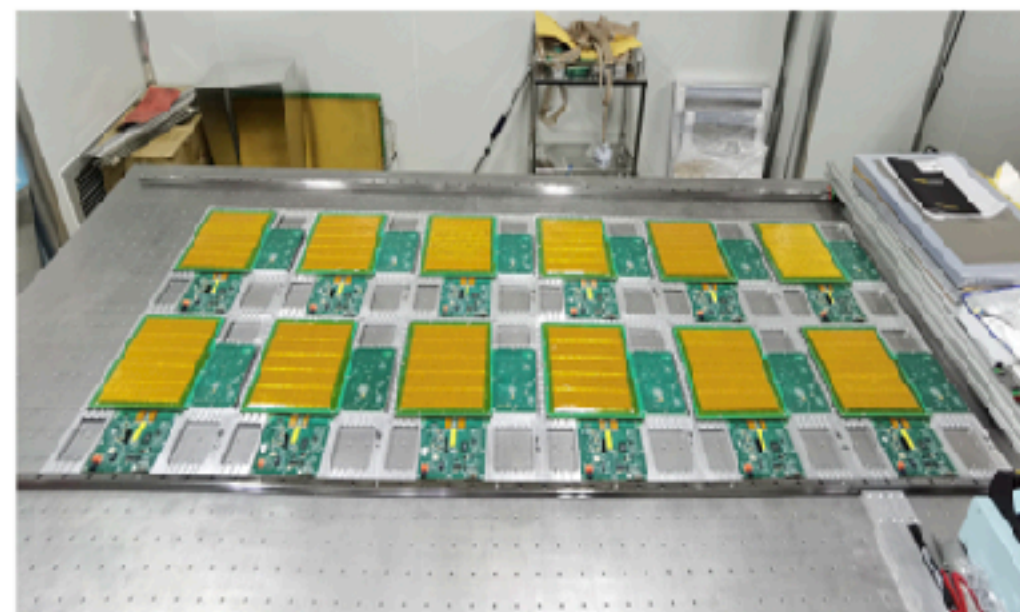
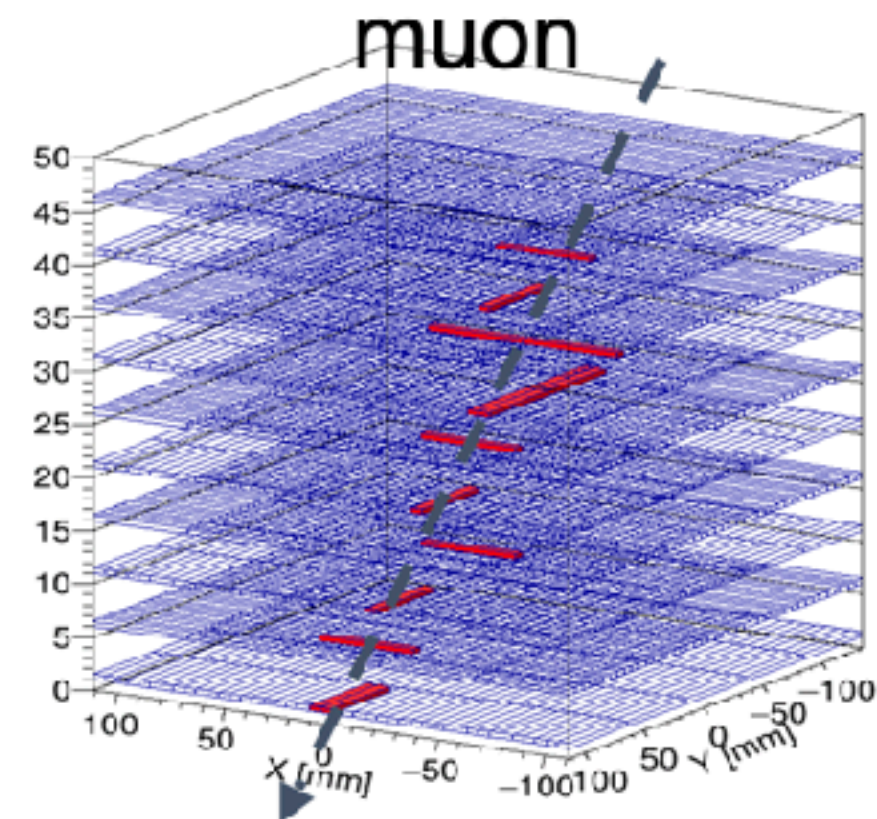
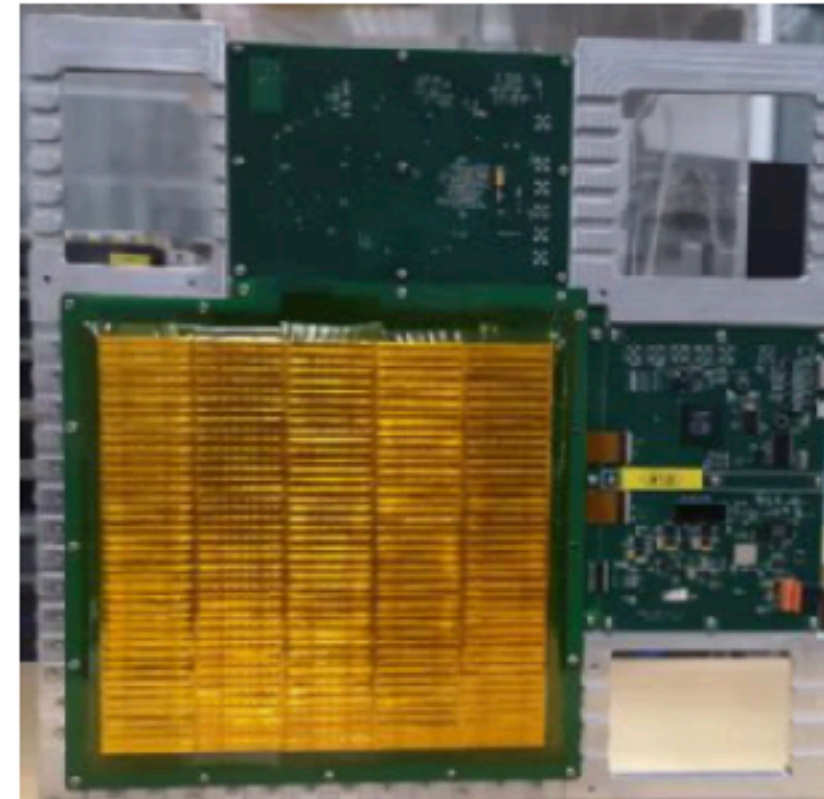
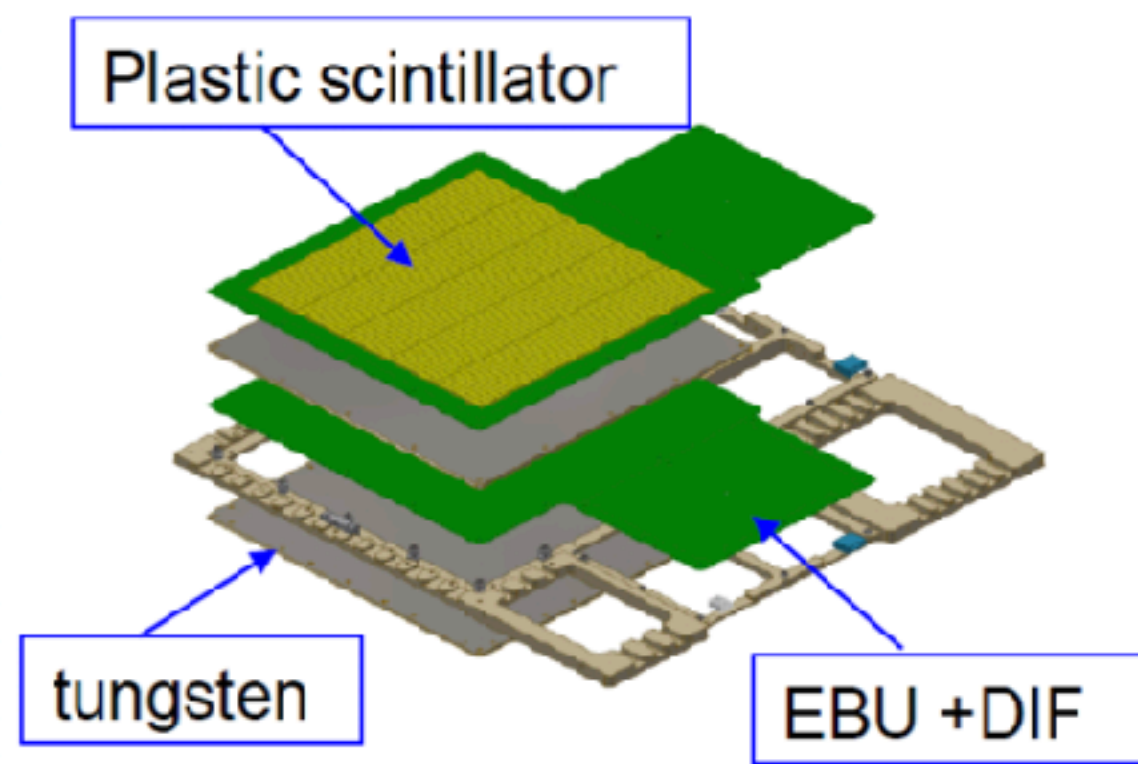
Some longitudinal granularity

**Crystal** Calorimeter (LYSO:Ce + PbWO)  
**Dual readout** calorimeters (INFN, Italy + Iowa, USA) — RD52

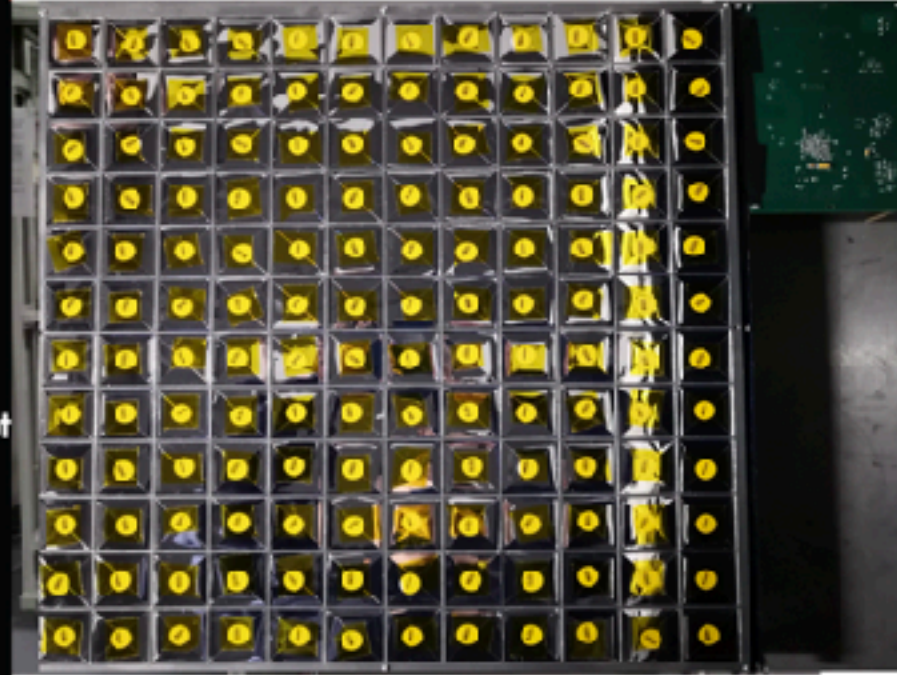
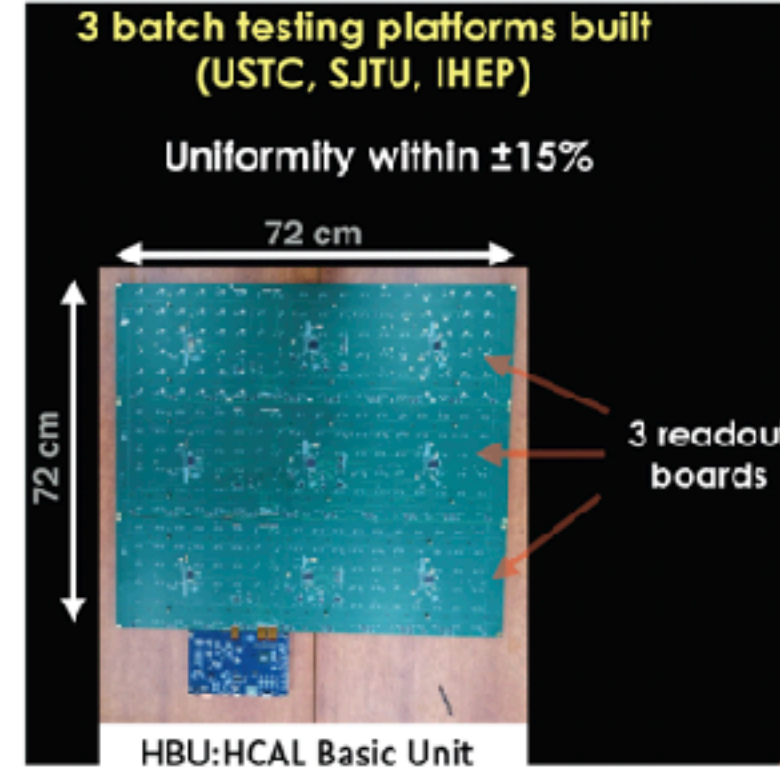


# CEPC R&D: Scintillating Calorimeters (ECAL, AHCAL)

## Scintillator-W ECAL Prototype



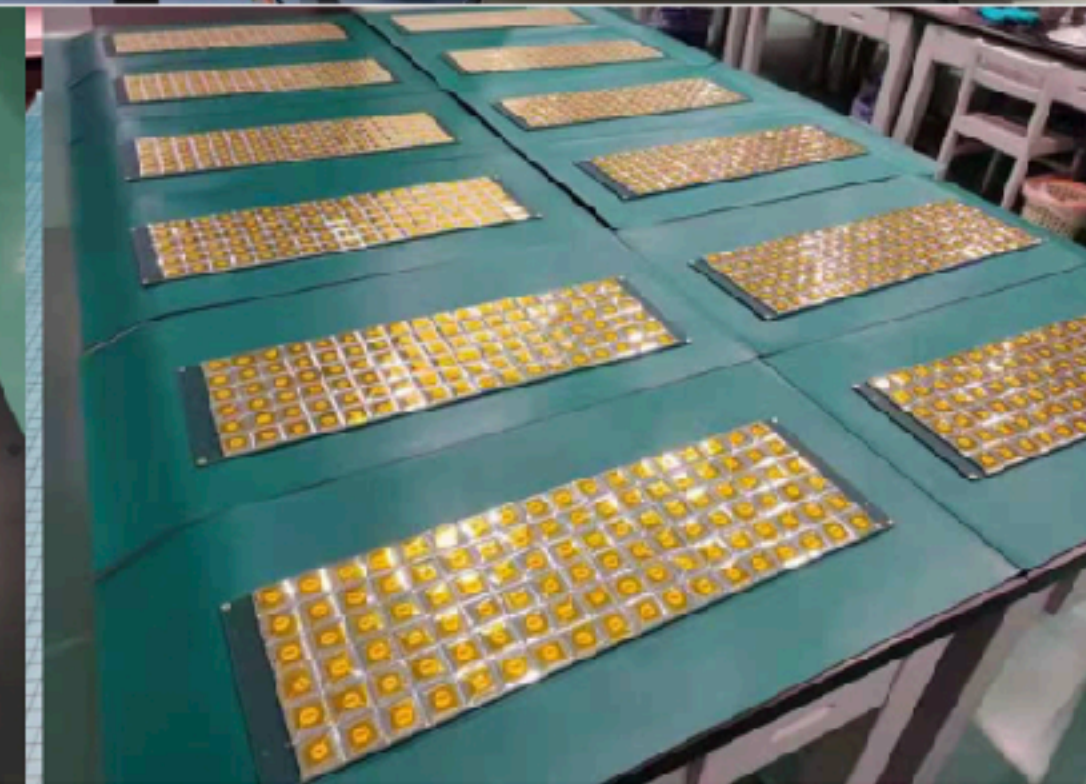
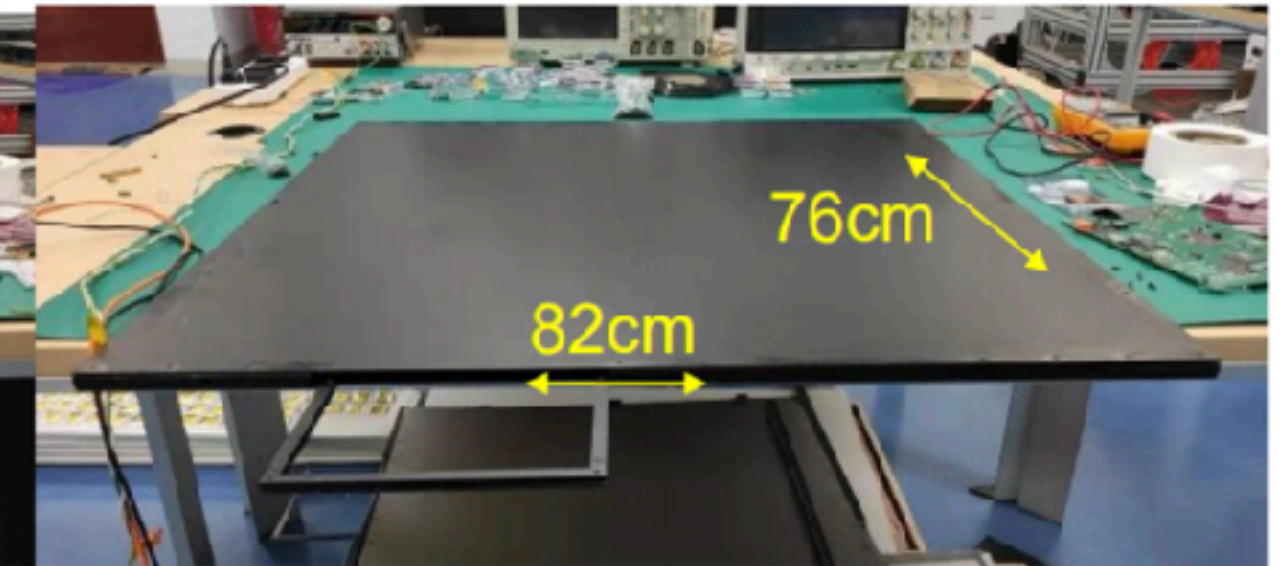
## Scintillator + SiPM AHCAL Prototype



SJTU



IHEP



Test beam at CERN SPS on-going, together with CALICE

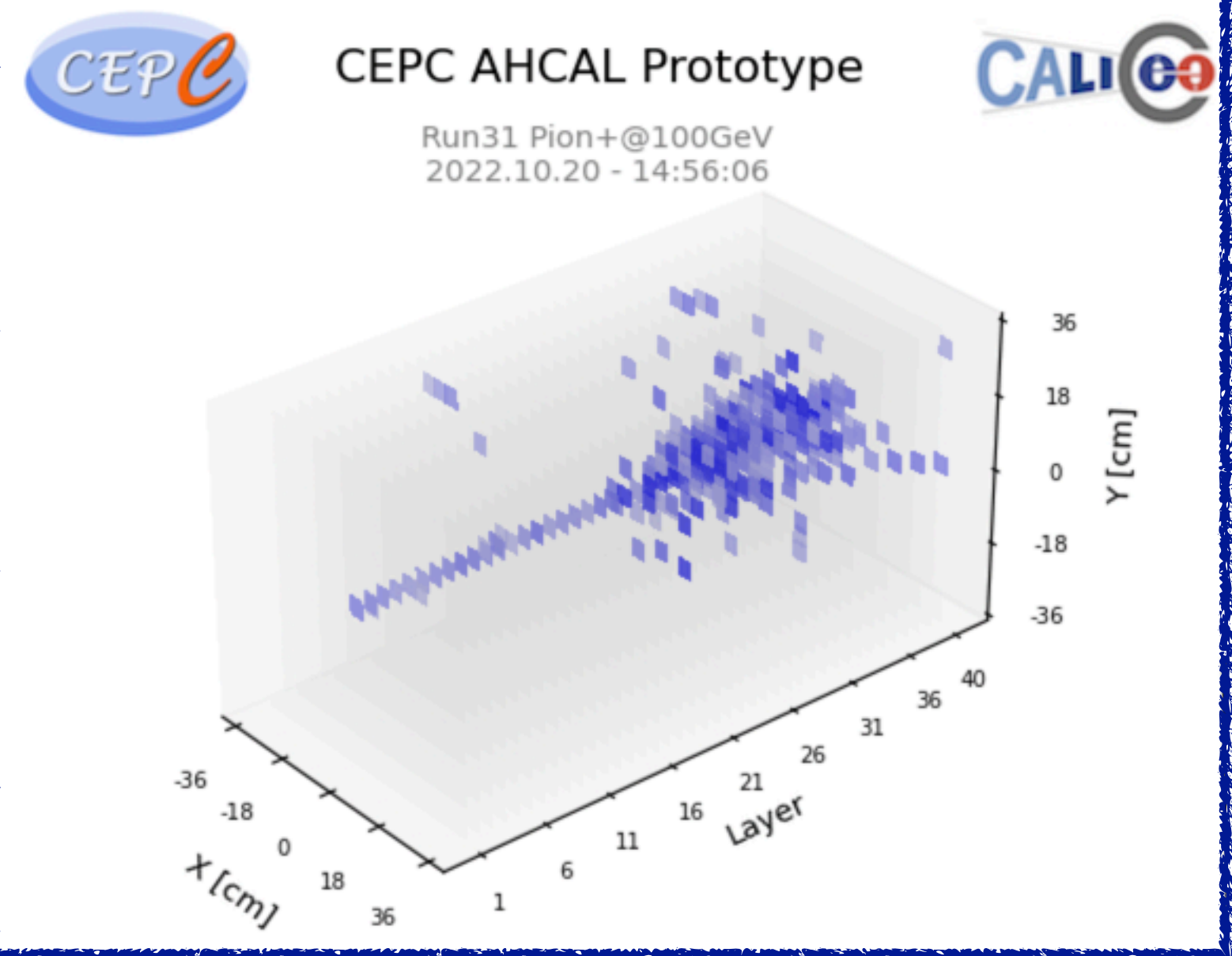


# CEPC R&D: Scintillating Calorimeters (ECAL, AHCAL)

Combined ScW-ECAL and AHCAL test beam



IHEP



Test beam at CERN SPS on-going, together with CALICE

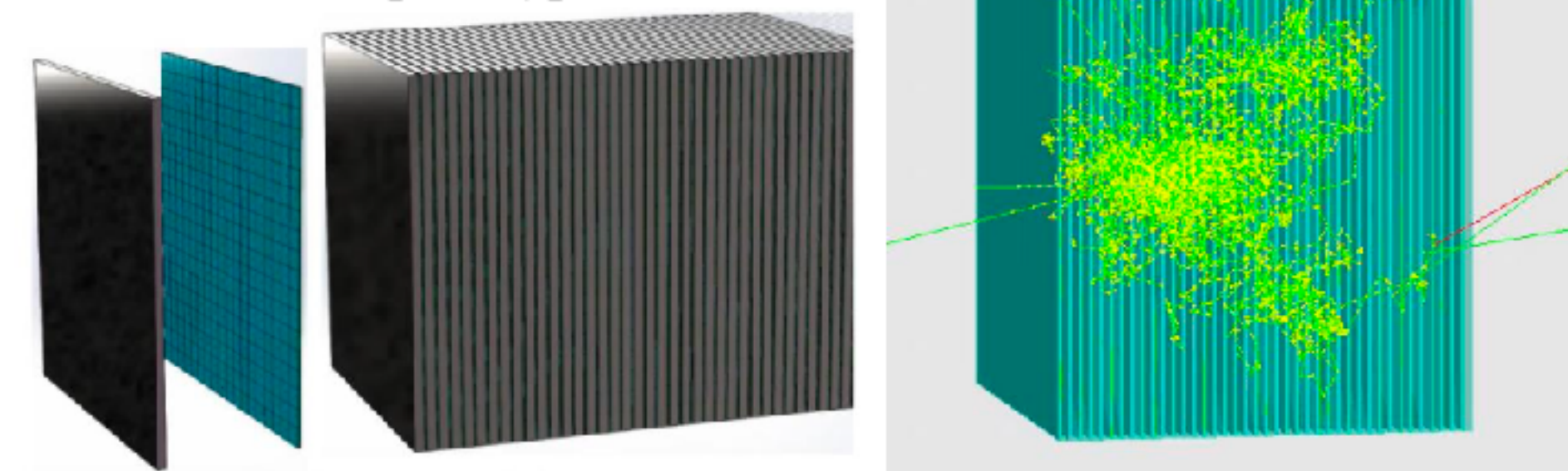


# CEPC R&D: New HCAL with Scintillating Glass Tiles

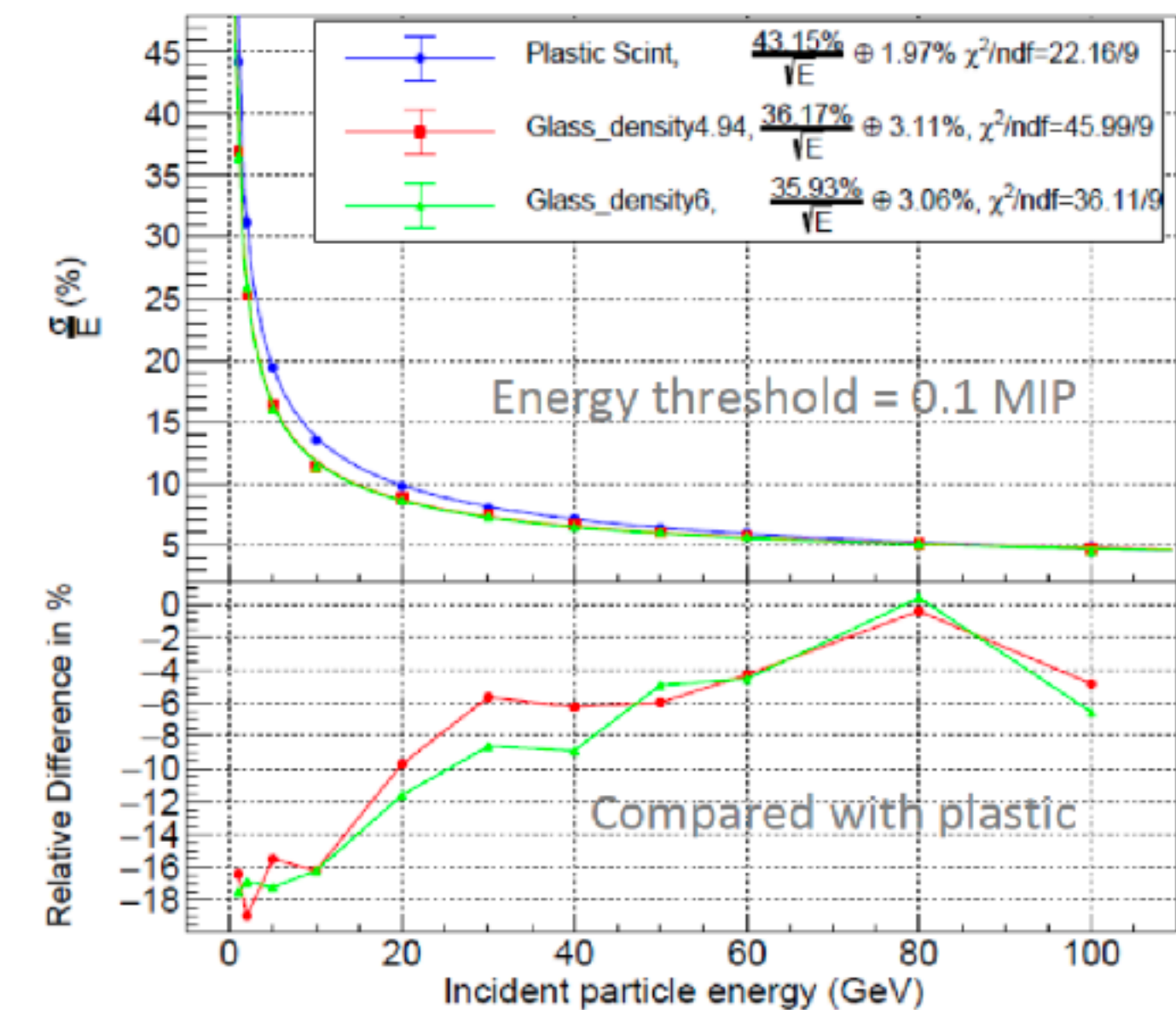
- **CEPC detector: highly granular calorimeter + tracker**
  - Boson Mass Resolution (BMR)  $\sim 4\%$  has been realized in baseline design
  - Further performance goal: BMR  $4\% \rightarrow 3\%$
- **New Option: Glass Scintillator HCAL (GS-HCAL)**
  - Higher density provides higher sampling fraction
  - Doping with neutron-sensitive elements: improve hadronic response (Gd)
  - More compact HCAL layout (given 4~5 nuclear interaction lengths in depth)

Design similar to baseline AHCAL

CEPC AHCAL prototype schematics



Key parameters	Value	Remarks
Tile size	$\sim 30 \times 30 \text{ mm}^2$	Reference CALICE-AHCAL, granularity, number of channels
Tile thickness	$\sim 10 \text{ mm}$	Energy resolution, Uniformity and MIP response
<b>Density</b>	<b><math>6-7 \text{ g/cm}^3</math></b>	More compact HCAL structure with higher density
<b>Intrinsic light yield</b>	<b>1000-2000 ph/MeV</b>	Higher intrinsic LY can tolerate lower transmittance
Transmittance	$\sim 75\%$	
MIP light yield	$\sim 150 \text{ p.e./MIP}$	Needs further optimizations: e.g. SiPM type, SiPM-glass coupling
Energy threshold	$\sim 0.1 \text{ MIP}$	Higher light yield would help to achieve a lower threshold
Scintillation decay time	$\sim 100 \text{ ns}$	Mitigation pile-up effects at CEPC Z-pole (91 GeV)
Emission spectrum	Typically 350-600 nm	To match SiPM PDE and transmittance spectra

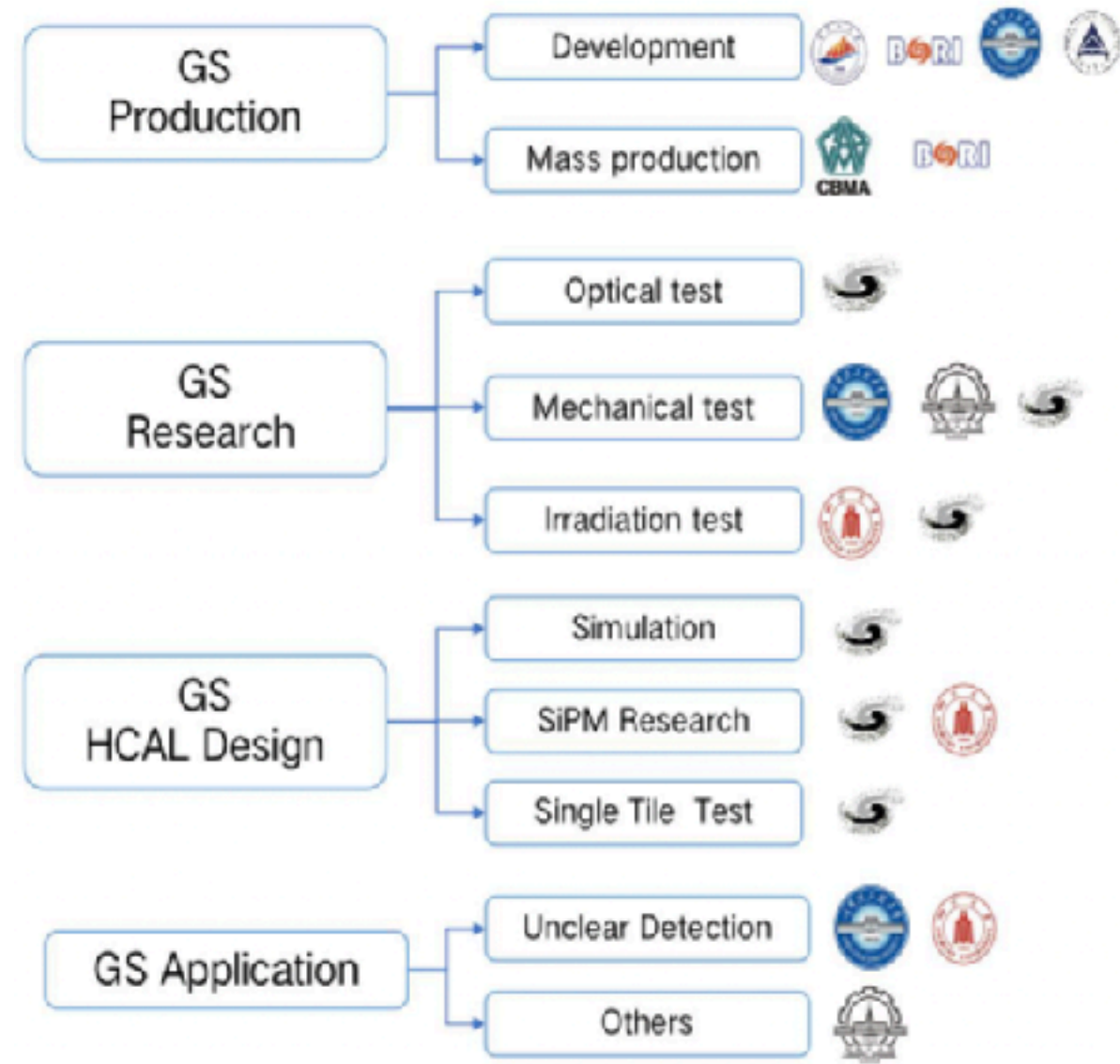


Better energy resolution than scintillator

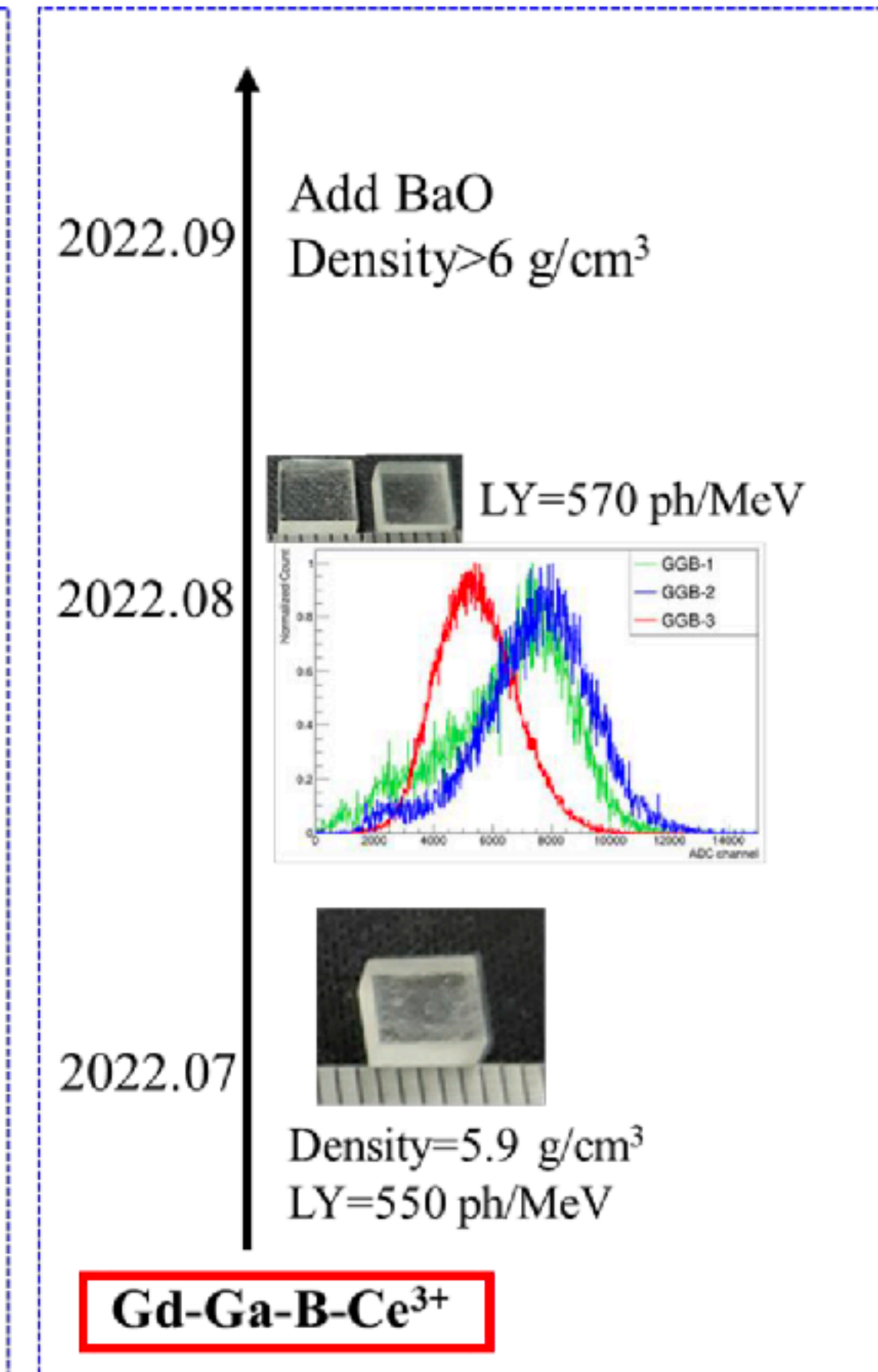
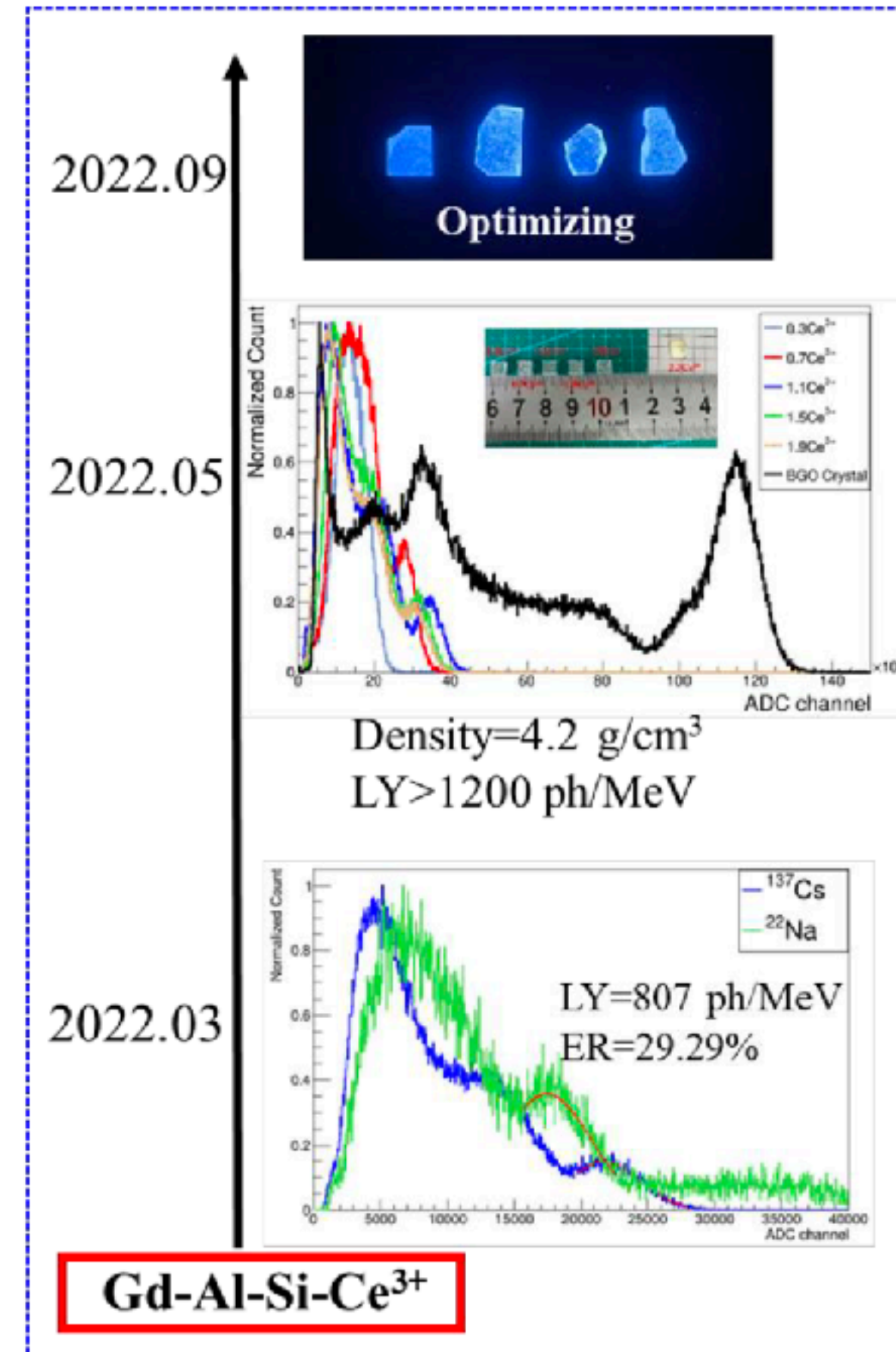
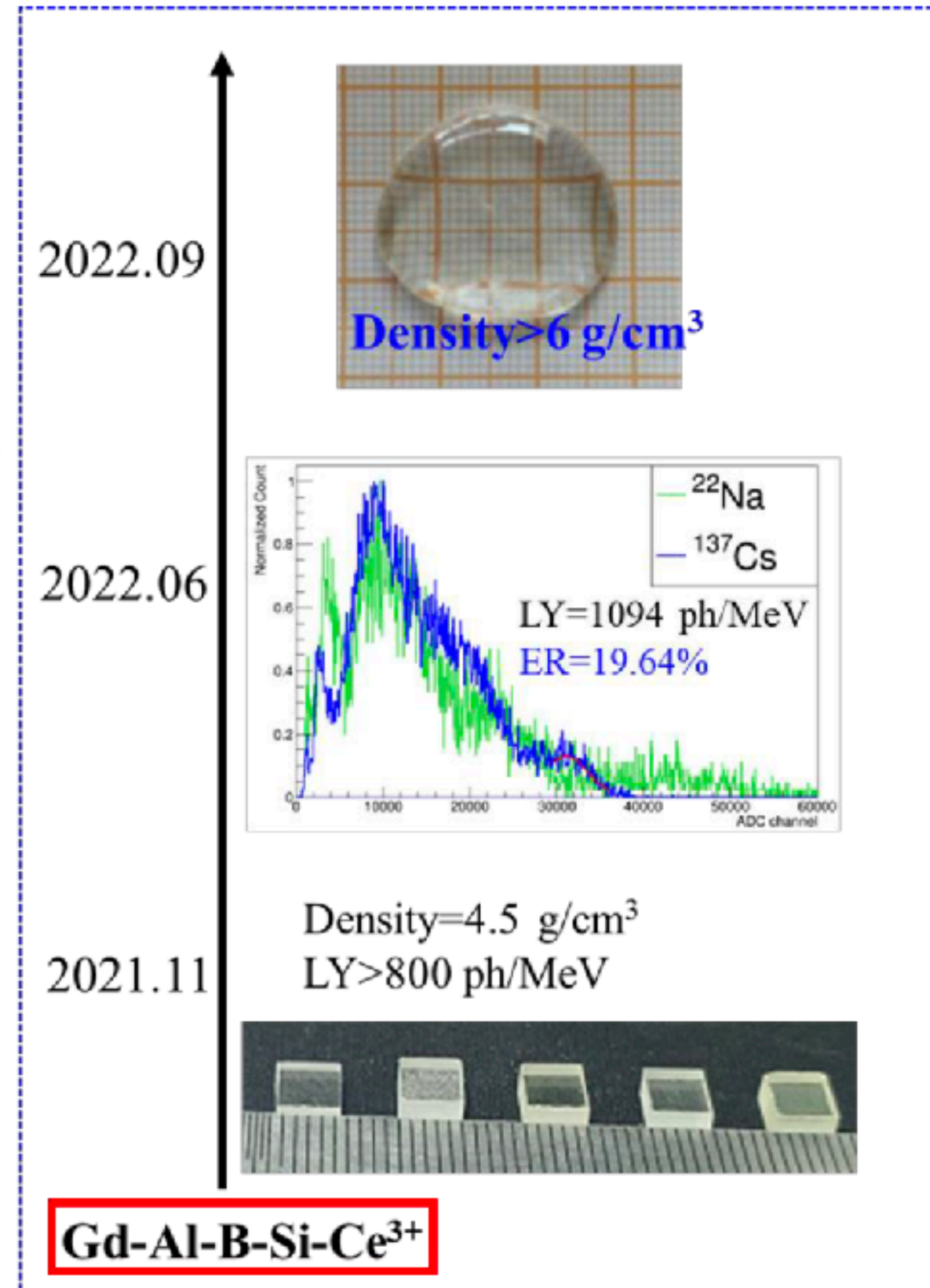


# CEPC R&D: New HCAL with Scintillating Glass Tiles

Different types of glass have been investigated



- 中国科学院高能物理研究所  
Institute of High Energy Physics  
Chinese Academy of Science
- Jinggangshan University  
井冈山大学
- Beijing Glass Research Institute  
北京玻璃研究院
- China Building Materials Academy  
中国建筑材料研究院
- China Jiliang University  
中国计量大学
- Harbin Engineering University  
哈尔滨工程大学
- Harbin Institute of Technology  
哈尔滨工业大学
- Sichuan University  
四川大学

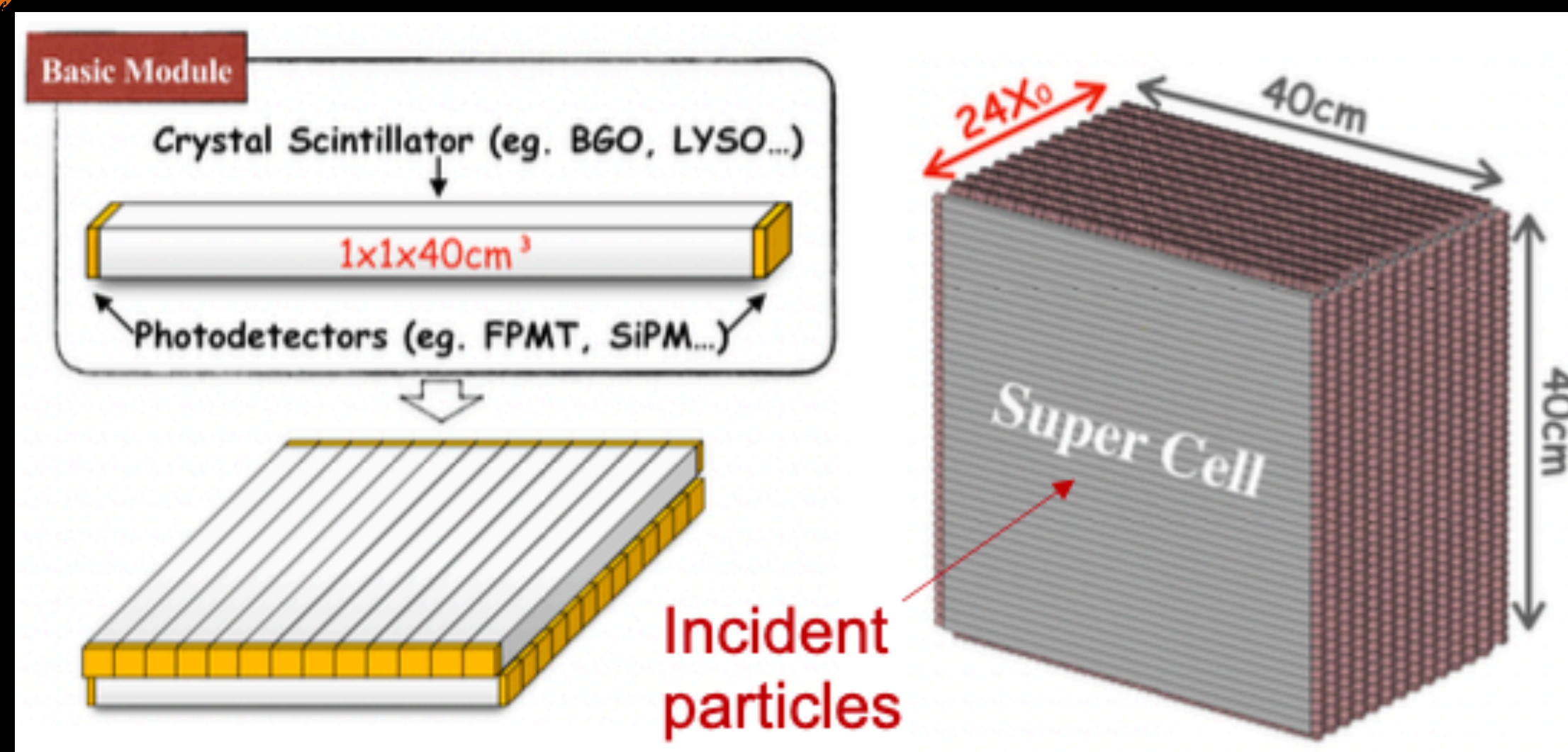


Glass scintillator of high density and light yield:  
 5.2 g/cm<sup>3</sup> & 800 ph/MeV—Gd-B-Si-Ce<sup>3+</sup> glass  
 5.9 g/cm<sup>3</sup> & 550 ph/MeV—Gd-Ga-B-Ce<sup>3+</sup> glass



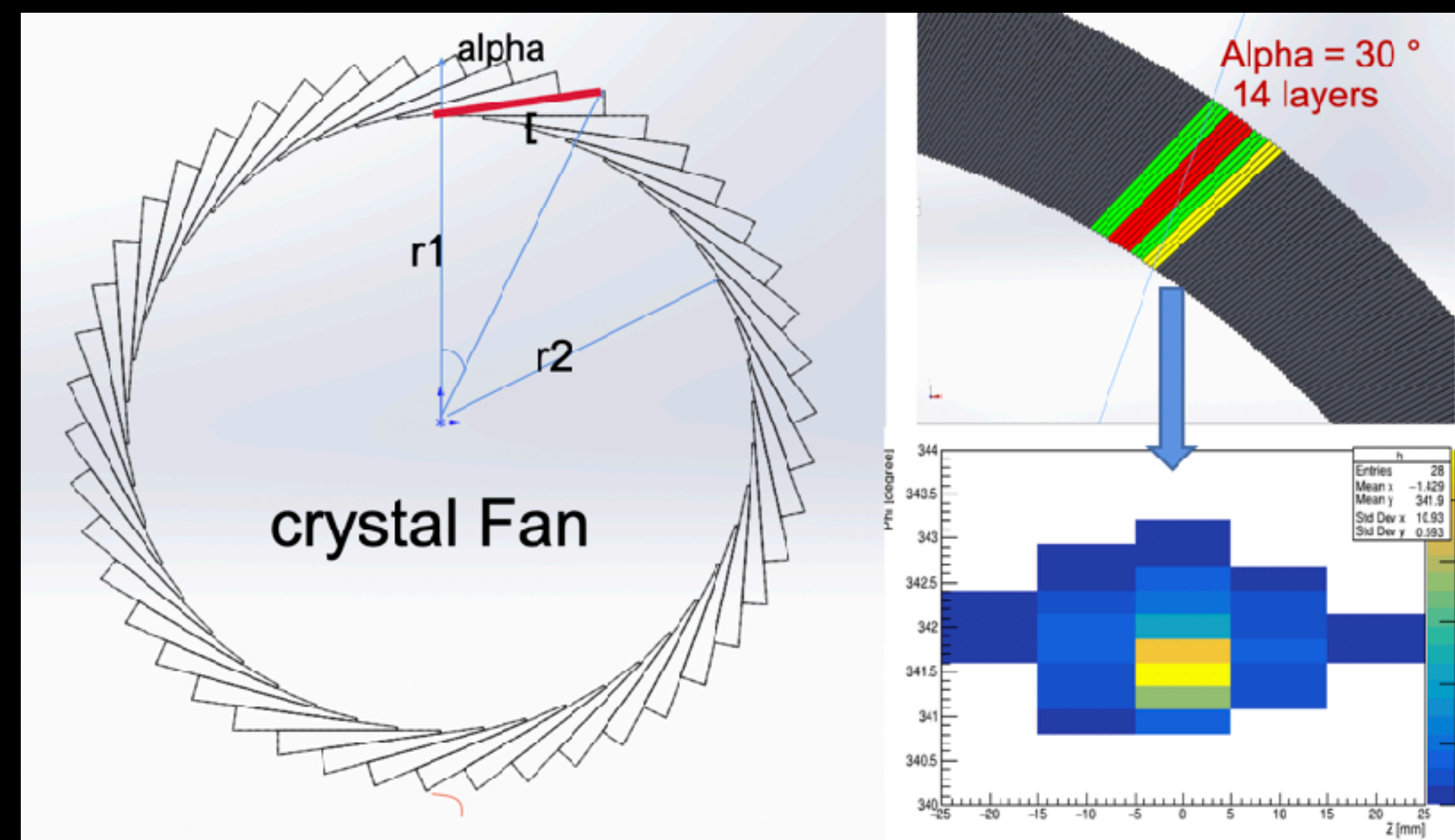
# CEPC R&D: High Granularity Crystal ECAL

## New segmented ECAL designs based on crystals



- Long bars:  $1 \times 40 \text{ cm}$
- Super-cell:  $40 \times 40 \text{ cm}$  cube
- Double-sided readout
  - Timing at both sides, gives position along bar
- Key concerns:
  - Ambiguities in separation of close showers
  - Impact on Jet Energy Resolution (JER)

## Crystal Fan Design



- Fine segmentation in  $Z$ ,  $\phi$  and  $r$
- Resolutions (mm) :  $Z \sim 1$  ;  $\phi \sim 2$  ;  $r \sim 8$
- Reduced readout electronics channels

Dual Readout Crystal Calorimeter also being consider by USA and Italian colleagues



# CEPC R&D: High Granularity Crystal ECAL

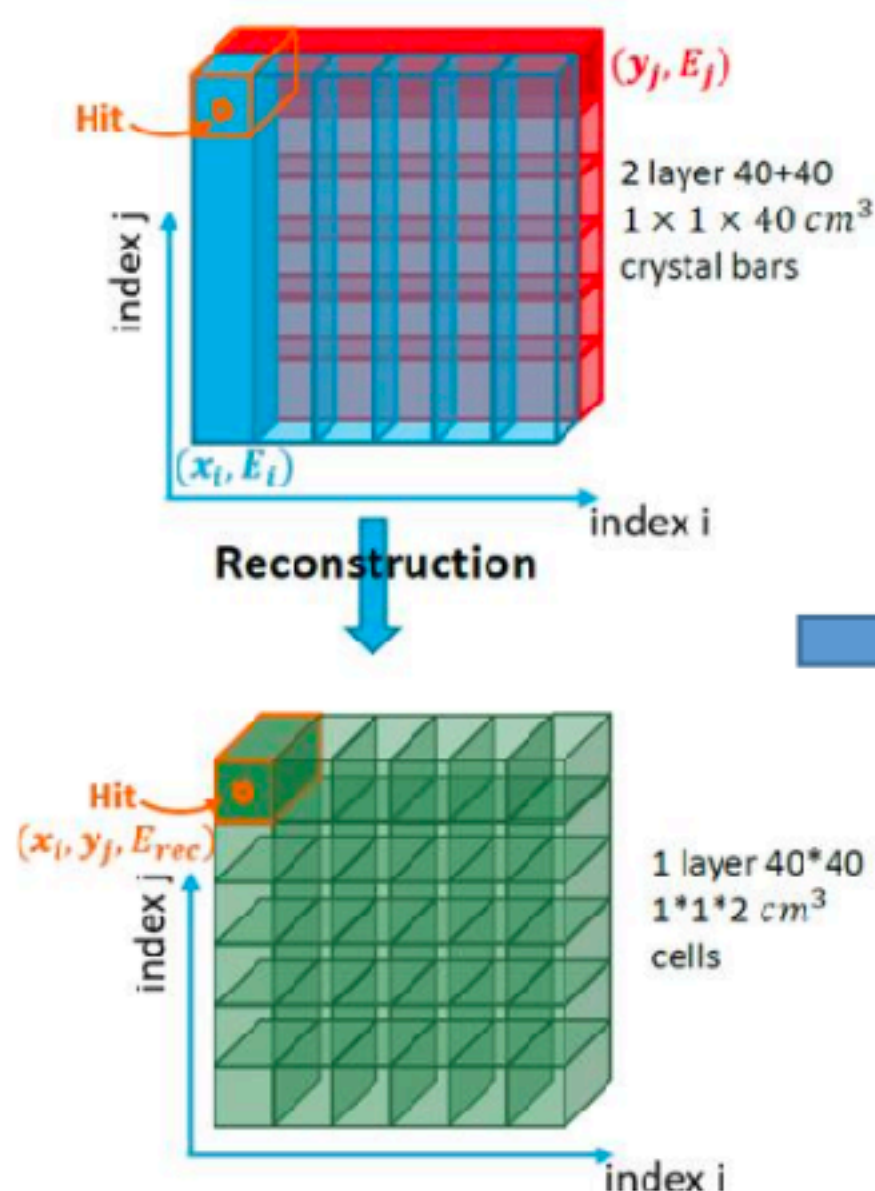
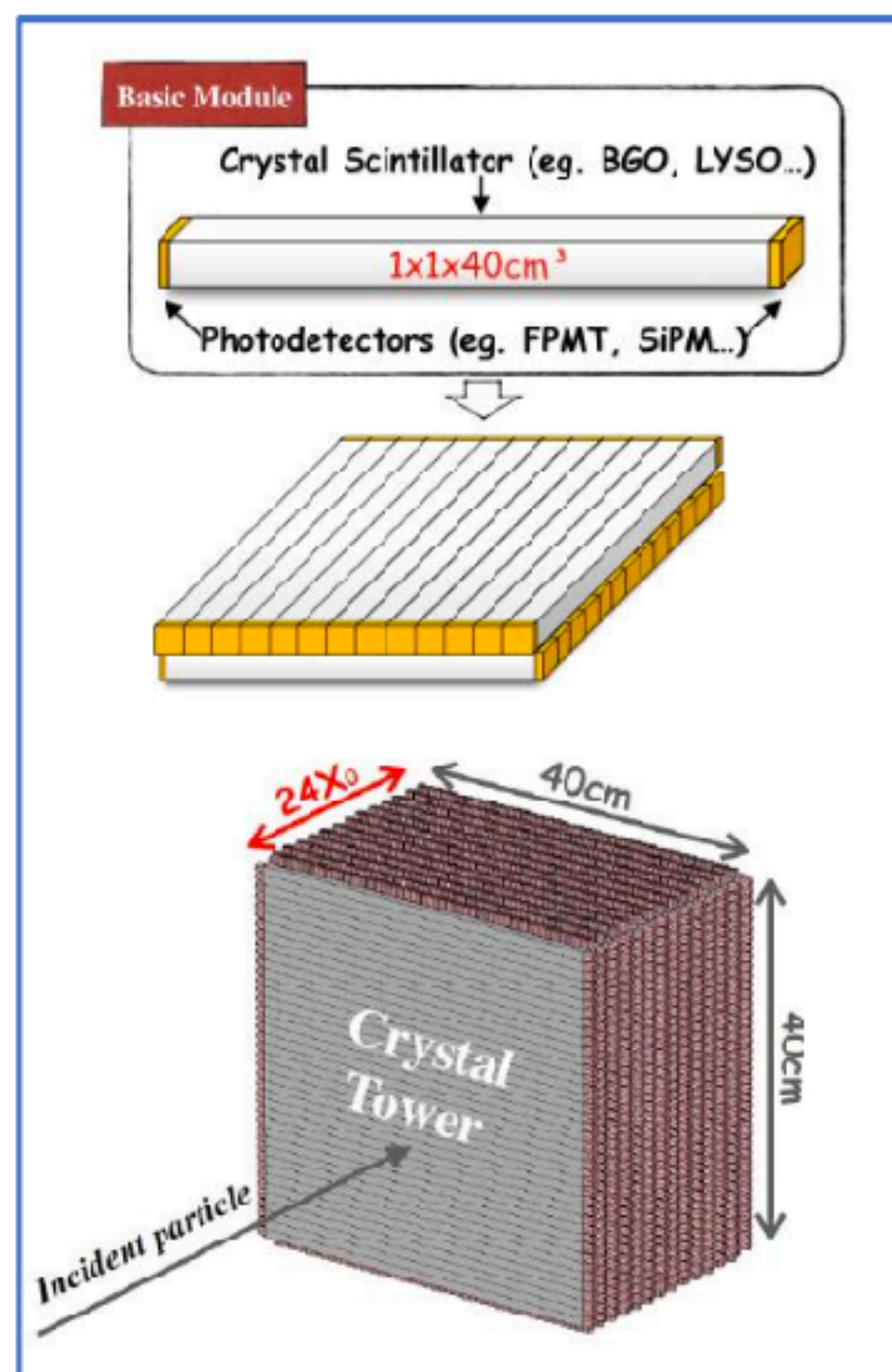
Hardware design



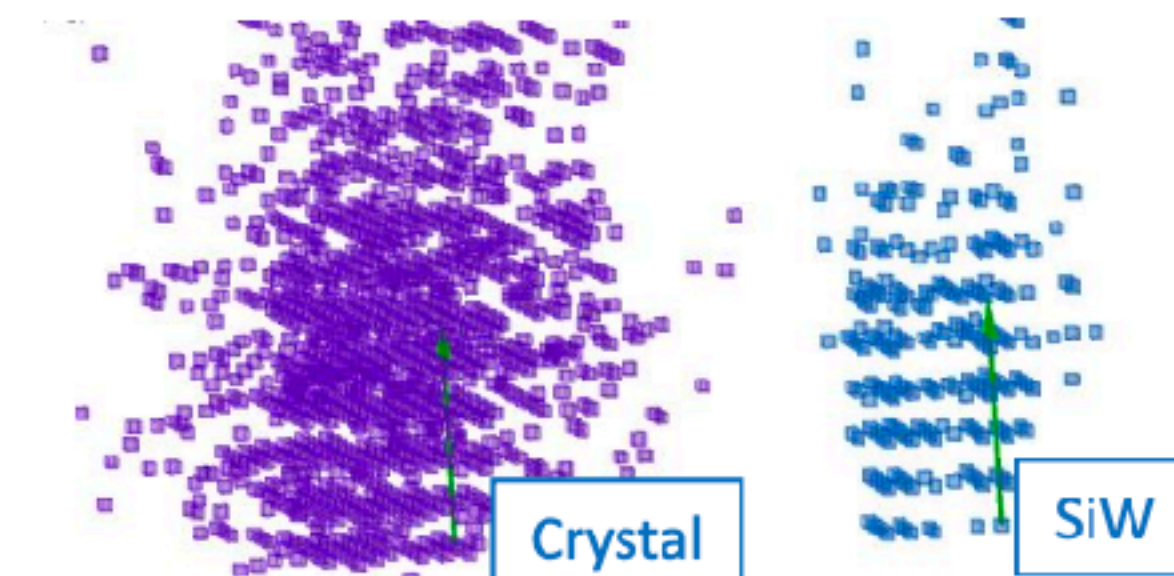
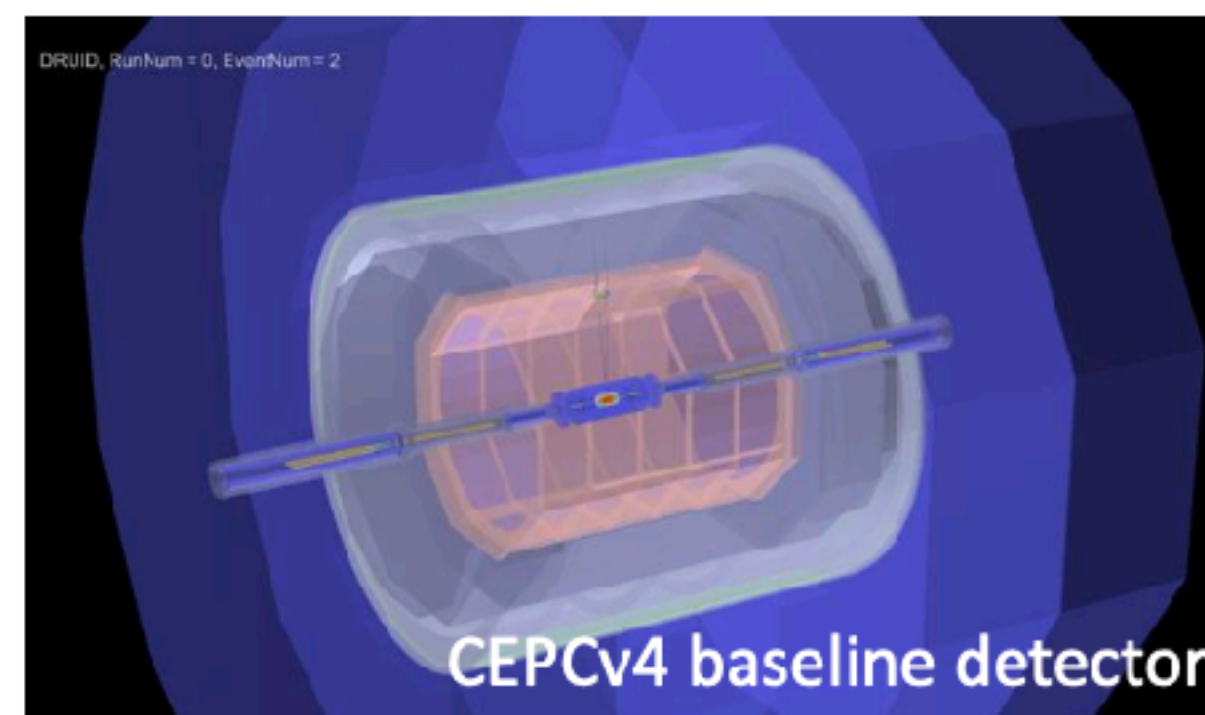
Simulation and validation



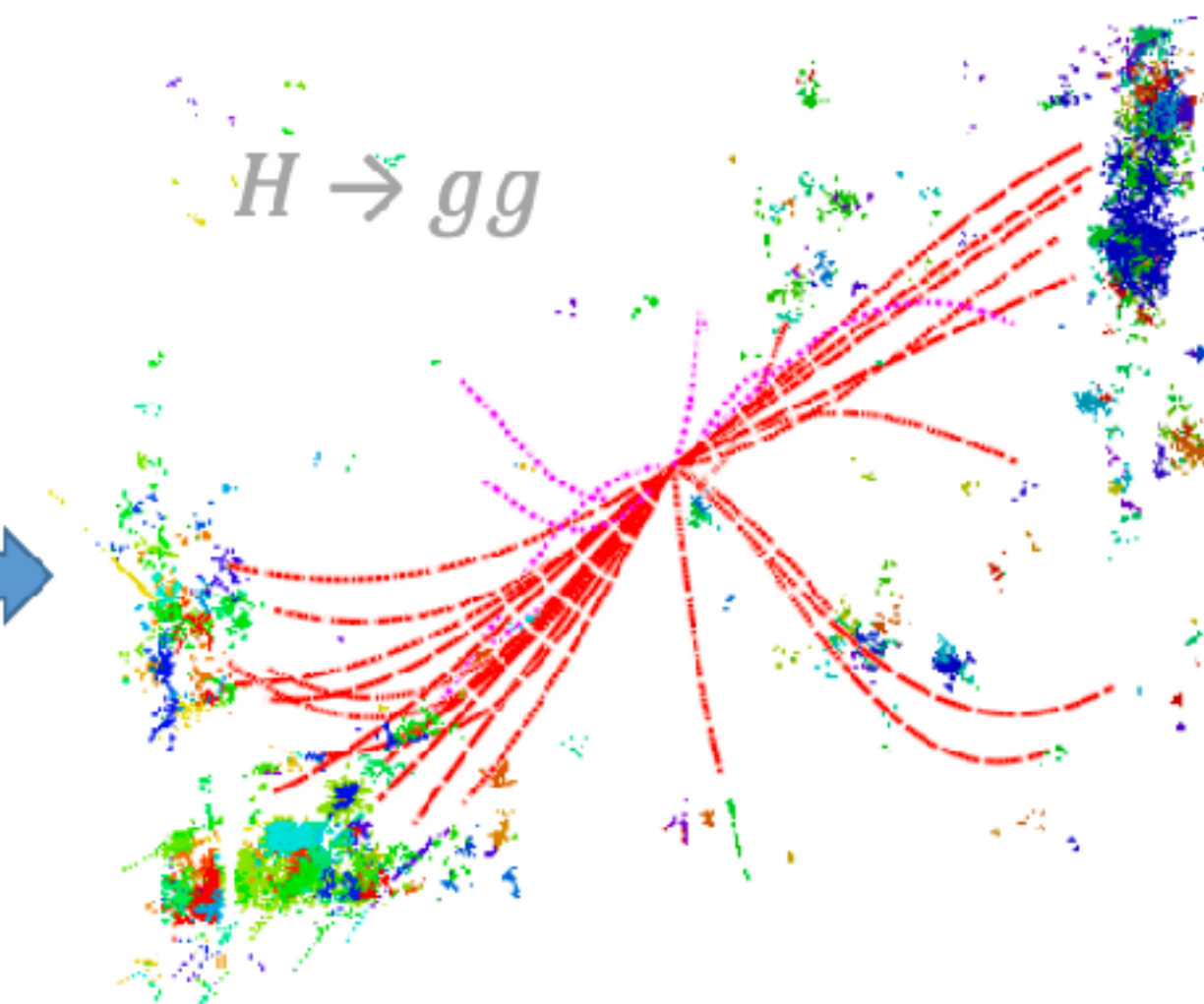
Performance evaluation



Crossed long bar design:  
1×1×2 cm<sup>3</sup> granularity  
after reconstruction



Shower profile of 5 GeV photons:  
significant increase of #hit due to a larger  
Molière radius: 2.26 cm (BGO) vs 0.93 (W)



Performance study with multiple  
jets events of Higgs decay

Hardware development:  
crossed long crystal bars

- New reconstruction software for long bars
- Optimizations of the Arbor-PFA for crystal ECAL

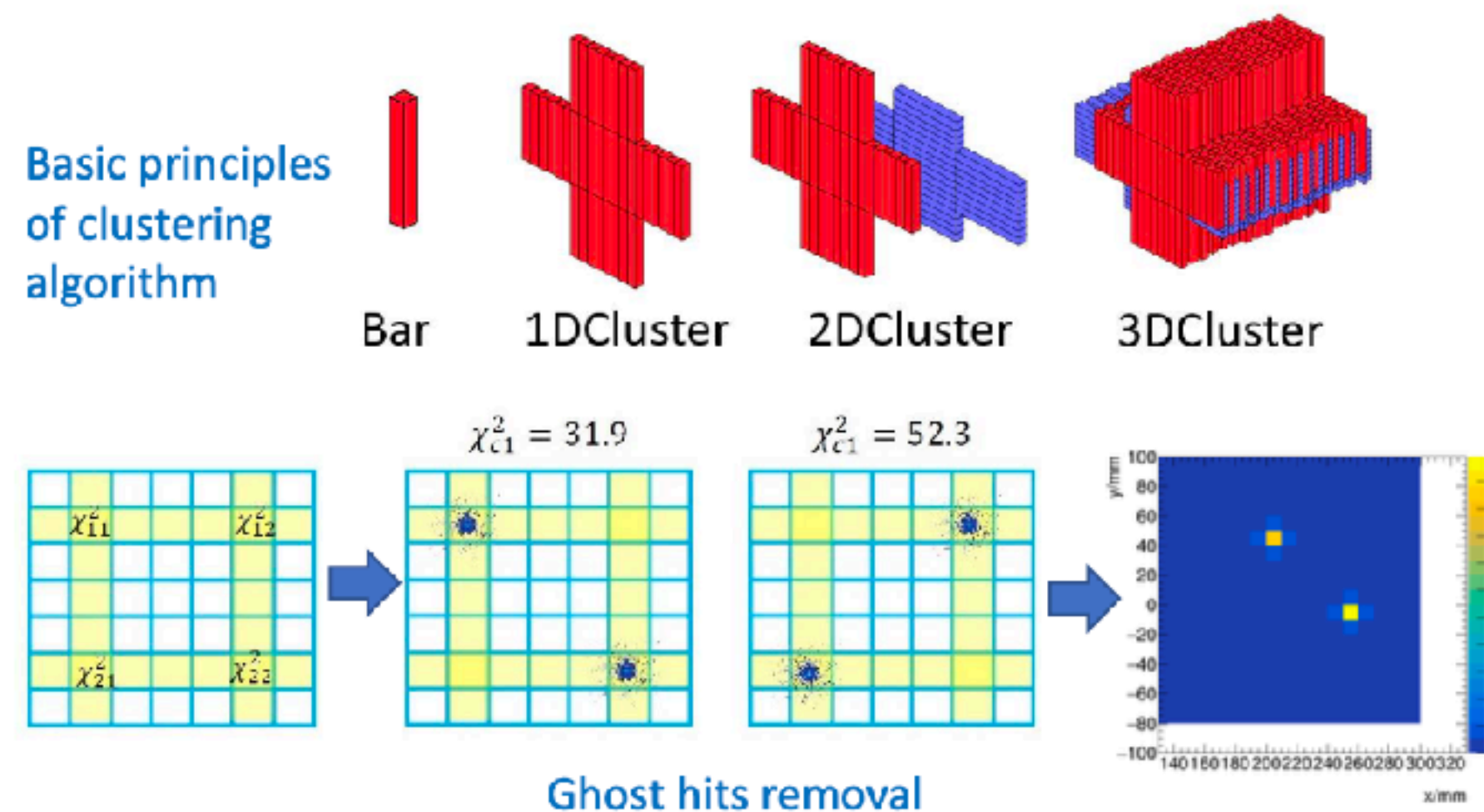
Physics performance evaluation  
with Higgs benchmarks

Goal: Intrinsic energy resolution:  $\sim 3\%/\sqrt{E}$   $\sim 1\%$



# CEPC R&D: High Granularity Crystal ECAL

## Reconstruction algorithms

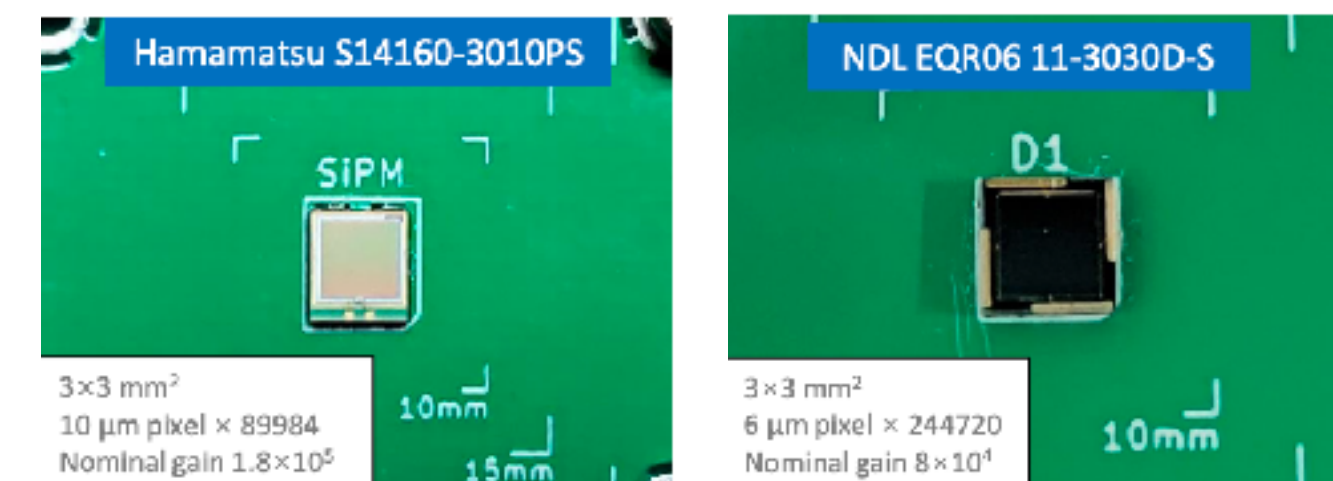


## Study of crystal-SiPM units

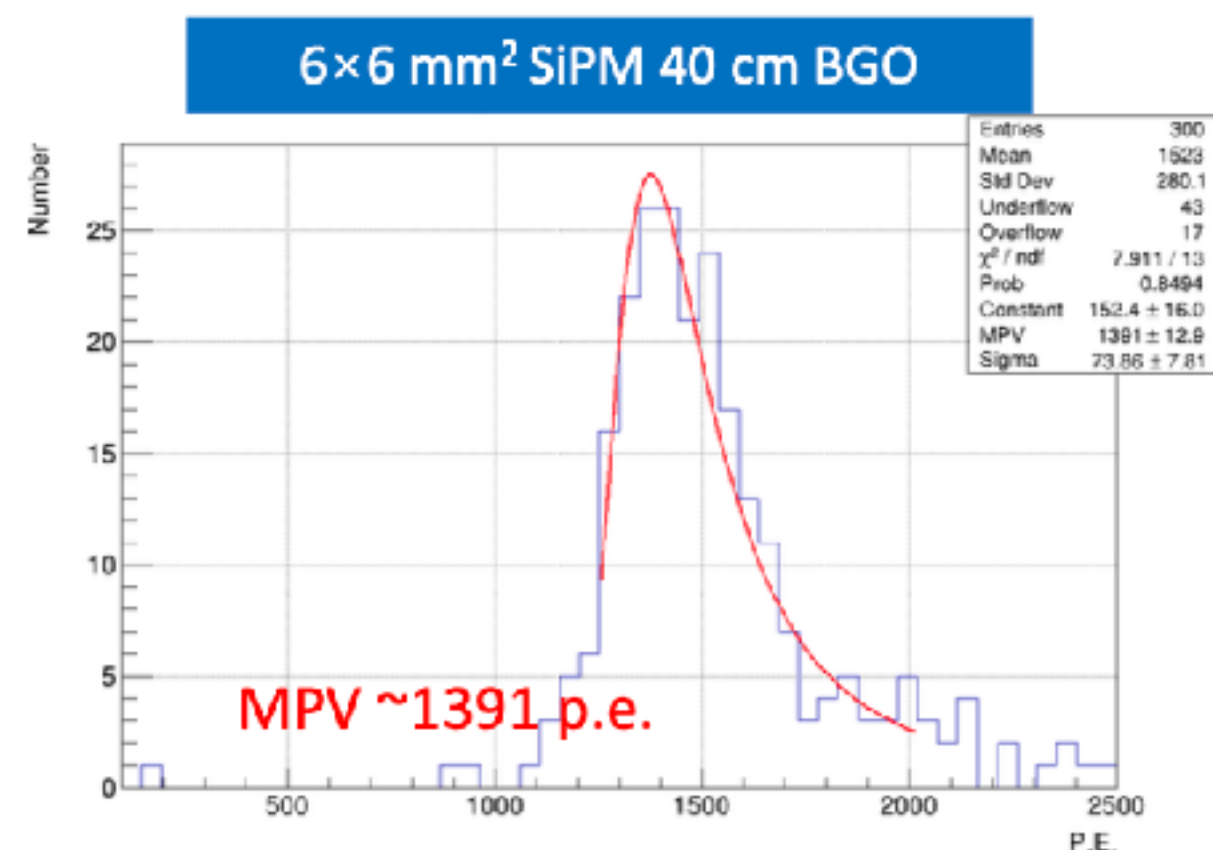
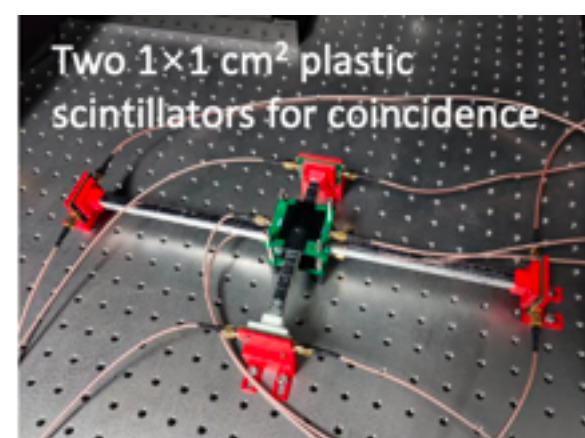
BGO crystals



Large dynamics SiPMs

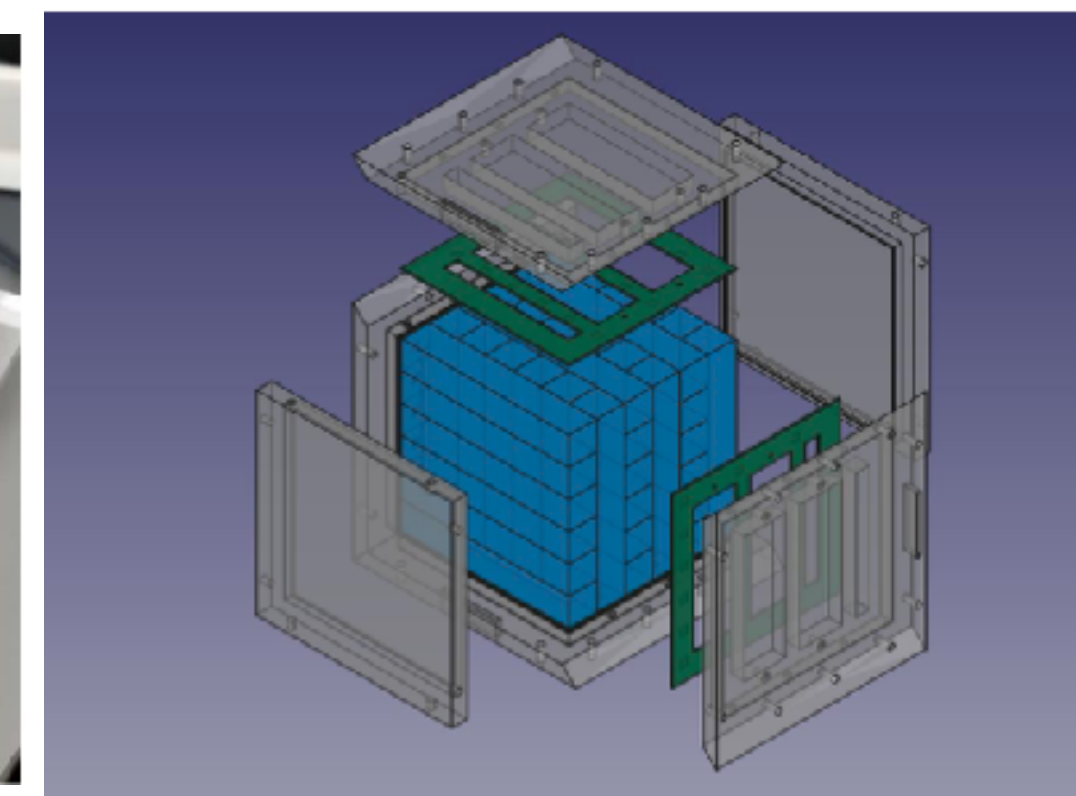


## Cosmic ray test



good enough light yield

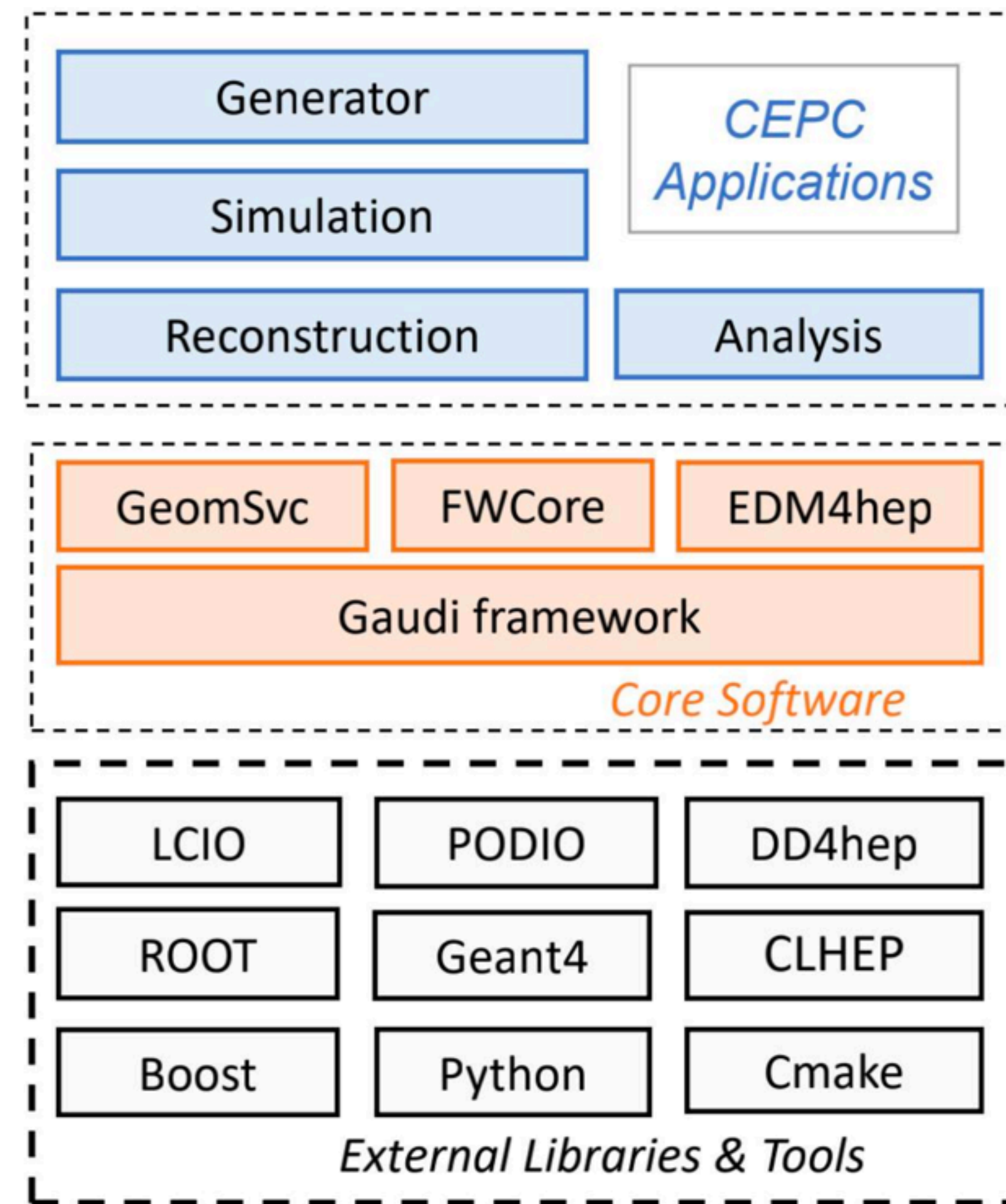
## Mechanical structure





## Key4hep is the foundation of CEPC software

- ❖ Based on Key4HEP
- ❖ Reuse and extend existing components
  - Gaudi, EDM4hep, DD4hep, ...
- ❖ Implement the specific components for CEPC
  - Geometry, generator, simulation and reconstruction algorithms, etc.
- ❖ Provide ready-to-work environment to algorithm developers and physicists
  - Porting algorithms from iLCSoft to CEPCSW
  - Integrate/develop more algorithms and features

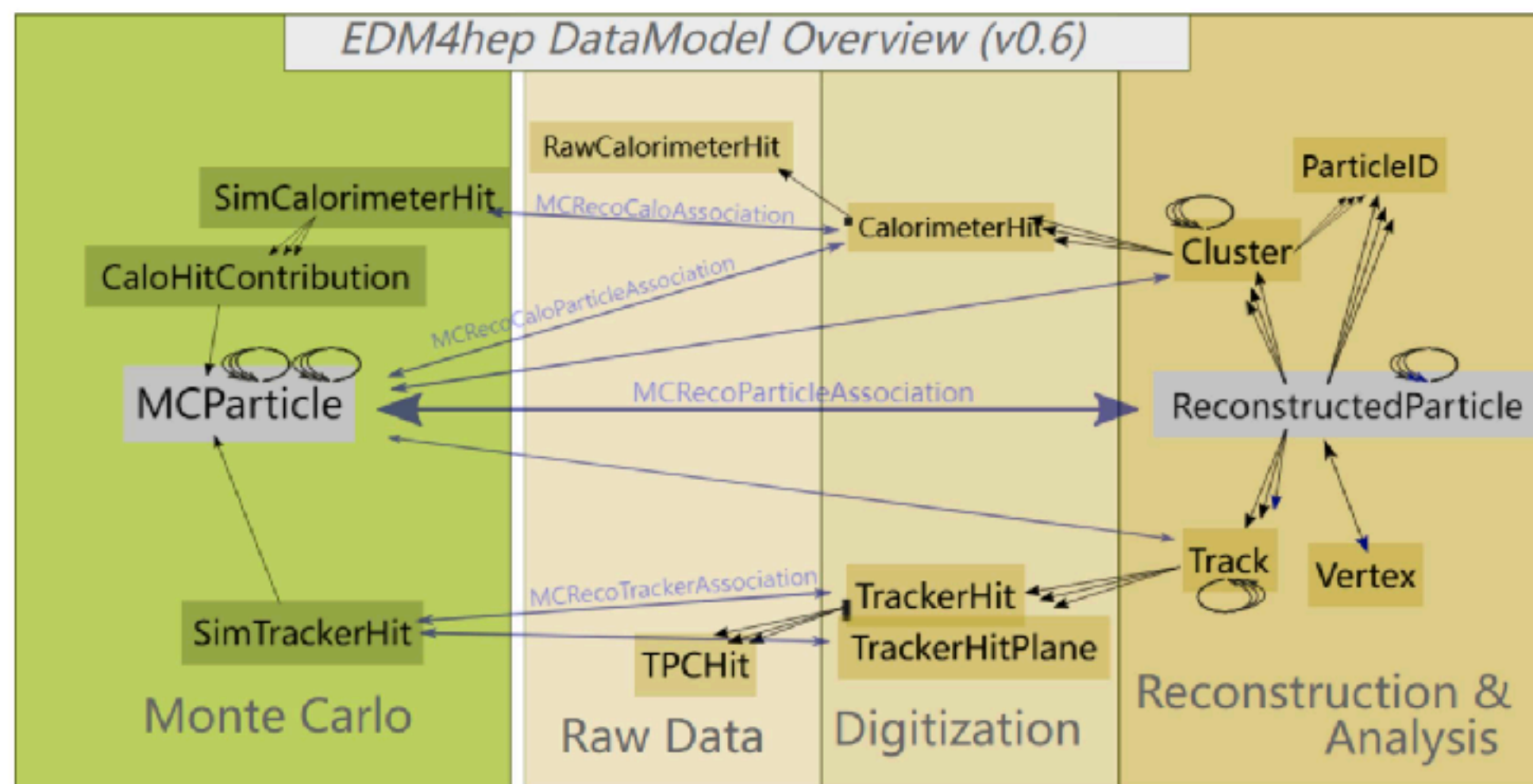


<https://github.com/cepc/CEPCSW>

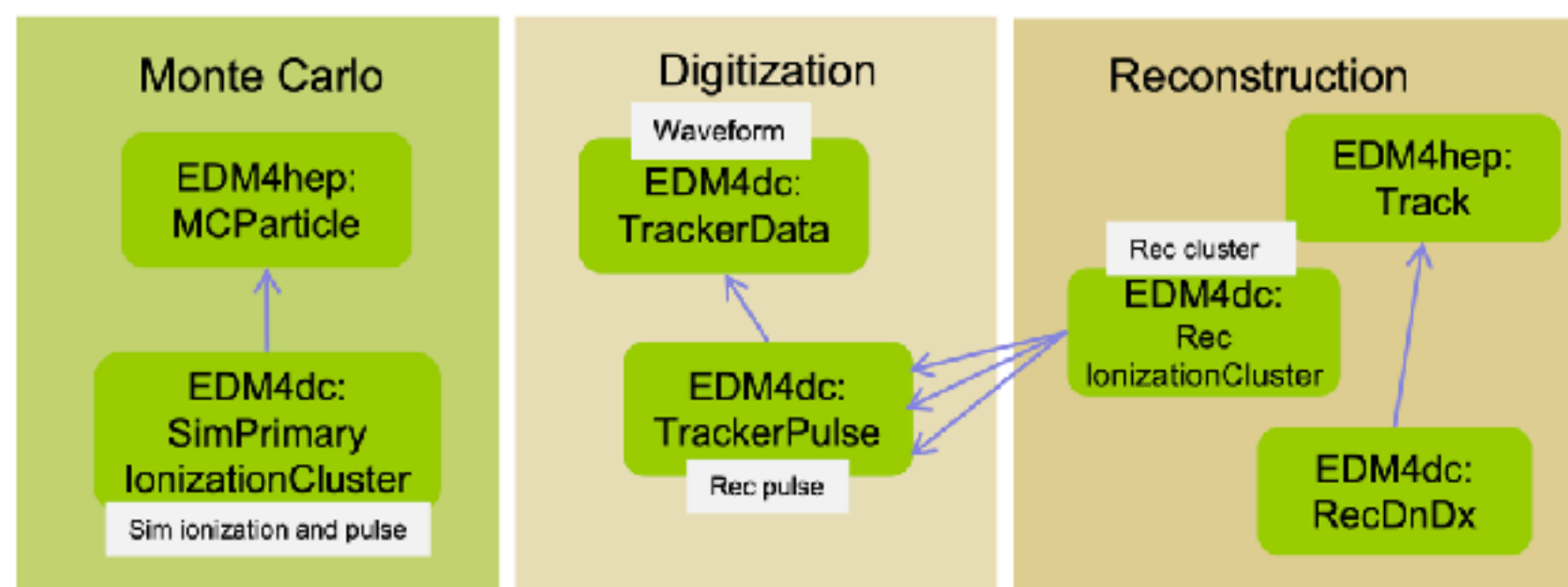


## Common Event Data Model: EDM4hep

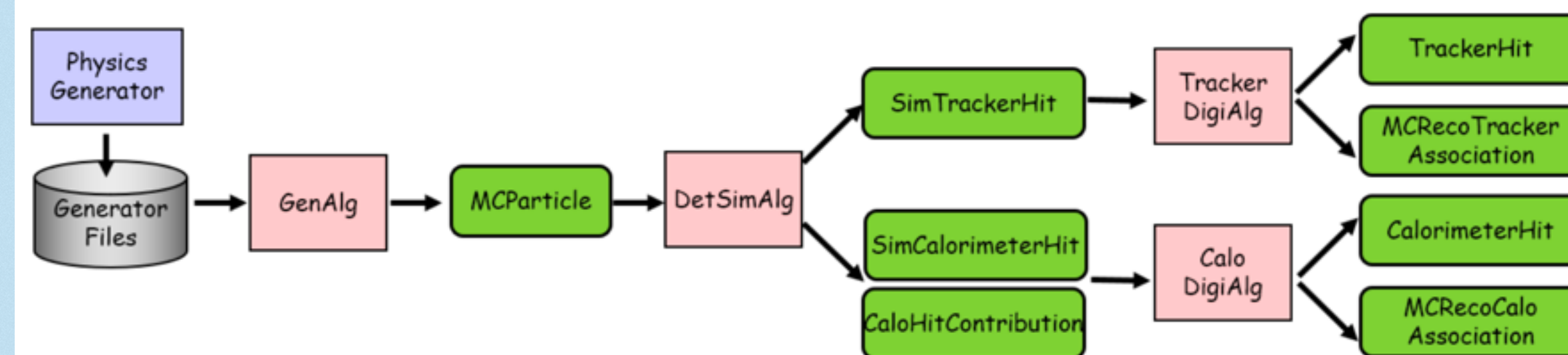
CEPC uses EDM4hep, the common EDM that can be used by all communities in the Key4hep project: ILC, CLIC, FCC-ee & FCC-hh



### Extensions to EDM4Hep for cluster counting



### CEPC simulation using EDM4hep



### Detector description using DD4hep

### Reconstruction work done for:

- Silicon tracking
- TPC software
- Drift chamber tracking and cluster counting
- Calorimeter



# International Collaboration



# Snowmass — Letters of Intent

## 14 CEPC-Related Detector LoI submitted

<https://indico.ihep.ac.cn/event/12410/>


### Detector R&D

Conveners: Joao Guimaraes Costa, WANG Jianchun, Mr. Manqi Ruan (IHEP)

#### 15:00 **CEPC Detectors Overview LoI 1'**

*CEPC Detector Overview LOI*  
*SNOWMASS21-EF1\_EF4-IF9\_IF0-260.pdf*

Speakers: Joao Guimaraes Costa, Mr. Manqi Ruan (IHEP), WANG Jianchun

Material: [Paper](#)  [Slides](#) 

#### 15:02 **IDEA Concept 1'**

Speaker: Franco Bedeschi (INFN-Pisa)

Material: [Paper](#) 

#### 15:03 **Dual Readout Calorimeter 1'**

Speaker: Roberto Ferrari (INFN)

Material: [Paper](#) 

#### 15:04 **Drift Chamber 1'**

Speaker: Franco Grancagnolo

Material: [Paper](#) 

#### 15:06 **mu-RWELL (muons, preshower) 1'**

Speaker: Paolo Giacomelli (INFN-Bo)

Material: [Paper](#) 

#### 15:08 **Time Detector LoI 1'**

Speaker: Prof. Zhijun Liang (IHEP)

Material: [Slides](#) 

#### 15:09 **Key4hep 1'**

Speakers: Dr. Weidong Li (高能所), Dr. Tao LIN (高能所), Prof. Xingtao Huang (Shandong University), Wenxing Fang (Belhang University)

Material: [Slides](#) 


#### 15:10 **PFA Calorimeter 1'**

Speakers: Haijun Yang (Shanghai Jiao Tong University), Dr. Jianbei Liu (University of Science and Technology of China), Dr. Yong Liu (Institute of High Energy Physics)

Material: [Slides](#) 

#### 15:11 **High Granularity Crystal Calorimeter 1'**

Speaker: Dr. Yong Liu (Institute of High Energy Physics)

Material: [Paper](#)  [Slides](#) 

#### 15:12 **Muon Scintillator Detector 1'**

Speaker: Dr. Xiaolong Wang (Institute of Modern Physics, Fudan University)

Material: [document](#) 

#### 15:13 **Vertex LoI 1'**

Speaker: Prof. Zhijun Liang (IHEP)

Material: [Slides](#) 

#### 15:15 **MDI LoI 1'**

Speaker: Dr. Hongbo ZHU (IHEP)

Material: [Slides](#) 

#### 15:16 **TPC LoI 1'**

Speaker: Dr. Huirong Qi (Institute of High Energy Physics, CAS)

Material: [Slides](#) 

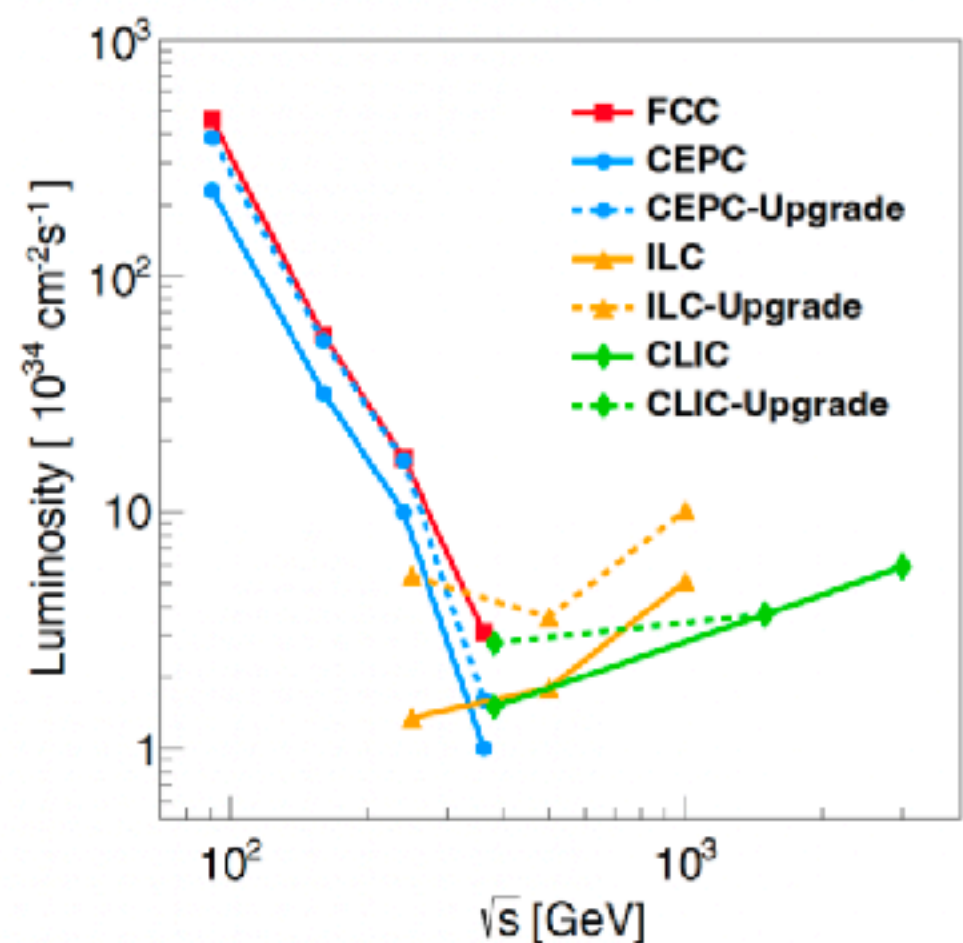
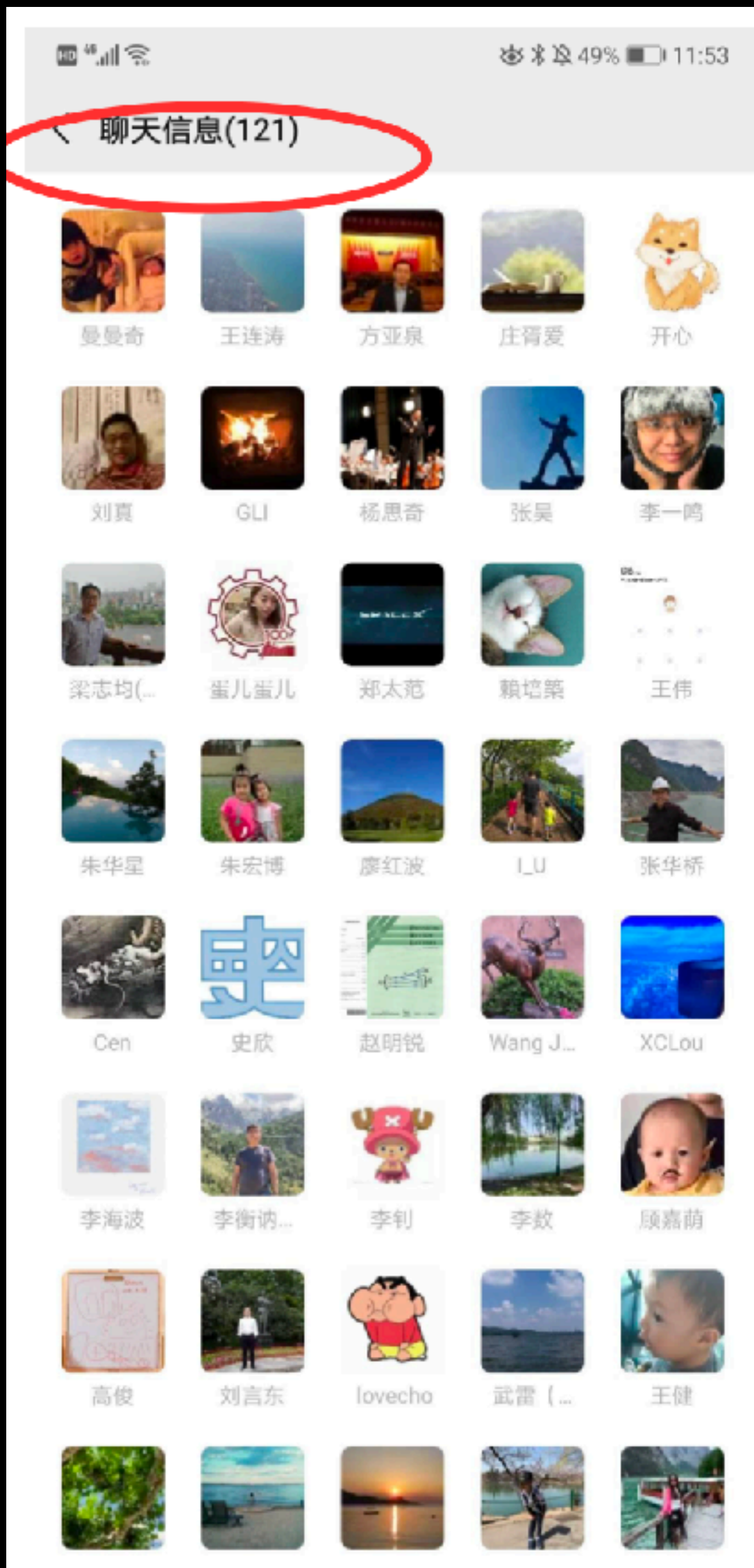
#### 15:17 **Solenoid R&D LoI 1'**

Speaker: Dr. Feipeng NING (IHEP)

Material: [Slides](#) 



# CEPC Physics at Snowmass



## CEPC input to the Snowmass 2021 - Physics cases

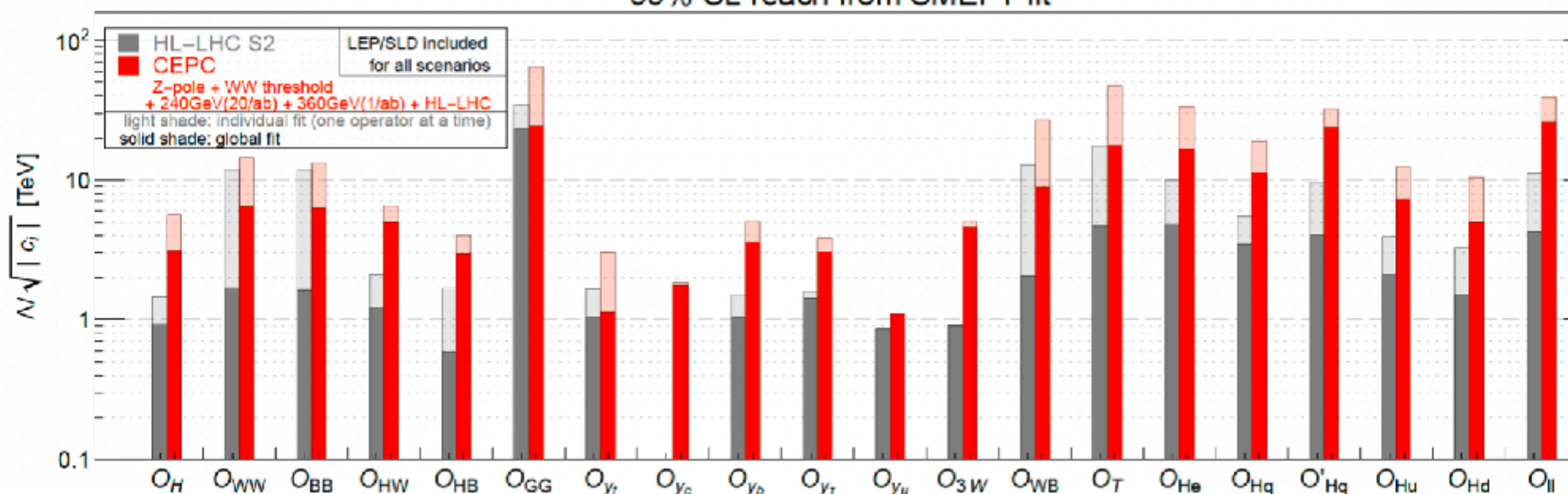
CEPC Physics Study Group

(Dated: March 28, 2022)

### ABSTRACT

The Circular Electron Positron Collider (CEPC) is a large-scale future collider facility that can serve as a factory of the Higgs boson, the W boson and the Z boson, and is upgradable to be also a top-quark factory. This document provides the latest nominal operation scenario and particle yields, and report briefly the physics potential studies. This submission is for the consideration by the Snowmass process.

### 95% CL reach from SMEFT fit



- Covers Higgs, EW, Flavor, NP, etc.
- Updated to the latest(TDR) beam parameters,
- Strong collaboration with theory/pheno community + clear requirement for the detector design



## Essential International Partners:

- **International partnership in the detector prototypes**
  - PFA calorimeter: with CALICE Collaboration
  - TPC: with LC-TPC Collaboration
  - Drift chamber: with Italian colleague from IDEA
  - Silicon tracker: with UK/Germany/Italian colleague
  - Silicon vertex: with French/Spanish colleague
  - Key4hep software development
- CERN and DESY for test beams among other



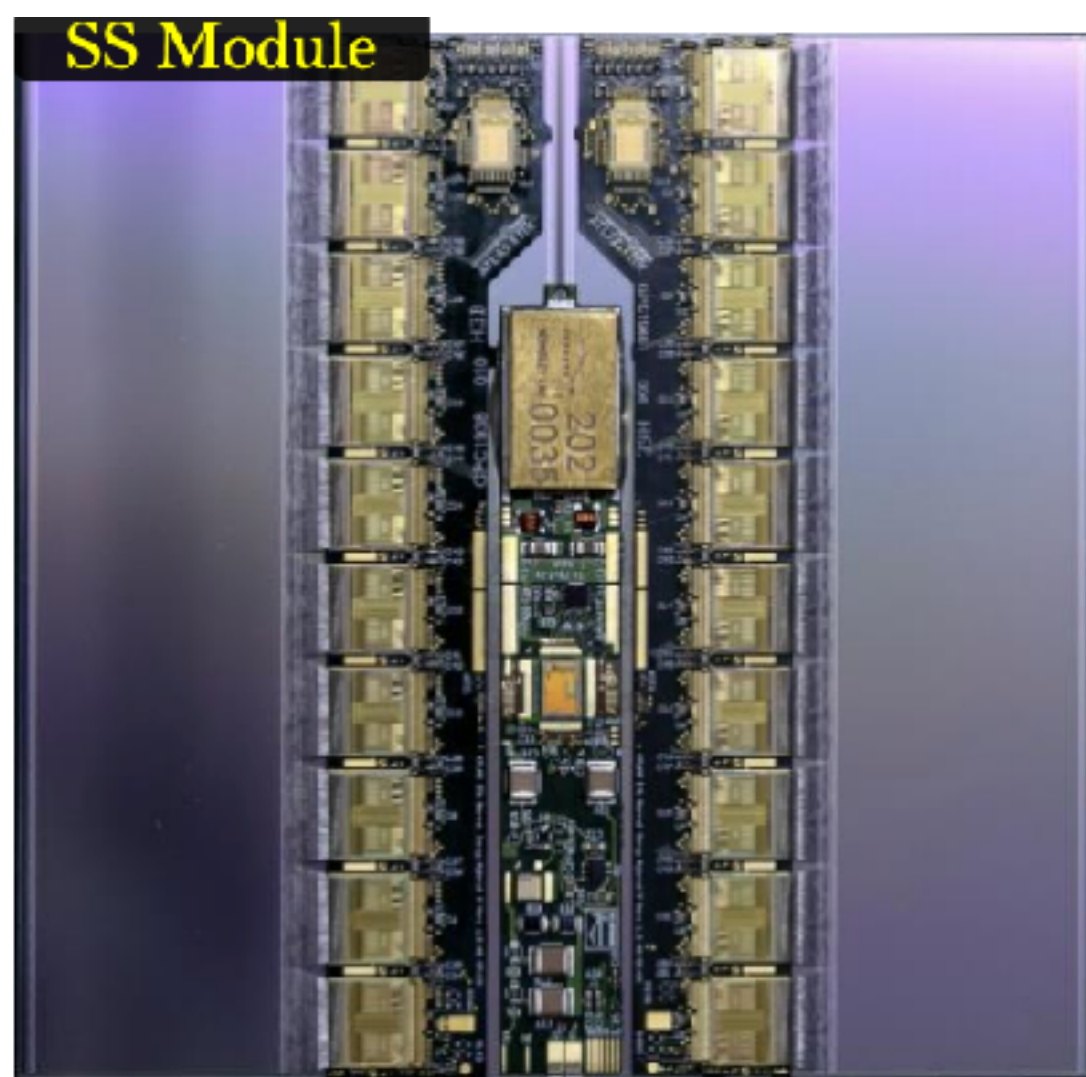
# CEPC Team participation in HL-LHC upgrade

## Example: Silicon-based detector upgrades

LHC upgrade Project	Contribution	IHEP member Leadership
ATLAS high granularity timing detector (HGTD)	~44% modules and ~34% sensors (~4000 modules, ~4000 sensors by Chinese foundry)	Project leader Coordinators in Sensors/ modules
LHCb UT tracker upgrade	System design, test and integration	Deputy project leader
ATLAS ITK strip detector upgrade	~10% modules in Barrel (1000 modules )	Coordinator in China/UK cluster
CMS HGcal	~ 20% modules (~100 m <sup>2</sup> area) silicon module	

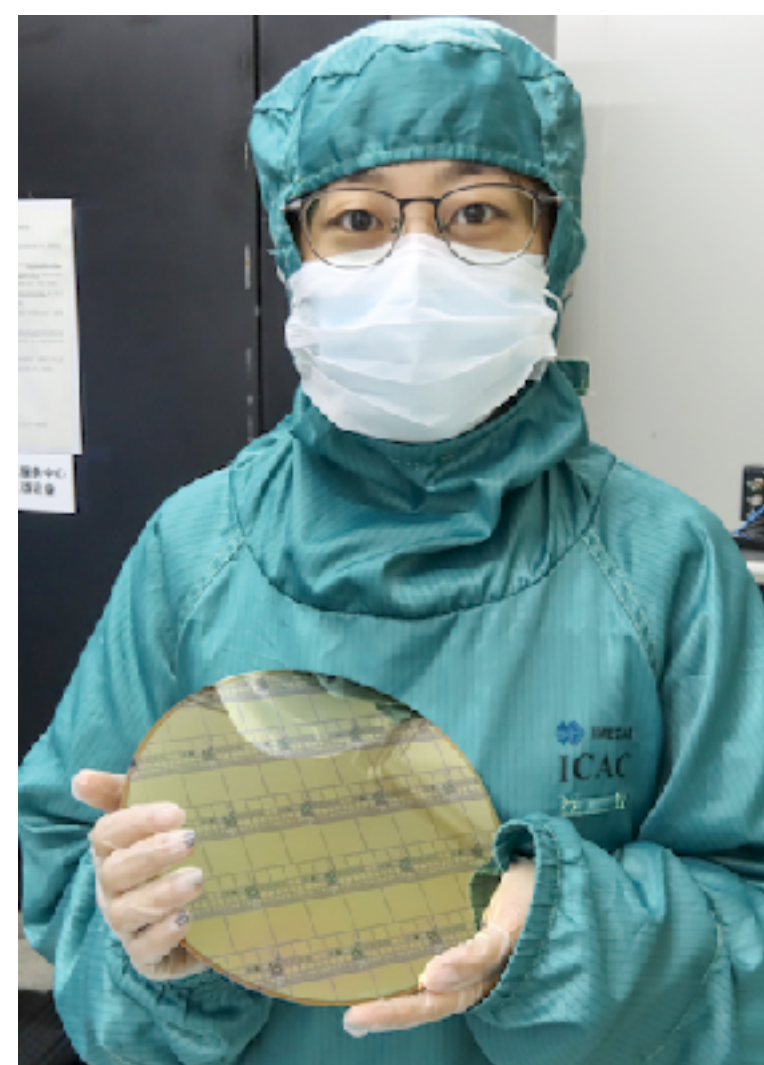
### ATLAS ITK strip upgrade

Module prototyping



### ATLAS HGTD

Sensor developed by IHEP



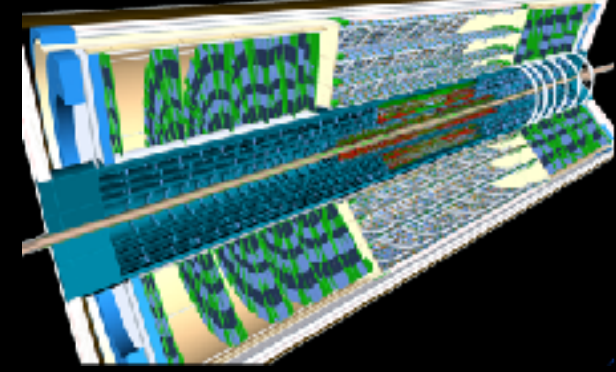
### CMS HGcal

module prototyping



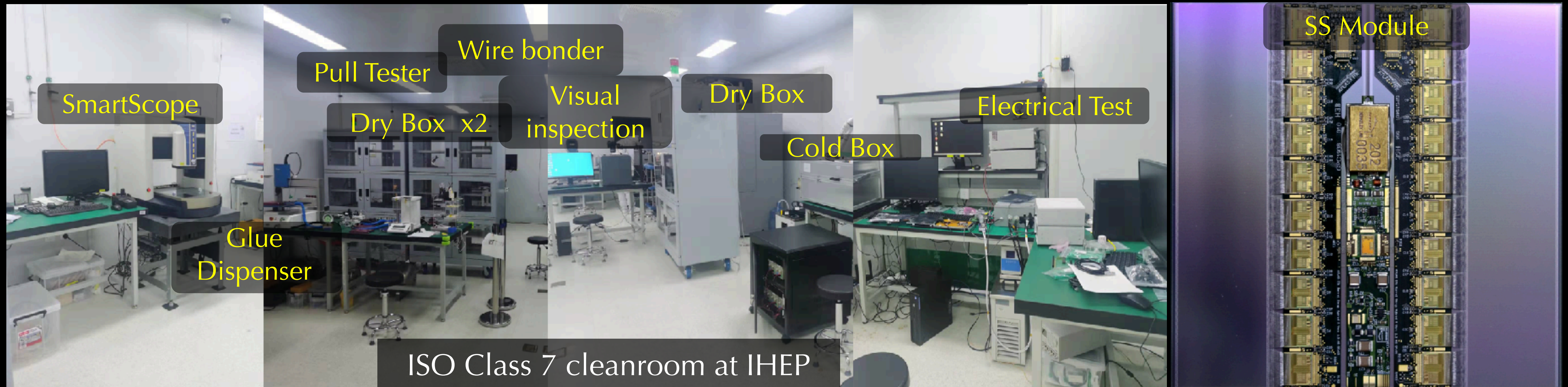


# ATLAS Silicon Tracker (ITk Strips)



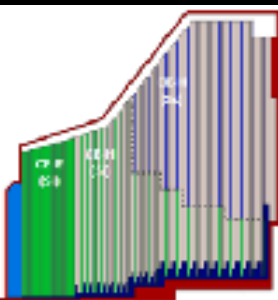
China (IHEP/THU) responsible for 10% barrel ATLAS ITk strip module production (>1000, 10 m<sup>2</sup>)

- Work done in collaboration with **Rutherford Labs, UK** — **China/UK cluster** responsible for 50% of barrel production — IHEP participating in the management team
  - Site has passed pre qualifications and a total of 15 pre-production modules have been produced
- Carried out irradiation study for readout ASICs and sensors
  - Possibly will use the proton beam at CSNS as irradiation site for quality assurance for ASICs and Sensors
- Contribute to the inner tracker system integration and test in the future
  - Two FTEs from IHEP based at RAL responsible for module production and stave loading



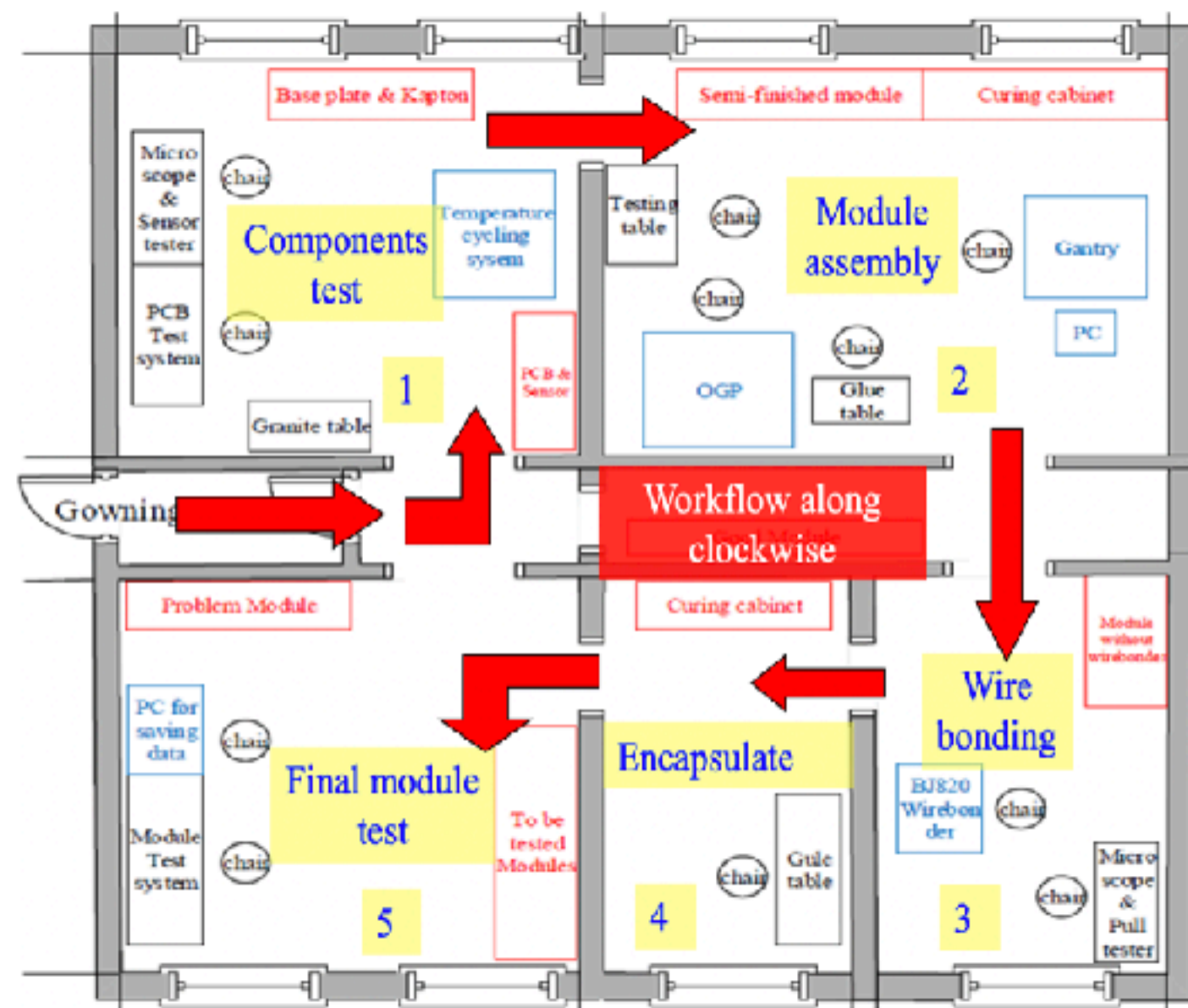


# CMS High Granularity Calorimeter at IHEP



- Hosting a HGCal silicon Module Assemble Center at IHEP
  - Plan prod.: ~5000 modules, >100 m<sup>2</sup> silicon (on average of 6 MACs)
- Cleanroom, equipment, assemble procedures settled

## Clean room



## HGCal Module Assembly

Components test

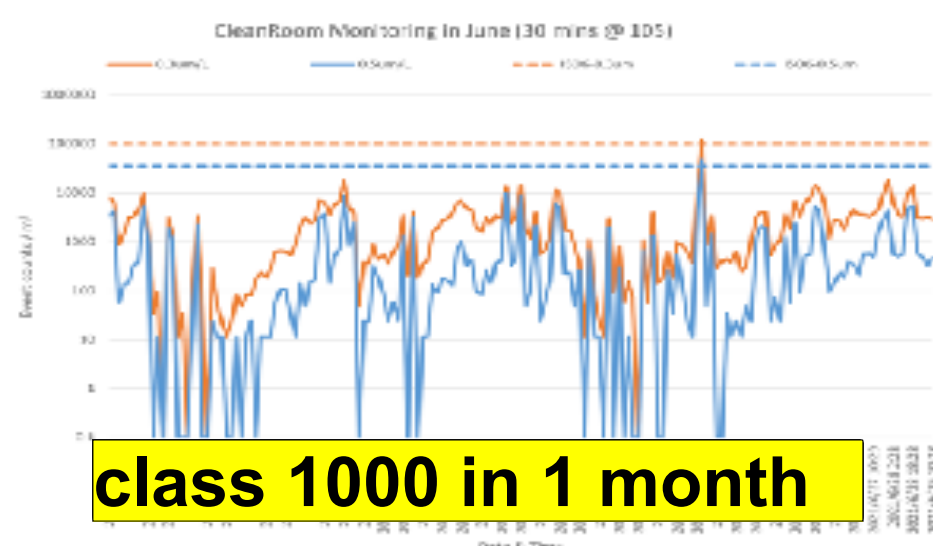
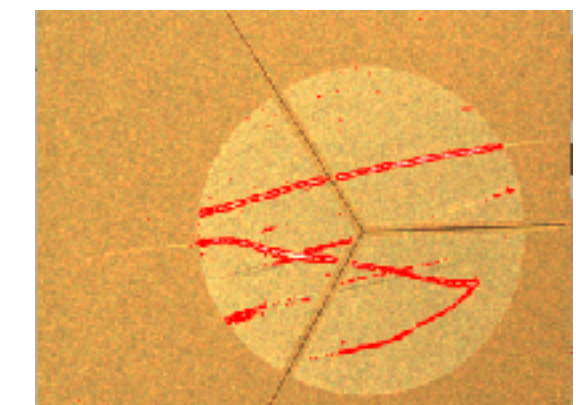
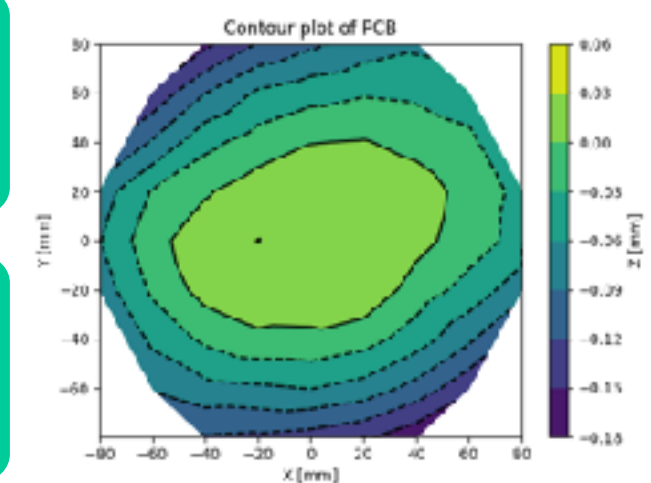
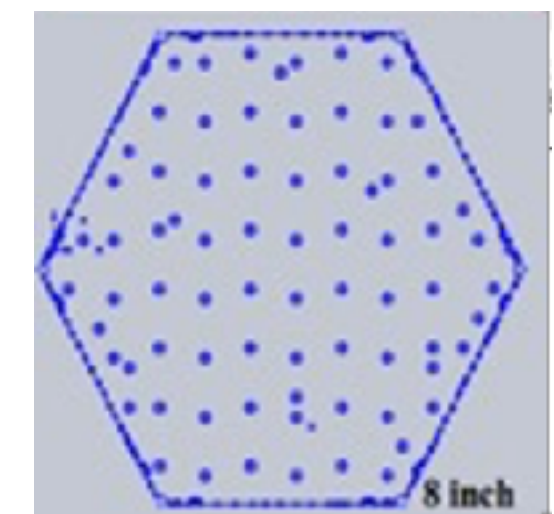
Assembly

Wire bonding

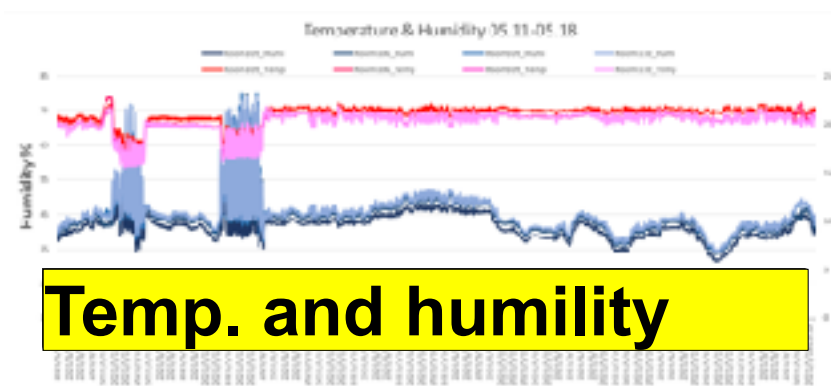
Encapsulation

Module testing

QA/QC



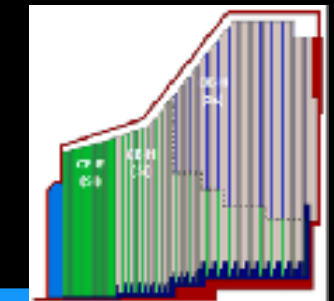
class 1000 in 1 month



Temp. and humidity



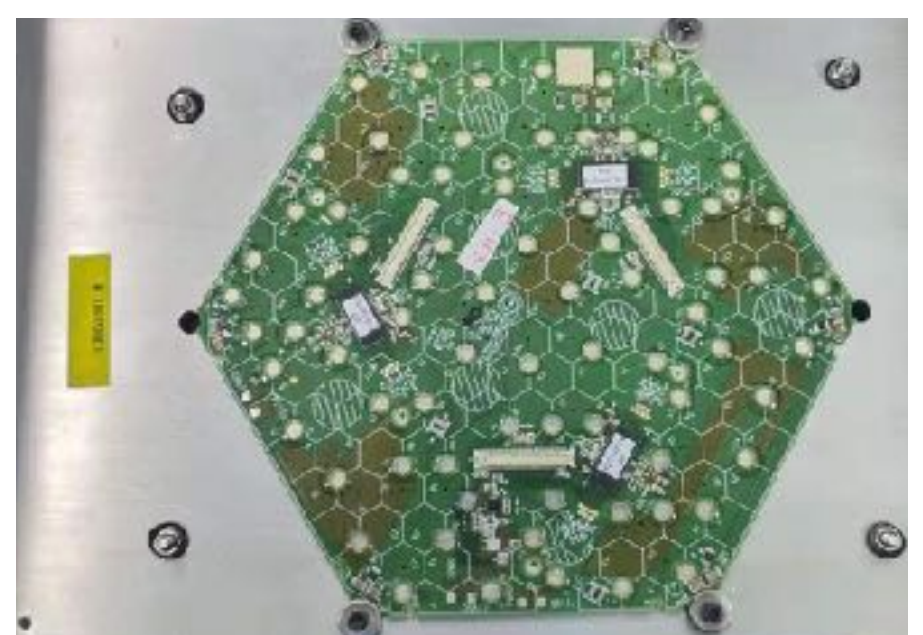
# CMS High Granularity Calorimeter at IHEP



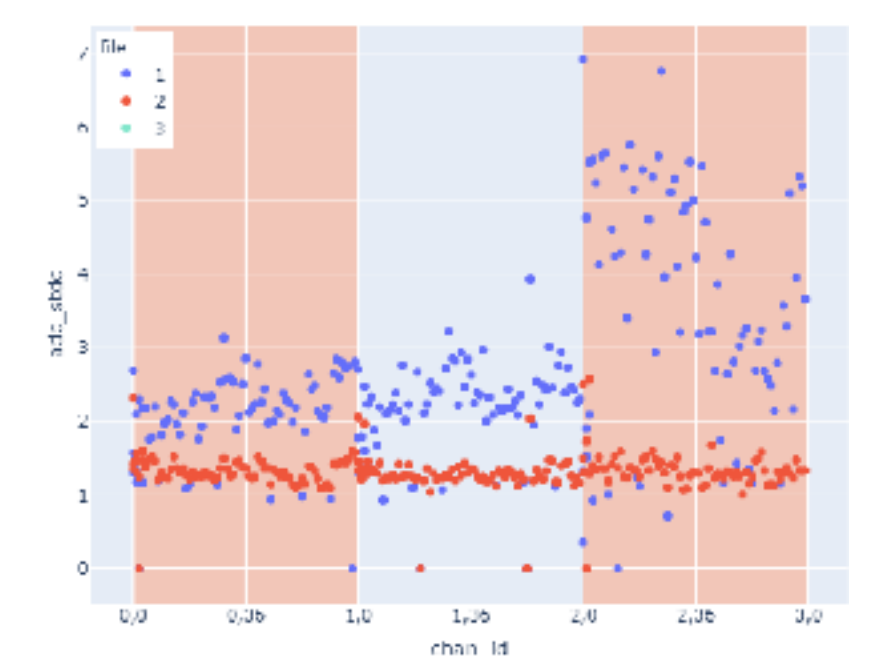
- Produced 7 modules (8 inch)
  - All have good noise level (pass lab tests)
  - 2 at CERN, tested using SPS beams
  - 4 at Fermilab for cassette tests
- Passed HGCal MAC Site qualification
  - Pre-production ~2023



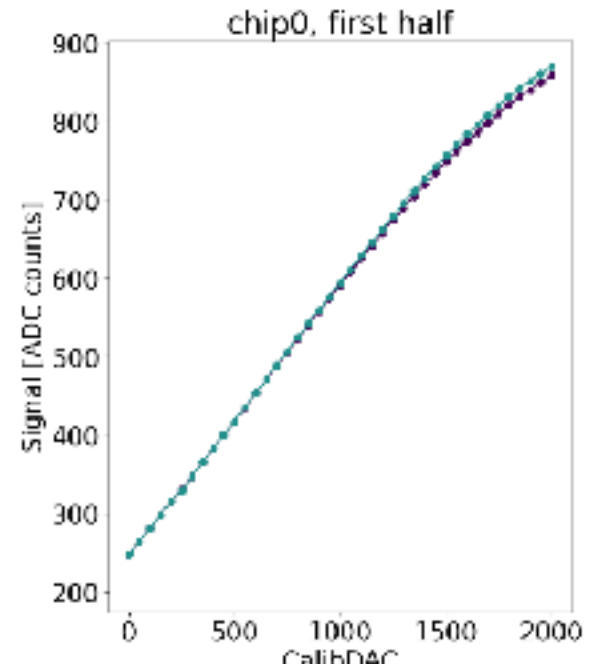
IHEP HGCal team



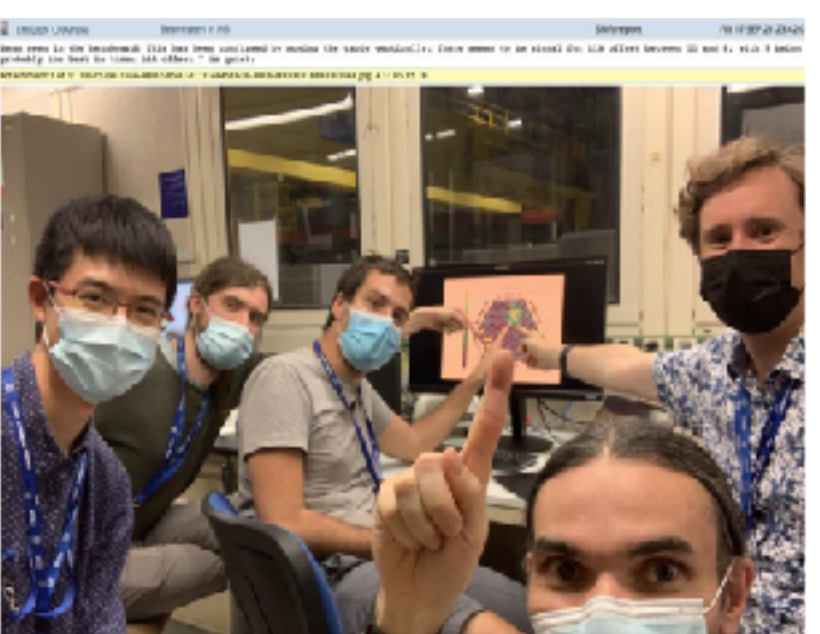
First 8 inch module at IHEP



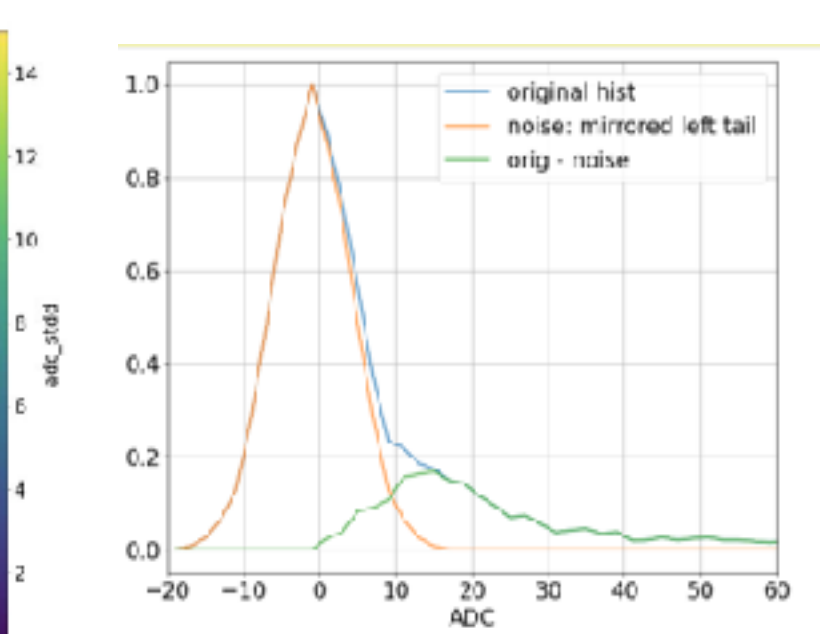
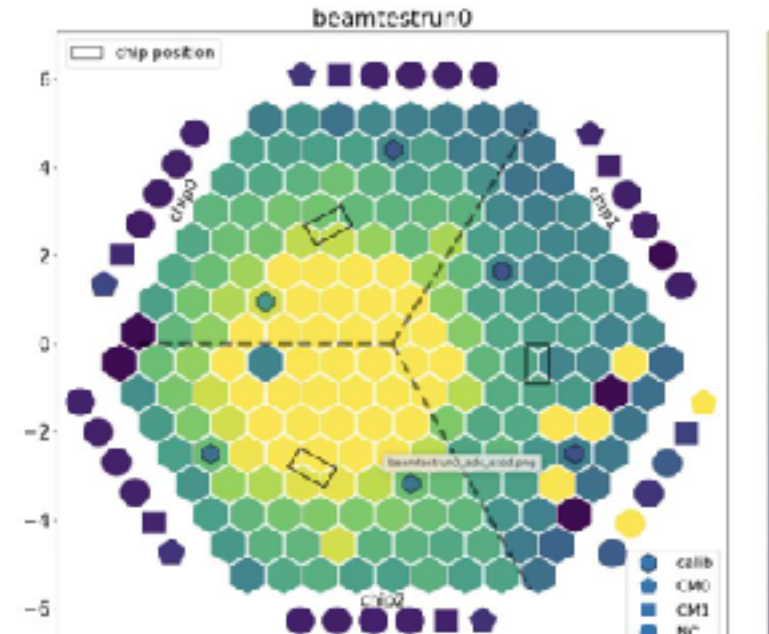
Noise before/after assembly





Charge injection



IHEP LD Module with HGCROCV2, 300mm silicon in September 2021 beam test




 EUROPEAN ORGANIZATION FOR NUCLEAR RESEARCH  
 COMPACT MUON SOLENOID COLLABORATION  
 URL: <http://cms.cern>


**Passed HGCal MAC site qualification**

Dr. Karl Gill  
 CMS HGCal Project Manager  
 Principal Applied Physicist  
 CERN - EP Department  
 CH - 1227 GENEVA 23  
 Switzerland  
 Tel: +41 76 411 4711  
 Email: Karl.Anton.Gill@cern.ch

December 15, 2021

Subject: Certification of qualification the HGCal Module Assembly Centre at IHEP, Beijing

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To whom it may concern,

I am writing as Project Manager for the CMS endcap calorimeter upgrade project (HGCal) to certify that the silicon module assembly center (MAC) at IHEP Beijing, led by Prof. Huanqin Zhang, has been qualified for the HGCal project as ready to move into the Pre-Series phase of construction.

HGCal will replace several of the present CMS sub-detectors: the silicon/lead endcap pre-shower detector, the lead-tungstate crystal electromagnetic endcap calorimeter, and the plastic/brass endcap hadron calorimeter. HGCal is a novel sampling calorimeter, based on a large-scale deployment of silicon modules (a grand total of approximately 26000 installed, plus 5% spares), positioned between dense layers of absorber. The silicon modules will be complemented with plastic scintillator tiles instrumented by silicon photomultipliers (SiPMs) in regions of the detector where particles arrive with lower intensity.

The qualification of the IHEP Beijing MAC has been completed on time to meet the corresponding project milestone. The MAC is set up in a Class 1000 clean room that is dedicated to this facility and all of the equipment for mass production of silicon modules for HGCal has been installed in the clean room and commissioned. This equipment includes a gantry machine for automated module assembly, a wire-bonding machine, an optical inspection and coordination measurement machine, and a silicon module test-stand. The IHEP Beijing team has been trained in how to use the MAC equipment, and they have practiced extensively on dummy module components before moving onto using live components.

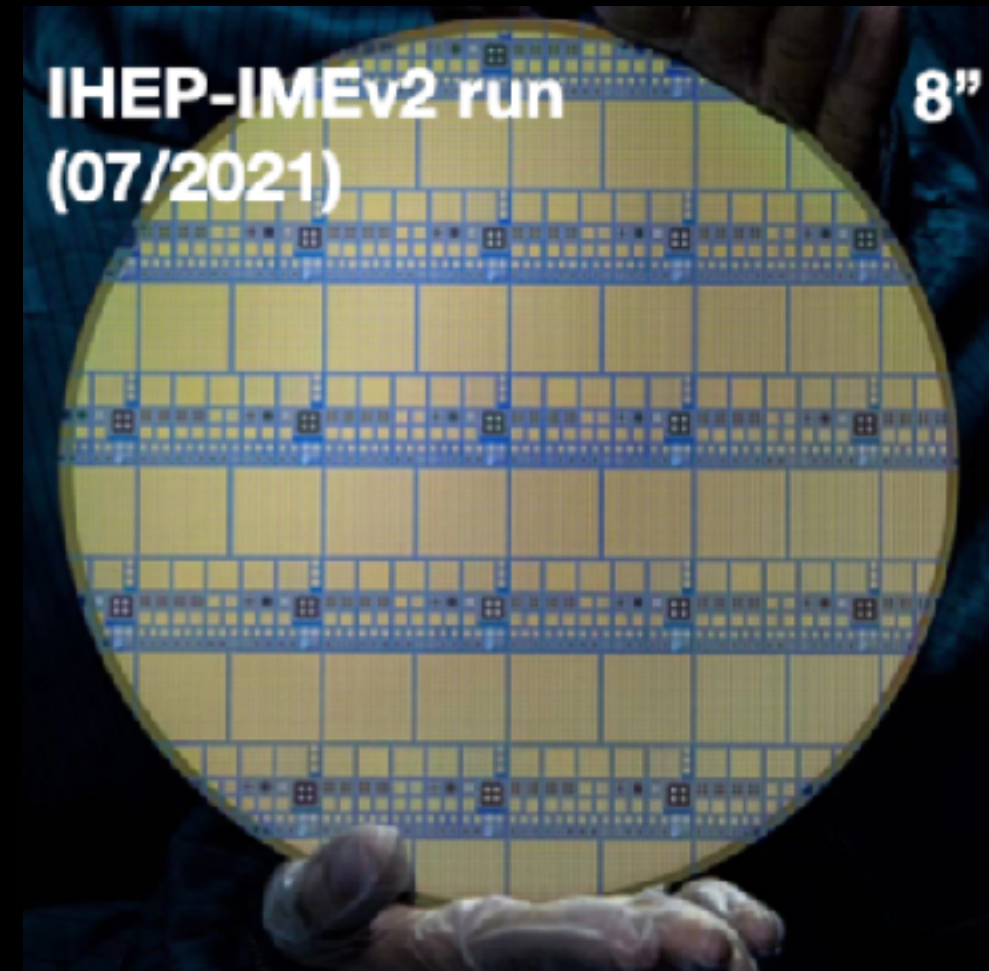
Name	Status	Baseline date	Finalization date	Distance from critical path
All Silicon modules assembly sites and procedures qualified (HQ)	not yet started	27-May-21	15-Aug-21	649
HGCROCV2 Full silicon module validated (HQ)	not yet started	17-Nov-21	27-Nov-21	103
Silicon Module assembly environment orders placed (HQ)	not yet started	23-Mar-21	17-Mar-21	265
Silicon module assembly site and procedures qualified	not yet started	18-Sep-21	28-Sep-21	366
Full silicon module assembly site and procedures qualified (HQ)	not yet started	7-Dec-21	7-Dec-21	309
Full silicon module assembly site and procedures qualified (HQ)	not yet started	7-Dec-21	7-Dec-21	310
Full silicon module assembly site and procedures qualified (HQ)	not yet started	7-Dec-21	7-Dec-21	349
All partial silicon modules qualified (HQ)	not yet started	5-Feb-21	5-Feb-21	214
Silicon modules production 50% complete (HQ)	not yet started	5-Jun-21	5-Jun-21	345
Full silicon module production 50% complete (HQ)	not yet started	18-Aug-21	18-Aug-21	319
Silicon modules production 50% complete (HQ)	not yet started	13-Feb-21	23-Feb-21	225
Silicon module production 50% complete (HQ)	not yet started	14-Jun-21	14-Jun-21	345



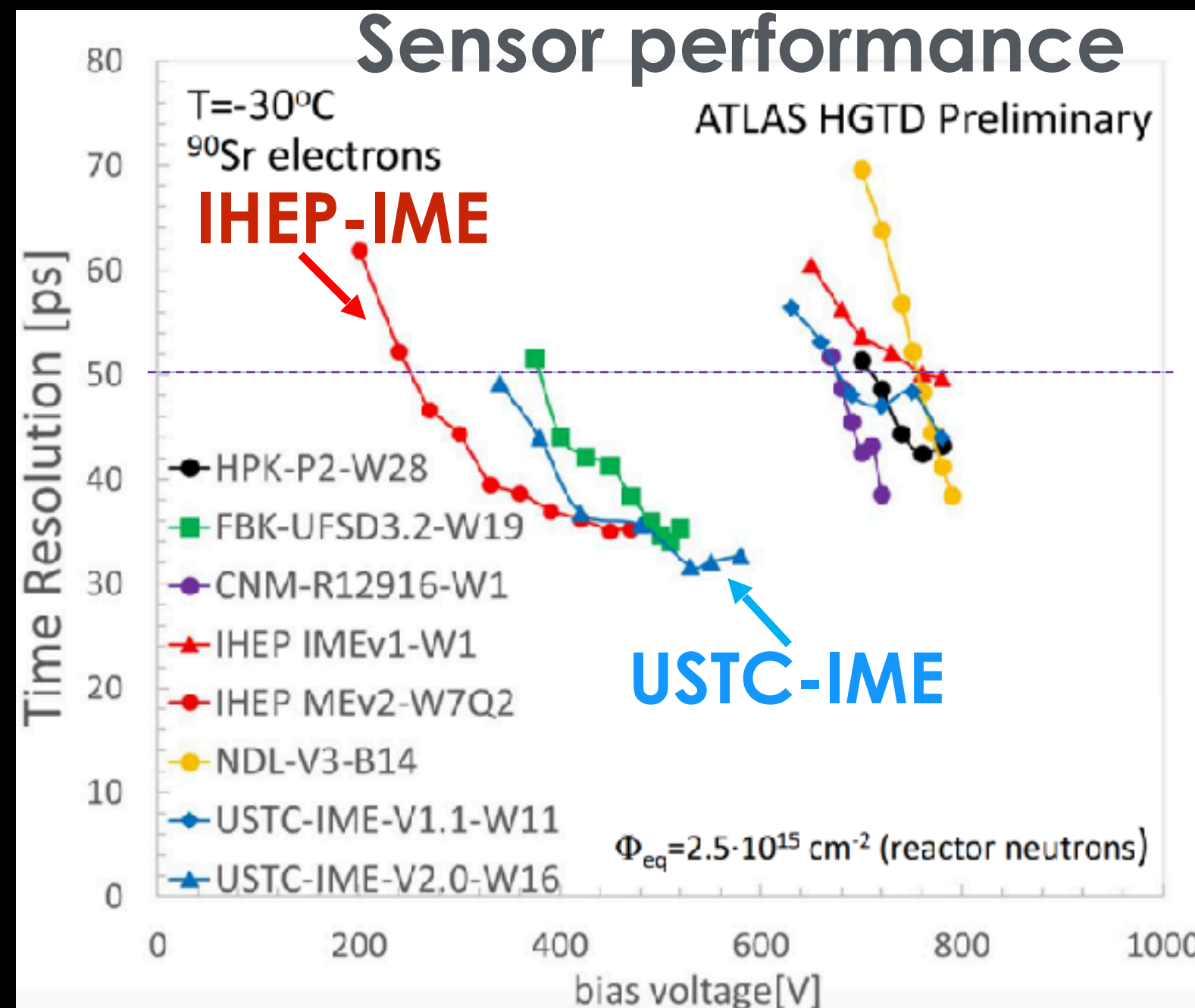
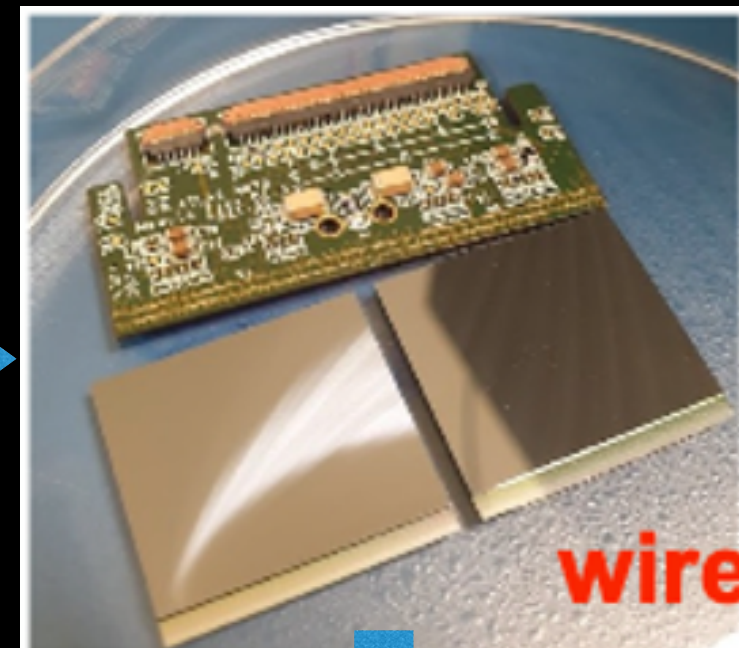
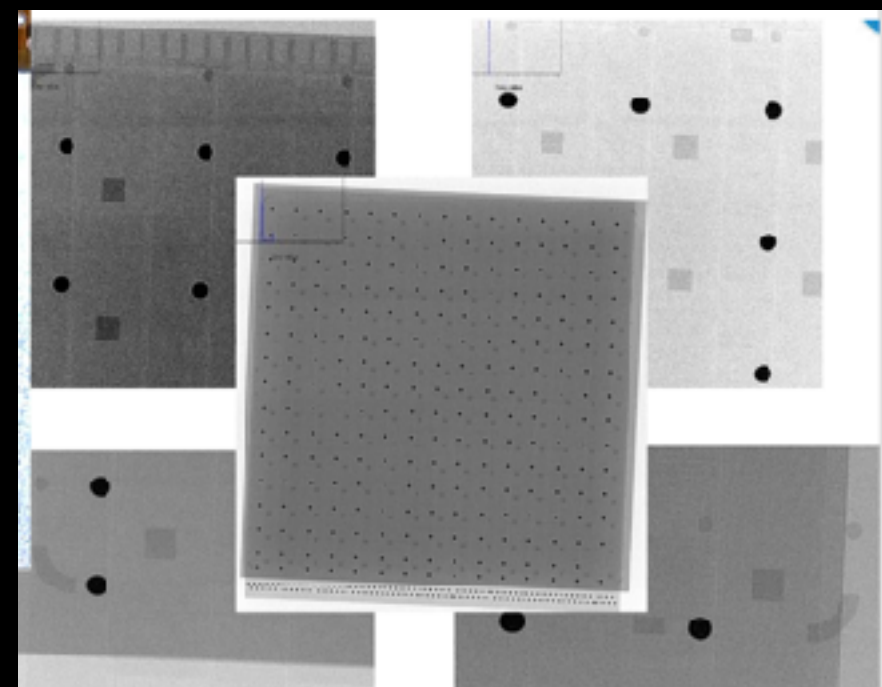
# ATLAS Timing Detector (HGTD)

China is taking a leadership role in HGTD (IHEP, USTC, Nanjing, Shandong, Shanghai)

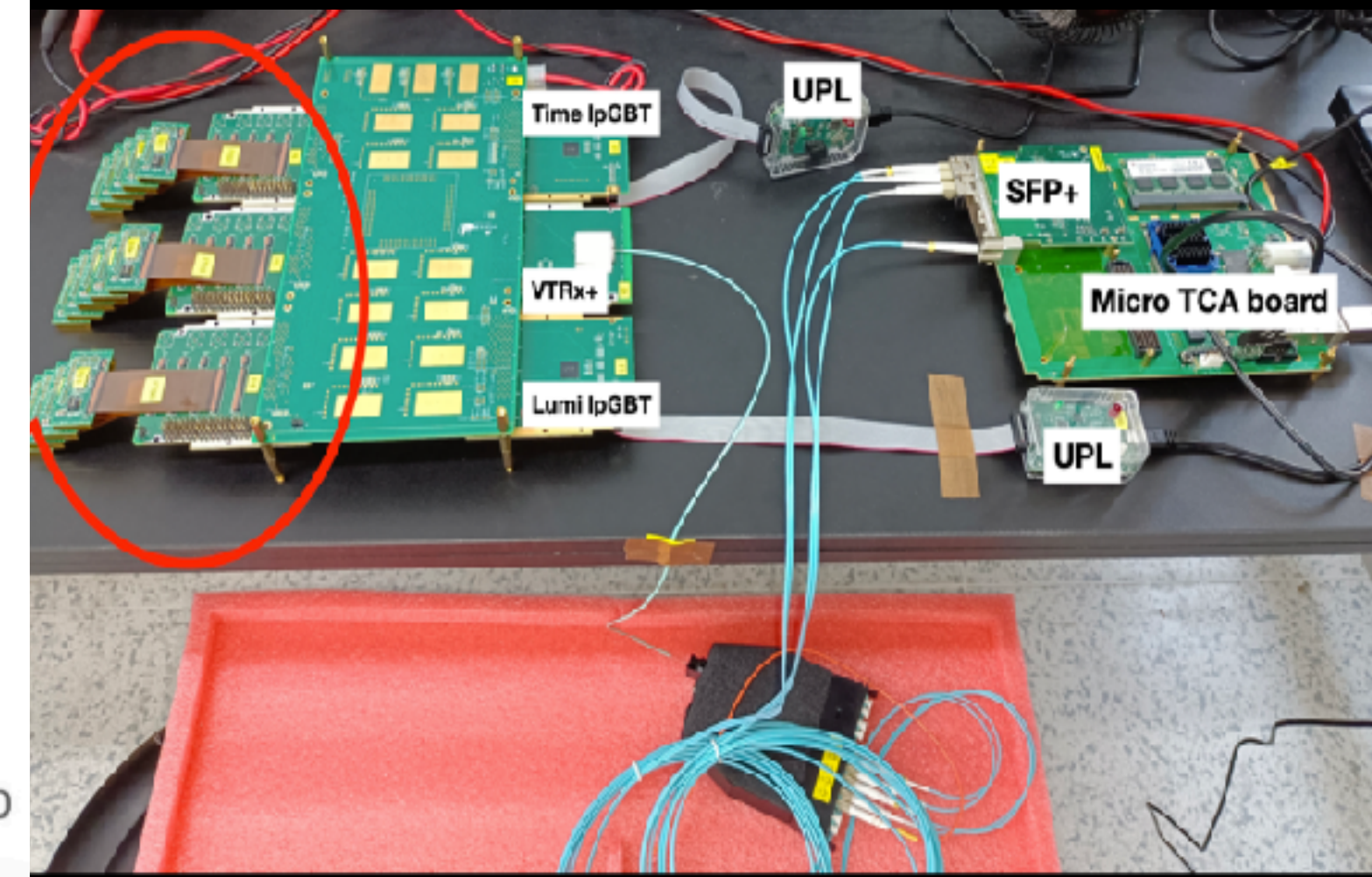
- 34% of LGAD sensors (IHEP-IME, USTC-IME)
- 100% module flex electronics
- 50% module hybridization
- 44% module assembly
- 50% module supports
- 33% flex cables
- 67% design/100% production peripheral electronics
- Low voltages power supplies



- Project leader
- HGTD risk and schedule coordinator
- L2 Sensors coordinator
- L2 Module coordinator
- L3 Module flex coordinator
- L2 software coordinator
- L3 Peripheral electronics coordinator
- L3 High Voltage coordinator
- HGTD Speakers committee Chair



## Peripheral electronics testing





# CEPC International Detector R&D Review Committee (IDRC)

Committee proposed by CEPC IAC

## Initial Charge and Goals

**Evaluate International proposals for detector R&D relevant to the CEPC**

Independent organ to evaluate the importance and suitability of worldwide detector R&D proposals for CEPC and produce short report with findings.

Reviews and endorses the Detector R&D proposals from the international community, such that international participants can apply for funds from their funding agencies and make effective and sustained contributions

Later, this committee is expected to evolve to **evaluate the Letters of Intent for the CEPC Detectors submitted by the proponents of the International Detector Collaborations**



# CEPC International Detector R&D Review Committee (IDRC)

## Goals for original meeting, provided to committee:

Provide an overview of the on-going detector R&D linked to the CEPC

Solicit input regarding the directions one should take in the near future

Suggest: Short report with the opinion of the committee regarding the current R&D program and future directions

## Outcome of original review: Report with main recommendation to produce:

- 1) Document with a coherent list of the on-going of R&D activities, such that the presence of gaps and overlaps can be determined and addressed — DONE
- 2) Updated CDR document within 12-18 months
- 3) A conservative full-detector concept, potentially deliverable on an aggressive time scale, should be specified by the CEPC Management and adopted as the baseline for the CDR update

We, the CEPC management and IAC, didn't agree with the production of another "CDR" document in this timescale, due to the large amount of resources required. Instead, the decision was to move forward with the R&D for a 4th detector



# Key previous steps:

- IDRC expressed concern that the schedule presented to them (with detector TDRs in 2023) was not realistic and prompted the problematic recommendations
- Follow-up IDRC meeting in 2020, planned for Marseille, was cancelled due to COVID
- A document with the summary of on-going R&D activities was produced and sent to the IDRC chair, as requested by the IDRC
- **Since the last IAC meeting in 2021:**
  - An updated version of the document with the summary of R&D activities was produced and sent to the IDRC
  - Two attempts to organize a meeting in 2022 were made by the IDRC chair, but unfortunately it was not possible to secure the presence of enough committee members
  - Given the current international situation, the chair has suggested a modification to the committee charge that we would like to discuss

## Document with summary of on-going R&D activities updated in early 2022

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# Suggestions and next steps:

## Discussion with IDRC chair → suggestions on how to proceed

- Concern that, given the current international situation, effectively there are **no proposals** from international community specifically to work at CEPC and it is difficult to imagine such proposals will materialize in the near future, therefore, the charge to this committee is not actionable
  - Observation: This might not be exactly correct since most detector R&D work for FCC-ee directly applies to CEPC. It is possible that, for certain communities, getting the support of this International Committee would be advantageous — this seems to be the situation with our Italian colleagues
- Suggest to change the charge of the committee to become more technical covering a technical evaluation of all detector R&D being done towards the CEPC — hence, closer to the International Accelerator Review Committee charge
- Re-evaluate the committee membership in light of this new, more technical, charge, and in particular, investigate the availability of the current committee members to still serve in such committee

**Given that this committee was created following an IAC recommendation, we would like to discuss these possible changes with you**



# Suggestions for a new charge:

- The IDRC will advise on matters related to the CEPC detector R&D, including the Machine-Detector Interface, and the compatibility of the detector technologies proposed with the high-luminosity operation of the accelerator at the Z, WW, ZH, and tt-bar production threshold energies.
- The IDRC will evaluate international proposals for detector R&D relevant to the CEPC, and produce a short report with its findings.
- The IDRC reports to the Project Director.
- Later, this committee is expected to evolve into an experimental committee (similar to LHCC) to evaluate the Letters of Intent for the CEPC Detectors submitted by the proponents of the International Detector Collaborations
- The committee should have external members including 2-3 IAC members.
- The committee should meet at least once a year and a report should be provided at the IAC meeting.

## Current committee membership:

Dave Newbold, UK, RAL (chair)  
Jim Brau, USA, Oregon  
Brian Foster, UK, Oxford  
Liang Han, China, USTC  
Andreas Schopper, CERN, CERN  
Steinar Stapnes, CERN, CERN  
Hitoshi Yamamoto, Japan, Tohoku  
Valter Bonvicini, Italy, Trieste  
Ariella Cattai, CERN, CERN  
Cristinel Diaconu, France, Marseille  
Abe Seiden, USA, UCSC  
Laurent Serin, France, LAL  
Roberto Tenchini, Italy, INFN  
Ivan Villa Alvarez, Spain, Santader  
Harvey Newman, USA, Caltech  
Marcel Stanitzki, Germany, DESY

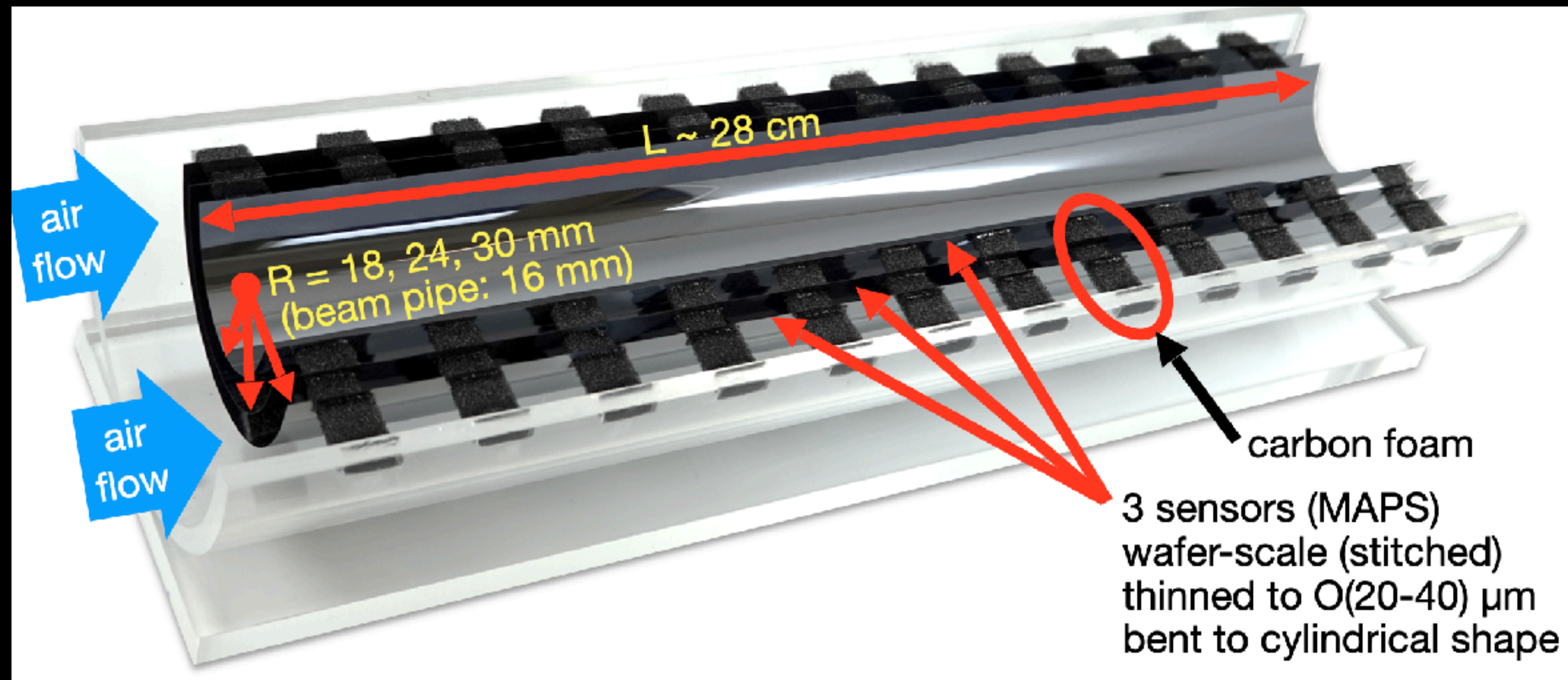


# **Key R&D Issues Moving Forward**



# Some key R&D topics moving forward

- **Machine Detector Interface**
- **Luminosity meter (LumiCal)** - continue integration in beampipe development
- **Silicon Vertex**
  - Continue to explore low-material budget solutions, cooling integration and performance optimization
  - Major issue: Sensor technology and availability in China
  - Curved silicon, as in ALICE ITS3, should be considered but it has lots of challenges that would need to be solved in a tight timescale





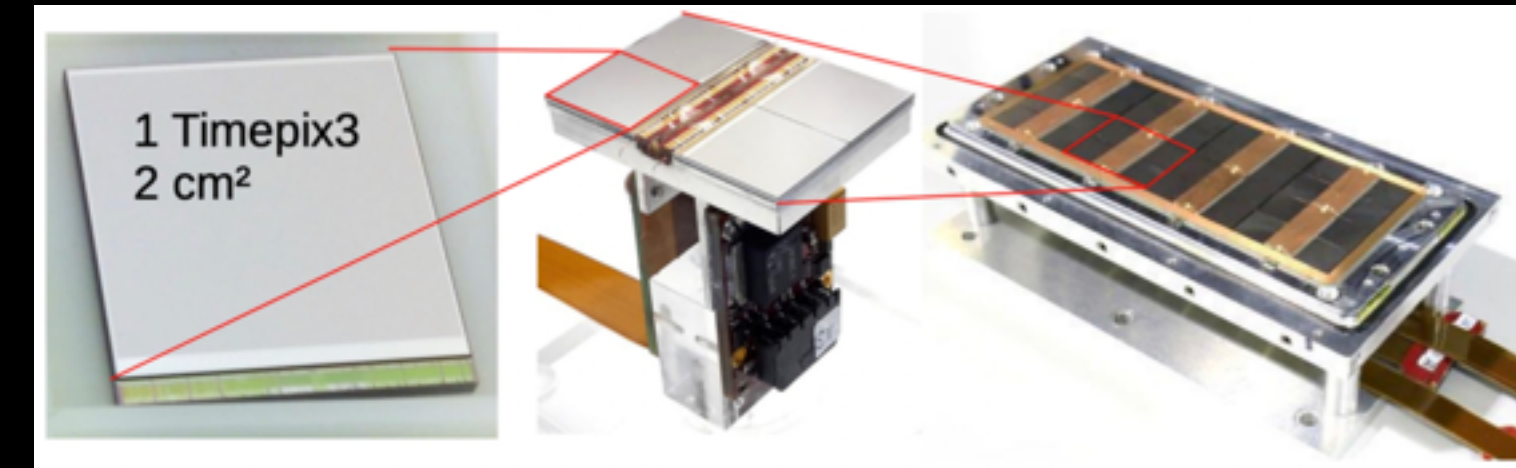
# Some key R&D topics moving forward

- **Tracker**

Trade off: Transparency  $\longleftrightarrow$  reliability/resolution

- **Time Projection Chamber**

- Evaluate the Pixel TPC possibility



- **Drift Chamber**

- Demonstrate it can cope with the high increased rates at the Z pole? Enough resolution?
- Demonstrate PID capabilities with cluster counting
- Continue mechanical design and stability analysis

- **Full silicon tracker**  $\rightarrow$  still need manpower increase to exploit this option

- Continue Silicon Tracker prototype collaboration
- Need to add detector for particle identification — drift chamber is an option
- Consider adding timing Silicon layer
  - AC-Coupled Resistive Silicon Detector (RSD)
  - Trench-isolated LGAD (TI-LGAD)



# Some key R&D topics moving forward

- **Calorimetry**
  - Cost versus physics performance
- **ECAL**
  - Finalize evaluation of the crystal calorimeter option
  - Cooling of PFA calorimeter versus performance
- **HCAL**
  - Study glass hadronic calorimeter has an alternative to Scintillator option
  - Cooling and mechanics studies
- **Dual Readout**
  - Demonstration using full size prototype



# Some key R&D topics moving forward

- **Calorimetry**
  - Cost versus physics performance
- **ECAL**
  - Finalize evaluation of the crystal calorimeter option
  - Cooling of PFA calorimeter versus performance
- **HCAL**
  - Finalize evaluation of Scintillator Steel option
  - Study glass hadronic calorimeter has an alternative
  - Cooling and mechanics studies
- **Dual Readout**
  - Demonstration using full size prototype
- **Muon System optimization**
  - Optimize number of layers
  - Optimize design for industrialization and cost



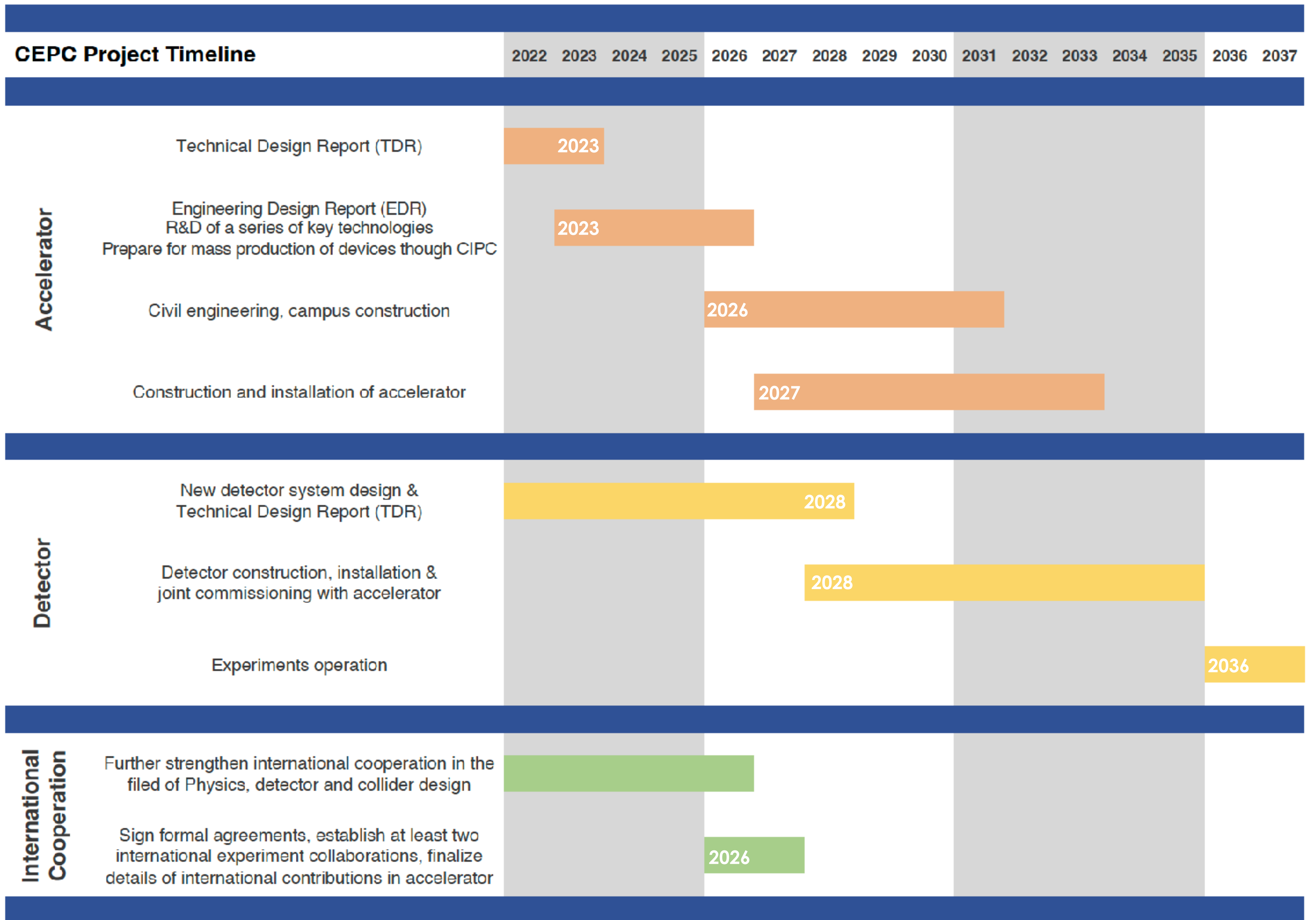
# Optimization of detectors

Not an easy task without definite detectors/collaborations target

- Use a mixture of **fast simulation** and **full simulation**
- Need to consider **engineering aspects**
- Need to consider **costing** issues
- **balance between performance and eventual total detector cost**



# CEPC Project timeline





# Final remarks

**New ideas continue to be deployed while we also develop new tools**  
**International collaboration has continue albeit the difficulties**

**Key detector technologies R&D continues and many have been put to prototyping**  
**Several CEPC R&D detector projects reaching a successful conclusion**  
**others are starting**

International collaboration continues to be a main goal of the CEPC

Final detectors are to be defined by International Collaborations and they are likely to incorporate a mixture of the technologies discussed here

**Still very important to expand international collaboration**  
**Explore the CEPC and FCC-ee R&D synergies**



**The End**



**Extra Slides**



# Sub-detectors and Key techs

Table 3.2: All sub-detectors and the key technologies

Sub-detector	Key technology	Key Specifications
Silicon vertex detector	Spatial resolution and materials	$\sigma_{r\phi} \sim 3 \mu\text{m}, X/X_0 < 0.15\%$ (per layer)
Silicon tracker	Large-area silicon detector	$\sigma\left(\frac{1}{p_T}\right) \sim 2 \times 10^{-5} \oplus \frac{1 \times 10^{-3}}{p \times \sin^{3/2} \theta} (\text{GeV}^{-1})$
TPC/Drift Chamber	Precise dE/dx (dN/dx) measurement	Relative uncertainty 2%
Time of Flight detector	Large-area silicon timing detector	$\sigma(t) \sim 30 \text{ ps}$
Electromagnetic Calorimeter	High granularity 4D crystal calorimeter	EM energy resolution $\sim 3\% / \sqrt{E(\text{GeV})}$ Granularity $\sim 2 \times 2 \times 2 \text{ cm}^3$
Magnet system	Ultra-thin High temperature Superconducting magnet	Magnet field 2 – 3 T Material budget $< 1.5 X_0$ Thickness $< 150 \text{ mm}$
Hadron calorimeter	Scintillating glass Hadron calorimeter	Support PFA jet reconstruction Single hadron $\sigma_E^{had} \sim 40\% / \sqrt{E(\text{GeV})}$ Jet $\sigma_E^{jet} \sim 30\% / \sqrt{E(\text{GeV})}$

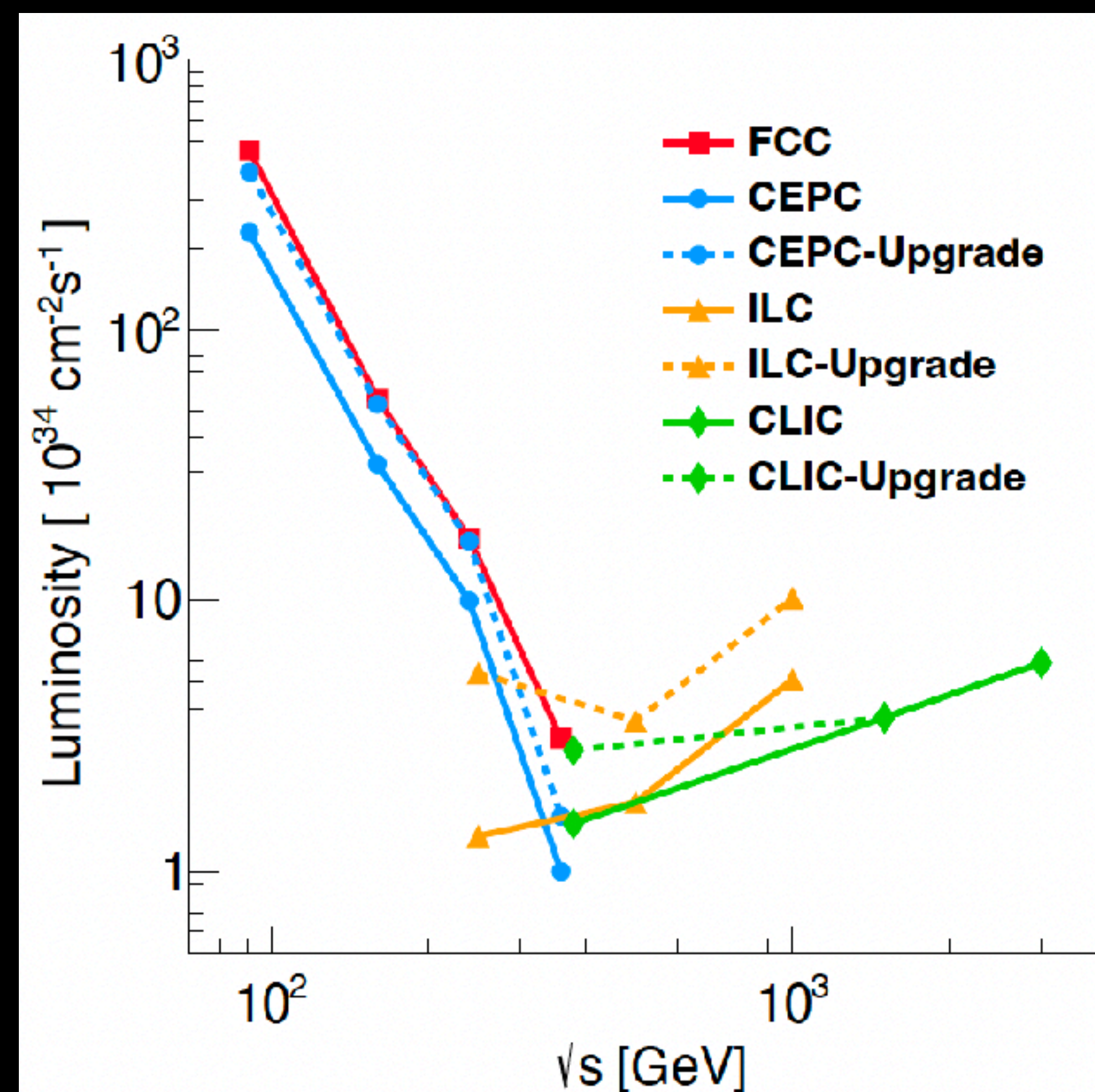


# CEPC TDR Parameters (upgrade version)

	Higgs	W	Z	ttbar
Number of IPs	2			
Circumference [km]	100.0			
SR power per beam [MW]	50			
Half crossing angle at IP [mrad]	16.5			
Bending radius [km]	10.7			
Energy [GeV]	120	80	45.5	180
Energy loss per turn [GeV]	1.8	0.357	0.037	9.1
Piwinski angle	5.94	6.08	24.68	1.21
Bunch number	415	2162	19918	58
Bunch spacing [ns]	385	154	15(10% gap)	2640
Bunch population [ $10^{10}$ ]	14	13.5	14	20
Beam current [mA]	27.8	140.2	1339.2	5.5
Momentum compaction [ $10^{-5}$ ]	0.71	1.43	1.43	0.71
Phase advance of arc FODOs [degree]	90	60	60	90
Beta functions at IP (bx/by) [m/mm]	0.33/1	0.21/1	0.13/0.9	1.04/2.7
Emittance (ex/ey) [nm/pm]	0.64/1.3	0.87/1.7	0.27/1.4	1.4/4.7
Beam size at IP (sx/sy) [ $\mu\text{m}/\text{nm}$ ]	15/36	13/42	6/35	39/113
Bunch length (SR/total) [mm]	2.3/3.9	2.5/4.9	2.5/8.7	2.2/2.9
Energy spread (SR/total) [%]	0.10/0.17	0.07/0.14	0.04/0.13	0.15/0.20
Energy acceptance (DA/RF) [%]	1.7/2.2	1.2/2.5	1.3/1.7	2.3/2.6
Beam-beam parameters (xx/xy)	0.015/0.11	0.012/0.113	0.004/0.127	0.071/0.1
RF voltage [GV]	2.2 (2cell)	0.7 (2cell)	0.12 (1cell)	10 (5cell)
RF frequency [MHz]	650			
Beam lifetime [min]	20	55	80	18
Luminosity per IP [ $10^{34}/\text{cm}^2/\text{s}$ ]	8.3	26.6	191.7	0.8

Higher SR power of 50MW:  
Luminosity increase ~66%.

CEPC accelerator white paper for  
Snowmass21, arXiv:2203.09451





**Detector**



# Projects overview: R&D schedule

PBS	Task Name	Start	Finish	Duration	2020		2021		2022		2023		2024		2025		2026		2027		2028		2029			
					H1	H2	H1	H2	H1	H2	H1	H2	H1	H2	H1	H2	H1	H2	H1	H2	H1	H2	H1	H2		
	<b>CEPC Detector R&amp;D Project</b>	2020/5/7	2026/12/31	1736 days	CEPC Detector R&D Project																					
1	<b>Vertex</b>	2020/5/7	2023/12/29	952 days	Vertex																					
1.1	Vertex Prototype	2020/5/7	2023/12/29	952 days	Vertex Prototype																					
1.2	ARCADIA CMOS MAPS	2020/5/7	2023/12/29	952 days	ARCADIA CMOS MAPS																					
2	<b>Tracker</b>	2020/5/7	2024/12/31	1214 days	Tracker																					
2.1	TPC Module and Prototype	2020/5/7	2021/12/31	432 days	TPC Module and Prototype																					
2.2	Silicon Tracker Prototype	2020/5/7	2023/10/31	909 days	Silicon Tracker Prototype																					
2.3	Drift Chamber Activities	2020/5/7	2024/12/31	1214 days	Drift Chamber Activities																					
3	<b>Calorimetry</b>	2020/5/7	2024/12/31	1214 days	Calorimetry																					
3.1	<b>ECAL Calorimeter</b>	2020/5/7	2024/12/31	1214 days	ECAL Calorimeter																					
3.1.1	Crystal Calorimeter	2020/5/7	2021/12/31	432 days	Crystal Calorimeter																					
3.1.2	PFA Sci-ECAL Prototype	2020/5/7	2024/12/31	1214 days	PFA Sci-ECAL Prototype																					
3.2	<b>HCAL Calorimeter</b>	2020/5/7	2023/4/28	777 days	HCAL Calorimeter																					
3.2.1	PFA Digital Hadronic Calorimeter	2020/5/7	2022/12/30	692 days	PFA Digital Hadronic Calorimeter																					
3.2.2	PFA Sci-AHCAL Prototype	2020/5/7	2023/4/28	777 days	PFA Sci-AHCAL Prototype																					
3.3	<b>Dual-readout Calorimeter</b>	2020/5/7	2024/12/31	1214 days	Dual-readout Calorimeter																					
4	<b>Muon Detector</b>	2020/5/7	2024/12/31	1214 days	Muon Detector																					
4.1	Scintillator-based Muon Detector Prototype	2020/5/7	2023/12/29	952 days	Scintillator-based Muon Detector Prototype																					
4.2	Muon and pre-shower $\mu$ RWELL-based detectors	2020/5/7	2024/12/31	1214 days	Muon and pre-shower $\mu$ RWELL-based detectors																					
5	<b>Solenoid</b>	2020/5/7	2026/12/31	1736 days	Solenoid																					
5.1	LTS solenoid magnet	2020/5/7	2025/12/31	1475 days	LTS solenoid magnet																					
5.2	HTS solenoid magnet	2020/5/7	2026/12/31	1736 days	HTS solenoid magnet																					
6	<b>MDI</b>	2020/5/7	2023/12/29	952 days	MDI																					
6.1	LumiCal Prototype	2020/5/7	2021/12/1	410 days	LumiCal Prototype																					
6.2	Interaction Region Mechanics	2020/5/7	2023/12/29	952 days	Interaction Region Mechanics																					
8	<b>Software and Computing</b>	2020/5/7	2024/12/31	1214 days	Software and Computing																					



# Projects overview: FTE

PBS	Task Name	Team
	<b>CEPC Detector R&amp;D Project</b>	
<b>1</b>	<b>Vertex</b>	
1.1	Vertex Prototype	China+ international collaborators
1.2	<b>ARCADIA CMOS MAPS</b>	INFN
<b>2</b>	<b>Tracker</b>	
2.1	TPC Module and Prototype	IHEP, Tsinghua
2.2	<b>Silicon Tracker Prototype</b>	China, UK, INFN
2.3	<b>Drift Chamber Activities</b>	INFN, Novosibirsk
<b>3</b>	<b>Calorimetry</b>	
3.1	<b>ECAL Calorimeter</b>	
3.1.1	Crystal Calorimeter	IHEP, USA, INFN
3.1.2	PFA Sci-ECAL Prototype	USTC, IHEP
3.2	<b>HCAL Calorimeter</b>	
3.2.1	PFA Digital Hadronic Calorimeter	SJTU, IPNL, Weizmann, IIT, USTC
3.2.2	PFA Sci-AHCAL Prototype	USTC, IHEP, SJTU
3.3	<b>Dual-readout Calorimeter</b>	INFN, Sussex, Zagreb, South Korea
<b>4</b>	<b>Muon Detector</b>	
4.1	Scintillator-based Muon Detector	Fudan, SJTU
4.2	<b>Muon and pre-shower <math>\mu</math>RWELL-</b>	INFN, LNF
<b>5</b>	<b>Solenoid</b>	
5.1	LTS solenoid magnet	IHEP+Industry
5.2	HTS solenoid magnet	IHEP+Industry
<b>6</b>	<b>MDI</b>	
6.1	LumiCal Prototype	AC, IHEP, Vinca
6.2	Interaction Region Mechanics	IHEP
<b>8</b>	<b>Software and Computing</b>	IHEP, SDU, CERN, INFN

